

PIC24HJ32GP202/204 and PIC24HJ16GP304 Data Sheet

High-Performance, 16-bit Microcontrollers

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High-Performance, 16-bit Microcontrollers

Operating Range:

- Up to 40 MIPS operation (@ 3.0-3.6V):
 - Industrial temperature range (-40°C to +85°C)
 - Extended temperature range (-40°C to +125°C)

High-Performance CPU:

- · Modified Harvard architecture
- · C compiler optimized instruction set
- · 16-bit wide data path
- · 24-bit wide instructions
- Linear program memory addressing up to 4M instruction words
- · Linear data memory addressing up to 64 Kbytes
- 71 base instructions, mostly 1 word/1 cycle
- · Sixteen 16-bit General Purpose Registers
- Flexible and powerful addressing modes
- · Software stack
- 16 x 16 multiply operations
- 32/16 and 16/16 divide operations
- Up to ±16-bit shifts for up to 40-bit data

Interrupt Controller:

- · 5-cycle latency
- · 118 interrupt vectors
- Up to 21 available interrupt sources
- Up to 3 external interrupts
- · Seven programmable priority levels
- · Four processor exceptions

On-Chip Flash and SRAM:

- Flash program memory (up to 32 Kbytes)
- Data SRAM (2 Kbytes)
- Boot and General Security for Program Flash

Digital I/O:

- · Peripheral Pin Select Functionality
- Up to 35 programmable digital I/O pins
- · Wake-up/Interrupt-on-Change for up to 21 pins
- · Output pins can drive from 3.0V to 3.6V
- Up to 5V output with open drain configuration
- · All digital input pins are 5V tolerant
- · 4 mA sink on all I/O pins

System Management:

- · Flexible clock options:
 - External, crystal, resonator, internal RC
 - Fully integrated Phase-Locked Loop (PLL)
 - Extremely low jitter PLL
- · Power-up Timer
- · Oscillator Start-up Timer/Stabilizer
- · Watchdog Timer with its own RC oscillator
- · Fail-Safe Clock Monitor
- · Reset by multiple sources

Power Management:

- · On-chip 2.5V voltage regulator
- · Switch between clock sources in real time
- · Idle, Sleep and Doze modes with fast wake-up

Timers/Capture/Compare:

- Timer/Counters, up to three 16-bit timers:
 - Can pair up to make one 32-bit timer
 - One timer runs as Real-Time Clock with external 32.768 kHz oscillator
 - Programmable prescaler
- Input Capture (up to four channels):
 - Capture on up, down or both edges
 - 16-bit capture input functions
 - 4-deep FIFO on each capture
- Output Compare (up to two channels):
 - Single or Dual 16-Bit Compare mode
 - 16-bit Glitchless PWM Mode

Communication Modules:

- · 4-wire SPI
 - Framing supports I/O interface to simple codecs
 - Supports 8-bit and 16-bit data
 - Supports all serial clock formats and sampling modes
- I²C™
 - Full Multi-Master Slave mode support
 - 7-bit and 10-bit addressing
 - Bus collision detection and arbitration
 - Integrated signal conditioning
 - Slave address masking
- UART
 - Interrupt on address bit detect
 - Interrupt on UART error
 - Wake-up on Start bit from Sleep mode
 - 4-character TX and RX FIFO buffers
 - LIN bus support
 - IrDA® encoding and decoding in hardware
 - High-Speed Baud mode
 - Hardware Flow Control with CTS and RTS

Analog-to-Digital Converters (ADCs):

- 10-bit, 1.1 Msps or 12-bit, 500 ksps conversion:
 - Two and four simultaneous samples (10-bit ADC)
 - Up to 13 input channels with auto-scanning
 - Conversion start can be manual or synchronized with one of four trigger sources
 - Conversion possible in Sleep mode
 - ±2 LSb max integral nonlinearity
 - ±1 LSb max differential nonlinearity

CMOS Flash Technology:

- · Low-power, high-speed Flash technology
- · Fully static design
- 3.3V (±10%) operating voltage
- · Industrial and extended temperature
- · Low-power consumption

Packaging:

- 28-pin SDIP/SOIC/QFN-S
- 44-pin QFN/TQFP

Note: See the device variant tables for exact peripheral features per device.

PIC24HJ32GP202/204 and PIC24HJ16GP304 Product Families

The device names, pin counts, memory sizes and peripheral availability of each family are listed below, followed by their pinout diagrams.

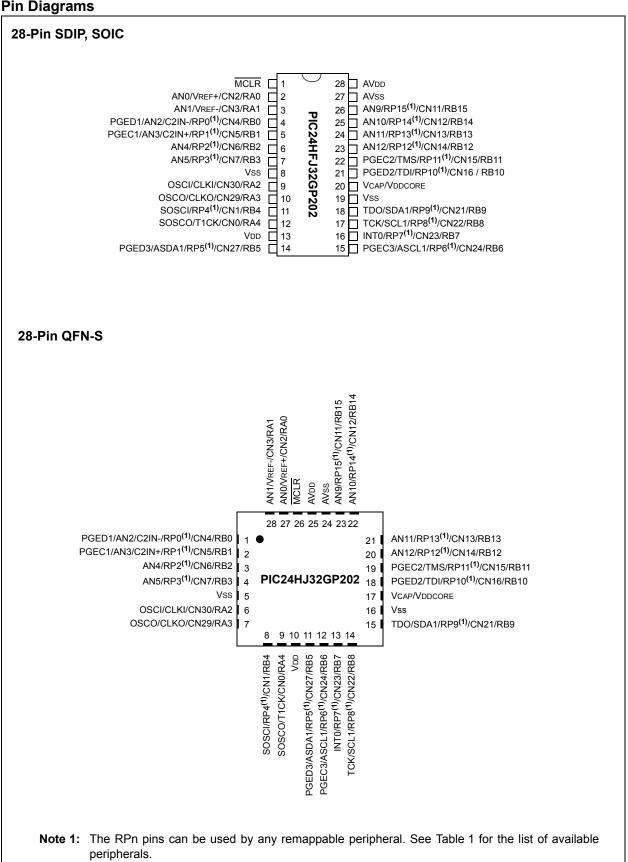
TABLE 1: PIC24HJ32GP202/204 AND PIC24HJ16GP304 CONTROLLER FAMILIES

		ory			Rei	тарра	ble Pe	ripher	als					
Device	Pins	Program Flash Memory (Kbyte)	RAM	Remappable Pins	16-bit Timer	Input Capture	Output Compare Std. PWM	UART	External Interrupts ⁽²⁾	SPI	10-Bit/12-Bit ADC	I ² C TM	I/O Pins (Max)	Packages
PIC24HJ32GP202	28	32	2	16	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 10 ch	1	21	SDIP SOIC QFN-S
PIC24HJ32GP204	44	32	2	26	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 13 ch	1	35	QFN TQFP
PIC24HJ16GP304	44	16	2	26	3(1)	4	2	1	3	1	1 ADC, 13 ch	1	35	QFN TQFP

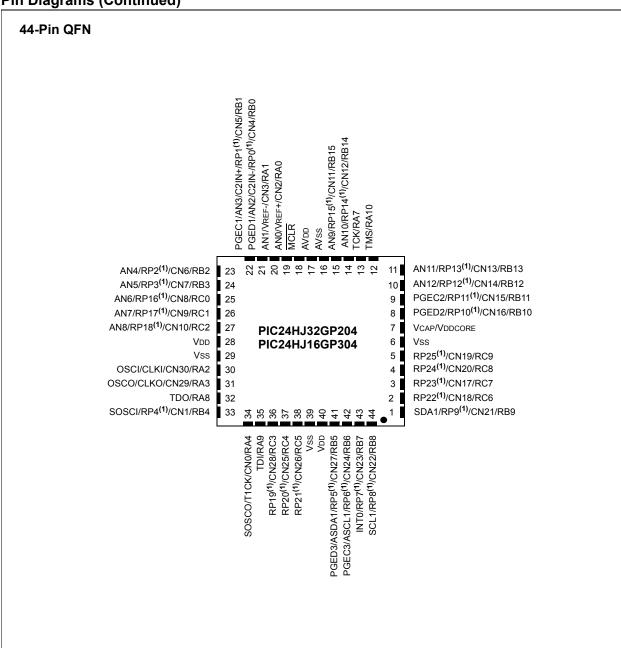
Note 1: Only two out of three timers are Remappable.

2: Only two out of three interrupts are remappable.

Pin Diagrams



Pin Diagrams (Continued)



Note 1: The RPn pins can be used by any remappable peripheral. See Table 1 for the list of available peripherals.

Pin Diagrams (Continued)

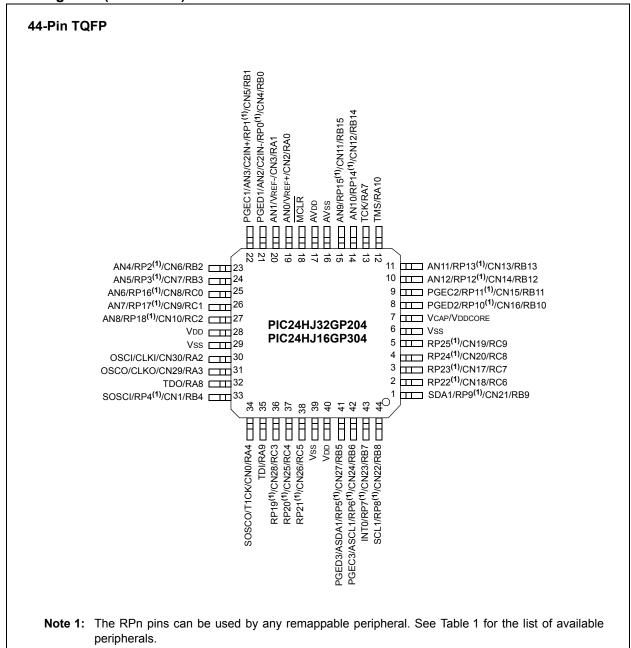


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1.0 DEVICE OVERVIEW

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "PIC24H Family Reference Manual".

This document contains device-specific information for the following devices:

- PIC24HJ32GP202
- PIC24HJ32GP204
- PIC24HJ16GP304

Figure 1-1 shows a general block diagram of the core and peripheral modules in the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. Table 1-1 lists the functions of the various pins shown in the pinout diagrams.

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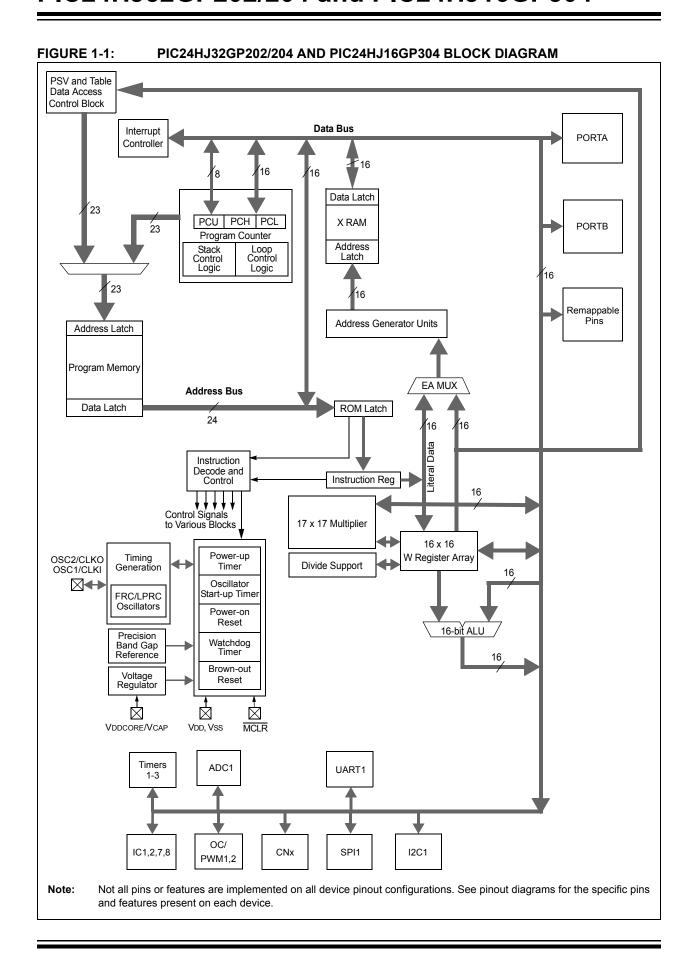


TABLE 1-1: PINOUT I/O DESCRIPTIONS

Pin Name											
Pin Name	Pin Type		Description								
AN0-AN12	I	Analog	Analog input channels.								
	O	ST/CMOS	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. Optionally functions as CLKO in RC and EC modes.								
		ST/CMOS	otherwise.								
			Oscillator mode. Optionally functions as CLKO in RC and EC modes.								
	-	ST/CMOS —	32.768 kHz low-power oscillator crystal input; CMOS otherwise. 32.768 kHz low-power oscillator crystal output.								
CN0-CN30	I	ST									
	I	ST									
	-										
INT0	ı		External interrupt 0.								
INT1	l I	ST	External interrupt 1.								
INT2	l	ST	External interrupt 2.								
RA0-RA4 RA7-RA10	I/O	ST	PORTA is a bidirectional I/O port.								
RB0-RB15	I/O	ST	PORTB is a bidirectional I/O port.								
RC0-RC9	I/O	ST	PORTC is a bidirectional I/O port.								
T1CK	I	ST	Timer1 external clock input.								
T2CK	I	ST	Timer2 external clock input.								
T3CK	I	ST	Timer3 external clock input.								
U1CTS	I	ST	UART1 clear to send.								
U1RTS	0	_	UART1 ready to send.								
U1RX		ST	UART1 receive.								
U1TX	0		UART1 transmit.								
SCK1 SDI1	I/O I	ST ST	Synchronous serial clock input/output for SPI1. SPI1 data in.								
SDO1	Ö	5	ISPI1 data out.								
SS1	I/O	ST	SPI1 slave synchronization or frame pulse I/O.								
SCL1	I/O	ST	Synchronous serial clock input/output for I2C1.								
SDA1	I/O	ST	Synchronous serial data input/output for I2C1.								
ASCL1	I/O	ST	Alternate synchronous serial clock input/output for I2C1.								
ASDA1	I/O	ST	Alternate synchronous serial data input/output for I2C1.								
TMS	l !	ST	JTAG Test mode select pin.								
TCK TDI		ST ST	JTAG test clock input pin. JTAG test data input pin.								
TDO	0	- -	JTAG test data input pin. JTAG test data output pin.								
PGD1/EMUD1	I/O	ST	Data I/O pin for programming/debugging communication channel 1.								
PGC1/EMUC1	l I	ST	Clock input pin for programming/debugging communication channel 1.								
PGD2/EMUD2	I/O	ST	Data I/O pin for programming/debugging communication channel 2.								
PGC2/EMUC2	I	ST	Clock input pin for programming/debugging communication channel 2.								
PGD3/EMUD3	I/O	ST	Data I/O pin for programming/debugging communication channel 3.								
PGC3/EMUC3	I	ST	Clock input pin for programming/debugging communication channel 3.								
VDDCORE	Р	_	CPU logic filter capacitor connection.								
Vss	Р	_	Ground reference for logic and I/O pins.								

Legend: CMOS = CMOS compatible input or output

Analog = Analog input I = Input

O = Output

TABLE 1-1: PINOUT I/O DESCRIPTIONS (CONTINUED)

.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		O D = O O	110110 (0011111025)
Pin Name	Pin Type	Buffer Type	Description
VREF+	I	Analog	Analog voltage reference (high) input.
VREF-	I	Analog	Analog voltage reference (low) input.
AVDD	Р	Р	Positive supply for analog modules. This pin must be connected at all times.
MCLR	I/P	ST	Master Clear (Reset) input. This pin is an active-low Reset to the device.
Avss	Р	Р	Ground reference for analog modules.
VDD	Р	_	Positive supply for peripheral logic and I/O pins.

Legend: CMOS = CMOS compatible input or output ST = Schmitt Trigger input with CMOS levels

Analog = Analog input I = Input O = Output

evels

P = Power

2.0 CPU

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 2. CPU" (DS70245), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 CPU modules have a 16-bit (data) modified Harvard architecture with an enhanced instruction set and addressing modes. The CPU has a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M x 24 bits of user program memory space. The actual amount of program memory implemented varies by device. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double word move (MOV.D) instruction and the table instructions. Overhead-free, single-cycle program loop constructs are supported using the REPEAT instruction, which is interruptible at any point.

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices have sixteen, 16-bit working registers in the programmer's model. Each of the working registers can serve as a data, address or address offset register. The 16th working register (W15) operates as a software Stack Pointer (SP) for interrupts and calls.

The PIC24HJ32GP202/204 and PIC24HJ16GP304 instruction set includes many addressing modes and is designed for optimum C compiler efficiency. For most instructions, the PIC24HJ32GP202/204 and PIC24HJ16GP304 is capable of executing a data (or program data) memory read, a working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing A + B = C operations to be executed in a single cycle.

A block diagram of the CPU is shown in Figure 2-1, and the programmer's model for the PIC24HJ32GP202/204 and PIC24HJ16GP304 is shown in Figure 2-2.

2.1 Data Addressing Overview

The data space can be linearly addressed as 32K words or 64 Kbytes using an Address Generation Unit (AGU). The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K program word boundary defined by the 8-bit Program Space Visibility Page (PSVPAG) register. The program to data space mapping feature lets any instruction access program space as if it were data space.

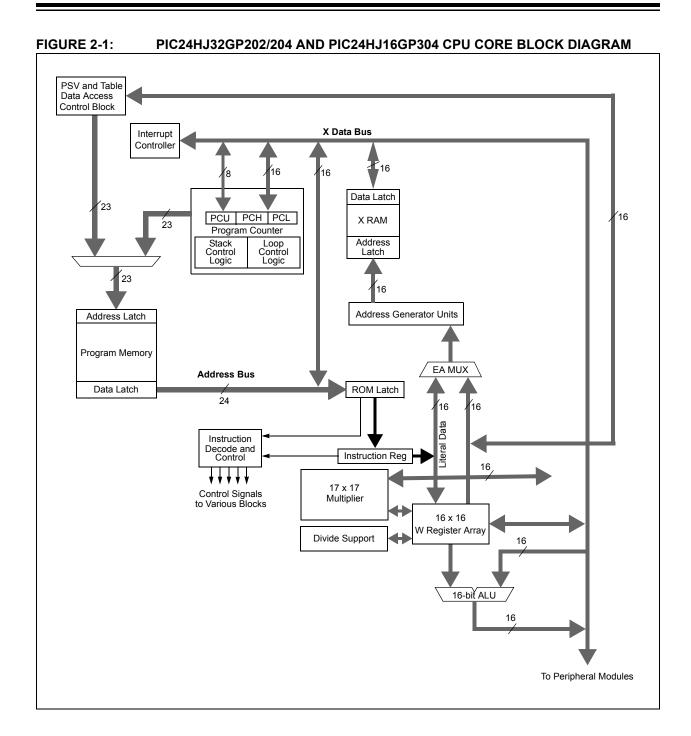
The data space also includes 2 Kbytes of DMA RAM, which is primarily used for DMA data transfers, but this may be used as general purpose RAM.

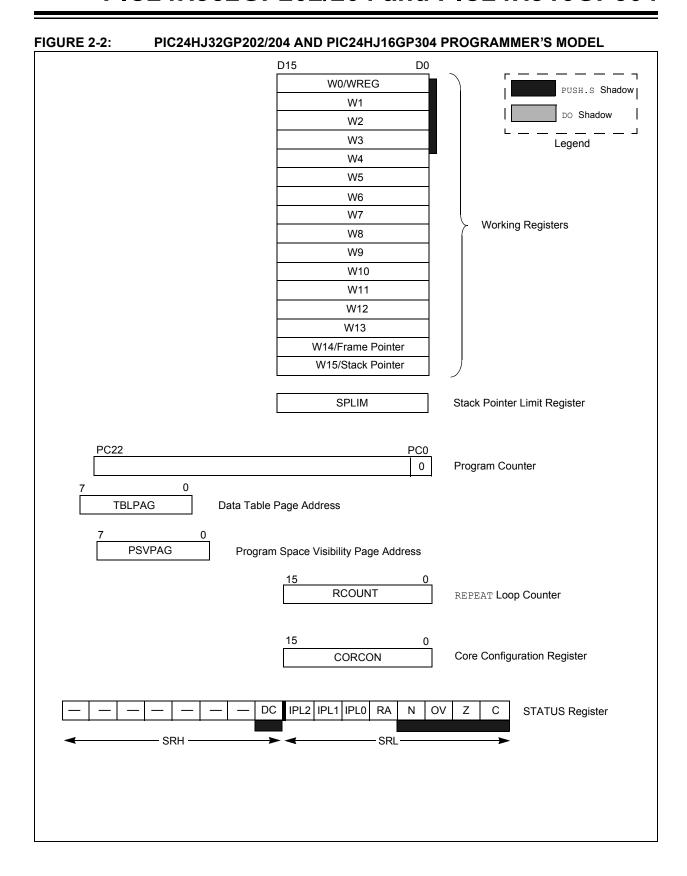
2.2 Special MCU Features

The PIC24HJ32GP202/204 and PIC24HJ16GP304 feature a 17-bit by 17-bit, single-cycle multiplier. The multiplier can perform signed, unsigned and mixed-sign multiplication. Using a 17-bit by 17-bit multiplier for 16-bit by 16-bit multiplication makes mixed-sign multiplication possible.

The PIC24HJ32GP202/204 and PIC24HJ16GP304 supports 16/16 and 32/16 integer divide operations. All divide instructions are iterative operations. They must be executed within a REPEAT loop, resulting in a total execution time of 19 instruction cycles. The divide operation can be interrupted during any of those 19 cycles without loss of data.

A multi-bit data shifter is used to perform up to a 16-bit, left or right shift in a single cycle.





2.3 CPU Control Registers

REGISTER 2-1: SR: CPU STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	-	_	_	_	DC
bit 15							bit 8

R/W-0 ⁽¹⁾	R/W-0 ⁽²⁾	R/W-0 ⁽²⁾	R-0	R/W-0	R/W-0	R/W-0	R/W-0
	IPL<2:0> ⁽²⁾		RA	N	OV	Z	С
bit 7							bit 0

Legend:

C = Clear only bit R = Readable bit U = Unimplemented bit, read as '0'

S = Set only bit W = Writable bit -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8 **DC:** MCU ALU Half Carry/Borrow bit

1 = A carry-out from the 4th low-order bit (for byte sized data) or 8th low-order bit (for word sized data) of the result occurred

0 = No carry-out from the 4th low-order bit (for byte sized data) or 8th low-order bit (for word sized data) of the result occurred

bit 7-5 IPL<2:0>: CPU Interrupt Priority Level Status bits⁽²⁾

111 = CPU Interrupt Priority Level is 7 (15), user interrupts disabled

110 = CPU Interrupt Priority Level is 6 (14)

101 = CPU Interrupt Priority Level is 5 (13)

100 = CPU Interrupt Priority Level is 4 (12)

011 = CPU Interrupt Priority Level is 3 (11)

010 = CPU Interrupt Priority Level is 2 (10)

001 = CPU Interrupt Priority Level is 1 (9)

000 = CPU Interrupt Priority Level is 0 (8)

bit 4 RA: REPEAT Loop Active bit

1 = REPEAT loop in progress

0 = REPEAT loop not in progress

bit 3 N: MCU ALU Negative bit

1 = Result was negative

0 = Result was non-negative (zero or positive)

bit 2 **OV:** MCU ALU Overflow bit

This bit is used for signed arithmetic (2's complement). It indicates an overflow of the magnitude which causes the sign bit to change state.

1 = Overflow occurred for signed arithmetic (in this arithmetic operation)

0 = No overflow occurred

bit 1 Z: MCU ALU Zero bit

1 = An operation which affects the Z bit has set it at some time in the past

0 = The most recent operation which affects the Z bit has cleared it (i.e., a non-zero result)

bit 0 C: MCU ALU Carry/Borrow bit

1 = A carry-out from the Most Significant bit (MSb) of the result occurred

0 = No carry-out from the Most Significant bit of the result occurred

Note 1: The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.

2: The IPL<2:0> Status bits are read-only when NSTDIS = 1 (INTCON1<15>).

REGISTER 2-2: CORCON: CORE CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0 U-0		R/C-0	R/W-0	U-0	U-0
_			_	IPL3 ⁽¹⁾	PSV	_	_
bit 7							bit 0

Legend:C = Clear only bitR = Readable bitW = Writable bit-n = Value at POR'1' = Bit is set0' = Bit is cleared'x = Bit is unknownU = Unimplemented bit, read as '0'

bit 15-4 Unimplemented: Read as '0'

bit 3 IPL3: CPU Interrupt Priority Level Status bit 3⁽¹⁾
1 = CPU interrupt priority level is greater than 7

0 = CPU interrupt priority level is 7 or less

bit 2 PSV: Program Space Visibility in Data Space Enable bit

1 = Program space visible in data space0 = Program space not visible in data space

bit 1-0 **Unimplemented:** Read as '0'

Note 1: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU interrupt priority level.

2.4 Arithmetic Logic Unit (ALU)

The PIC24HJ32GP202/204 and PIC24HJ16GP304 Arithmetic Logic Unit (ALU) is 16 bits wide and is capable of addition, subtraction, bit shifts and logic operations. Unless otherwise mentioned, arithmetic operations are 2's complement in nature. The ALU may affect the values of the Carry (C), Zero (Z), Negative (N), Overflow (OV) and Digit Carry (DC) Status bits in the SR register depending on the operation. The C and DC Status bits operate as Borrow and Digit Borrow bits respectively, for subtraction operations.

The ALU can perform 8-bit or 16-bit operations depending on the mode of the instruction that is used. Data for the ALU operation can come from the W register array, or data memory depending on the addressing mode of the instruction. Likewise, output data from the ALU can be written to the W register array or a data memory location.

Refer to the "dsPIC30F/33F Programmer's Reference Manual" (DS70157) for more information on the SR bits affected by each instruction.

The PIC24HJ32GP202/204 and PIC24HJ16GP304 CPU incorporates hardware support for both multiplication and division. This includes a dedicated hardware multiplier and a support hardware for 16-bit-divisor division.

2.4.1 MULTIPLIER

Using the high-speed 17-bit x 17-bit multiplier, the ALU supports unsigned, signed or mixed-sign operation in several multiplication modes:

- 16-bit x 16-bit signed
- · 16-bit x 16-bit unsigned
- 16-bit signed x 5-bit (literal) unsigned
- 16-bit unsigned x 16-bit unsigned
- · 16-bit unsigned x 5-bit (literal) unsigned
- · 16-bit unsigned x 16-bit signed
- · 8-bit unsigned x 8-bit unsigned

2.4.2 DIVIDER

The divide block supports 32-bit/16-bit and 16-bit/16-bit signed and unsigned integer divide operations with the following data sizes.

- 1. 32-bit signed/16-bit signed divide
- 2. 32-bit unsigned/16-bit unsigned divide
- 3. 16-bit signed/16-bit signed divide
- 4. 16-bit unsigned/16-bit unsigned divide

The quotient for all divide instructions ends up in W0 and the remainder in W1. A 16-bit signed and unsigned DIV instructions can specify any W register for both the 16-bit divisor (Wn) and any W register (aligned) pair (W(m + 1):Wm) for the 32-bit dividend. The divide algorithm takes one cycle per bit of divisor, so both 32-bit/16-bit and 16-bit/16-bit instructions take the same number of cycles to execute.

2.4.3 MULTI-BIT DATA SHIFTER

The multi-bit data shifter is capable of performing up to 16-bit arithmetic or logic right shifts, or up to 16-bit left shifts in a single cycle. The source can be either a working register or a memory location.

The shifter requires a signed binary value to determine both the magnitude (number of bits) and direction of the shift operation. A positive value shifts the operand right. and a negative value shifts the operand left. A value of '0' does not modify the operand.

3.0 MEMORY ORGANIZATION

Note: This data sheet summarizes the features PIC24HJ32GP202/204 the PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 3. Data Memory" (DS70237), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 architecture features separate program and data memory spaces and buses. This architecture also allows the direct access of program memory from the data space during code execution.

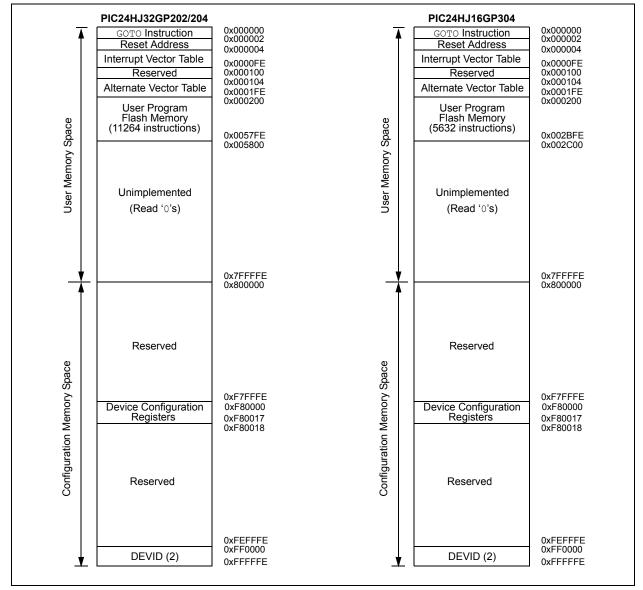
3.1 Program Address Space

The program address memory space of the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices is 4M instructions. The space is addressable by a 24-bit value derived either from the 23-bit Program Counter (PC) during program execution, or from table operation or data space remapping as described in Section 3.4 "Interfacing Program and Data Memory Spaces".

User application access to the program memory space is restricted to the lower half of the address range (0x0000000 to 0x7FFFFF). The exception is the use of TBLRD/TBLWT operations, which use TBLPAG<7> to permit access to the Configuration bits and Device ID sections of the configuration memory space.

The memory maps for the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices are shown in Figure 3-1.

FIGURE 3-1: PROGRAM MEMORY FOR PIC24HJ32GP202/204 AND PIC24HJ16GP304 DEVICES



3.1.1 PROGRAM MEMORY ORGANIZATION

The program memory space is organized in word-addressable blocks. Although it is treated as 24 bits wide, it is more appropriate to think of each address of the program memory as a lower and upper word, with the upper byte of the upper word being unimplemented. The lower word always has an even address, while the upper word has an odd address (See Figure 3-2).

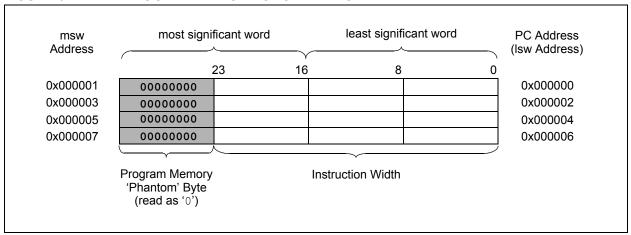
Program memory addresses are always word-aligned on the lower word, and addresses are incremented or decremented by two during code execution. This arrangement provides compatibility with data memory space addressing and makes data in the program memory space accessible.

3.1.2 INTERRUPT AND TRAP VECTORS

All PIC24HJ32GP202/204 and PIC24HJ16GP304 devices reserve the addresses between 0x00000 and 0x0000200 for hard-coded program execution vectors. A hardware Reset vector is provided to redirect code execution from the default value of the PC on device Reset to the actual start of code. A GOTO instruction is programmed by the user application at 0x0000000, with the actual address for the start of code at 0x0000002.

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices also have two interrupt vector tables, located from 0x000004 to 0x0000FF and 0x000100 to 0x0001FF. These vector tables allow each of the many device interrupt sources to be handled by separate Interrupt Service Routines (ISRs). Section 6.1 "Interrupt Vector Table" provides a more detailed discussion of the interrupt vector tables.

FIGURE 3-2: PROGRAM MEMORY ORGANIZATION



3.2 Data Address Space

The PIC24HJ32GP202/204 and PIC24HJ16GP304 CPU has a separate 16-bit-wide data memory space. The data space is accessed using separate Address Generation Units (AGUs) for read and write operations. The data memory maps is shown in Figure 3-3.

All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to the bytes within the data space. This arrangement gives a data space address range of 64 Kbytes or 32K words. The lower half of the data memory space (that is, when EA<15> = 0) is used for implemented memory addresses, while the upper half (EA<15> = 1) is reserved for the Program Space Visibility area (see Section 3.4.3 "Reading Data From Program Memory Using Program Space Visibility").

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices implement up to 30 Kbytes of data memory. Should an EA point to a location outside of this area, an all-zero word or byte will be returned.

3.2.1 DATA SPACE WIDTH

The data memory space is organized in byte addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all data space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

3.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® devices and improve data space memory usage efficiency, the PIC24HJ32GP202/204 and PIC24HJ16GP304 instruction set supports both word and byte operations. As a consequence of byte accessibility, all effective address calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word that contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register that matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or when translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap is generated. If the error occurred on a read, the instruction underway is completed. If the instruction occurred on a write, the instruction is executed but the write does not occur. In either case, a trap is then executed, allowing the system and/or user application to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the Least Significant Byte. The Most Significant Byte is not modified.

A sign-extend instruction (SE) is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, user applications can clear the MSB of any W register by executing a zero-extend (ZE) instruction on the appropriate address.

3.2.3 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0x0000 to 0x07FF, is primarily occupied by Special Function Registers (SFRs). These are used by the PIC24HJ32GP202/204 and PIC24HJ16GP304 core and peripheral modules to control the operation of the device.

SFRs are distributed among the modules that they control, and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'. A complete listing of implemented SFRs, including their addresses, is shown in Table 3-1 through Table 3-22.

Note: The actual set of peripheral features and interrupts varies by the device. Refer to the corresponding device tables and pinout diagrams for device-specific information.

3.2.4 NEAR DATA SPACE

The 8 Kbyte area between 0x0000 and 0x1FFF is referred to as the Near Data Space. Locations in this space are directly addressable via 13-bit absolute address field within all memory direct instructions. Additionally, the whole data space is addressable using MoV instructions, which support Memory Direct Addressing mode with a 16-bit address field, or by using Indirect Addressing mode using a working register as an address pointer.

FIGURE 3-3: DATA MEMORY MAP FOR PIC24HJ32GP202/204 AND PIC24HJ16GP304 DEVICES WITH 2 KB RAM

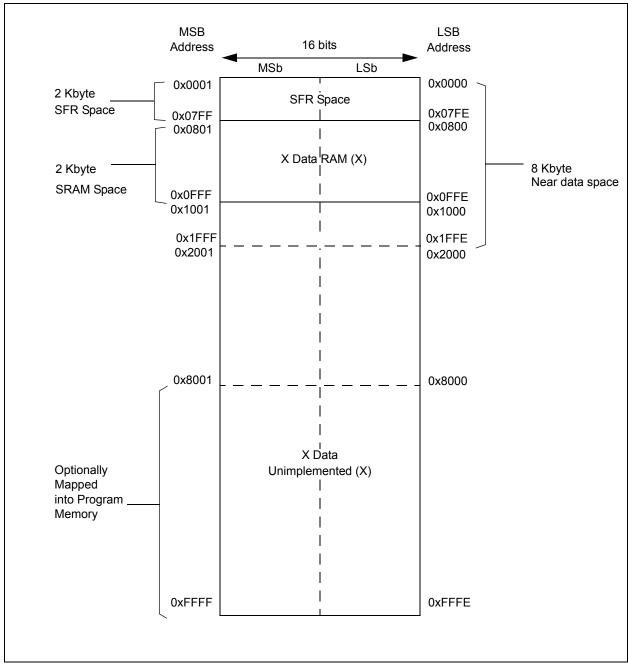


TABLE 3-1: CPU CORE REGISTERS MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
WREG0	0000								Working Re	gister 0								0000
WREG1	0002								Working Re	gister 1								0000
WREG2	0004								Working Re	gister 2								0000
WREG3	0006								Working Re	gister 3								0000
WREG4	8000								Working Re	gister 4								0000
WREG5	000A								Working Re	gister 5								0000
WREG6	000C		Working Register 6													0000		
WREG7	000E		Working Register 7													0000		
WREG8	0010		Working Register 8													0000		
WREG9	0012		Working Register 9													0000		
WREG10	0014		Working Register 10													0000		
WREG11	0016								Working Re	gister 11								0000
WREG12	0018								Working Re	gister 12								0000
WREG13	001A								Working Re	gister 13								0000
WREG14	001C								Working Re	gister 14								0000
WREG15	001E								Working Re	gister 15								0800
SPLIM	0020							Sta	ck Pointer Li	mit Register								xxxx
PCL	002E							Program	Counter Lo	w Word Reg	gister							0000
PCH	0030		_	_		-	_	_	_			Progra	m Counter	High Byte R	Register			0000
TBLPAG	0032	ı	_	_	ı	ı	-	_	_			Table F	Page Addre	ss Pointer R	Register			0000
PSVPAG	0034		_	Program Memory Visibility Page Address Pointer Register											0000			
RCOUNT	0036				Repeat Loop Counter Register											XXXX		
SR	0042	-	_	_	_	_	_		DC	IPL2	IPL1	IPL0	RA	N	OV	Z	С	0000
CORCON	0044	_	_	_	_	_	_	_	_	_		_	_	IPL3	PSV	_	_	0000
DISICNT	0052	_	_						Disable	Interrupts	Counter R	egister						xxxx

TABLE 3-2: CHANGE NOTIFICATION REGISTER MAP FOR PIC24HJ32GP202

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CNEN1	0060	CN15IE	CN14IE	CN13IE	CN12IE	CN11IE		_	_	CN7IE	CN6IE	CN5IE	CN4IE	CN3IE	CN2IE	CN1IE	CN0IE	0000
CNEN2	0062	_	CN30IE	CN29IE		CN27IE		_	CN24IE	CN23IE	CN22IE	CN21IE			_	_	CN16IE	0000
CNPU1	0068	CN15PUE	CN14PUE	CN13PUE	CN12PUE	CN11PUE		_	_	CN7PUE	CN6PUE	CN5PUE	CN4PUE	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000
CNPU2	006A	_	CN30PUE	CN29PUE	_	CN27PUE	_	_	CN24PUE	CN23PUE	CN22PUE	CN21PUE	_	_	_	_	CN16PUE	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-3: CHANGE NOTIFICATION REGISTER MAP FOR PIC24HJ32GP204 AND PIC24HJ16GP304

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
CNEN1	0060	CN15IE	CN14IE	CN13IE	CN12IE	CN11IE	CN10IE	CN9IE	CN8IE	CN7IE	CN6IE	CN5IE	CN4IE	CN3IE	CN2IE	CN1IE	CN0IE	0000
CNEN2	0062	_	CN30IE	CN29IE	CN28IE	CN27IE	CN26IE	CN25IE	CN24IE	CN23IE	CN22IE	CN21IE	CN20IE	CN19IE	CN18IE	CN17IE	CN16IE	0000
CNPU1	0068	CN15PUE	CN14PUE	CN13PUE	CN12PUE	CN11PUE	CN10PUE	CN9PUE	CN8PUE	CN7PUE	CN6PUE	CN5PUE	CN4PUE	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000
CNPU2	006A	_	CN30PUE	CN29PUE	CN28PUE	CN27PUE	CN26PUE	CN25PUE	CN24PUE	CN23PUE	CN22PUE	CN21PUE	CN20PUE	CN19PUE	CN18PUE	CN17PUE	CN16PUE	0000

PIC24HJ32GP202/204 and PIC24HJ16GP304

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TABLE 3-4: INTERRUPT CONTROLLER REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
INTCON1	0800	NSTDIS	_	_	_	_	1	_	_	_	DIV0ERR	_	MATHERR	ADDRERR	STKERR	OSCFAIL	_	0000
INTCON2	0082	ALTIVT	DISI	_	-	_	_	_	_	-	_	1	ı	_	INT2EP	INT1EP	INT0EP	0000
IFS0	0084	_	I	AD1IF	U1TXIF	U1RXIF	SPI1IF	SPI1EIF	T3IF	T2IF	OC2IF	IC2IF	I	T1IF	OC1IF	IC1IF	INT0IF	0000
IFS1	0086	_	1	INT2IF	_	_		_	_	IC8IF	IC7IF		INT1IF	CNIF		MI2C1IF	SI2C1IF	0000
IFS4	008C	_	1	_	_	_		_	_	_	_		ı	_		U1EIF	_	0000
IEC0	0094	_	1	AD1IE	U1TXIE	U1RXIE	SPI1IE	SPI1EIE	T3IE	T2IE	OC2IE	IC2IE	ı	T1IE	OC1IE	IC1IE	INT0IE	0000
IEC1	0096	_	I	INT2IE	_	_		_	_	IC8IE	IC7IE	-	INT1IE	CNIE	ı	MI2C1IE	SI2C1IE	0000
IEC4	009C	_	1	_	_	_		_	_	_	_		ı	_		U1EIE	_	0000
IPC0	00A4	_		T1IP<2:0>		_	(OC1IP<2:0	>	_		IC1IP<2:0>		_	11	NT0IP<2:0>	•	4444
IPC1	00A6	_		T2IP<2:0>		_	(OC2IP<2:0	>	_		IC2IP<2:0>		_	_	_	_	4440
IPC2	8A00	_	J	J1RXIP<2:0)>	_	8	SPI1IP<2:0	>	-	;	SPI1EIP<2:0	>	_	•	T3IP<2:0>		4444
IPC3	00AA	_		_	_	_	_	_	_	_		AD1IP<2:0>	•	_	U	1TXIP<2:0	>	0044
IPC4	00AC	_		CNIP<2:0>	•	_		_	_	-	ı	MI2C1IP<2:0	>	_	SI	2C1IP<2:0	>	4044
IPC5	00AE	_		IC8IP<2:0>	•	_		IC7IP<2:0	>	-	_	-	I	_	II.	NT1IP<2:0>	•	4404
IPC7	00B2	_	I	_	_	_		_	_	-		INT2IP<2:0	>	_	ı	-	_	0040
IPC16	00C4	_	_	_	_	_	_	_	_	_		U1EIP<2:0>		_	_	_	_	0040
INTTREG	00E0	_		_	_		ILR<	3:0>		_			VE	CNUM<6:0>				0000

TABLE 3-5:	TIMER	REGISTER	MAP
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SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TMR1	0100														xxxx			
PR1	0102															FFFF		
T1CON	0104	TON														0000		
TMR2	0106		Ç														xxxx	
TMR3HLD	0108						Time	er3 Holding I	Register (for	32-bit timer	operations	only)						xxxx
TMR3	010A								Timer3	Register								xxxx
PR2	010C								Period R	Register 2								FFFF
PR3	010E								Period R	Register 3								FFFF
T2CON	0110	TON	_	TSIDL	-	_	_	_	_	_	TGATE	TCKP	S<1:0>	T32	_	TCS	_	0000
T3CON	0112	TON	_	TSIDL	_	_	_	_	_	_	TGATE	TCKP	S<1:0>	_	_	TCS	_	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-6: INPUT CAPTURE REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IC1BUF	0140								Input 1 Capt	ure Register	r							xxxx
IC1CON	0142	_	_	ICSIDL	ı	_	ı	_	_	ICTMR	ICI<	:1:0>	ICOV	ICBNE		ICM<2:0>		0000
IC2BUF	0144								Input 2 Capt	ture Register	r							XXXX
IC2CON	0146	-	_	ICSIDL	ı	_	-	_	_	ICTMR	ICI<	:1:0>	ICOV	ICBNE		ICM<2:0>		0000
IC7BUF	0158								Input 7 Capt	ture Register	r							XXXX
IC7CON	015A	-	_	ICSIDL	ı	_	-	_	_	ICTMR	ICI<	:1:0>	ICOV	ICBNE		ICM<2:0>		0000
IC8BUF	015C								Input 8Capt	ure Register	-							XXXX
IC8CON	015E	-	_	ICSIDL		_	_	_	_	ICTMR	ICI<	1:0>	ICOV	ICBNE		ICM<2:0>		0000

PIC24HJ32GP202/204 and PIC24HJ16GP304

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-7: OUTPUT COMPARE REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
OC1RS	0180							Output	Compare 1	Secondary I	Register							xxxx
OC1R	0182							0	utput Comp	are 1 Regist	ter							xxxx
OC1CON	0184	_	_	OCSIDL	_	_	_	_	_	_	_	_	OCFLT	OCTSEL		OCM<2:0>		0000
OC2RS	0186							Output	Compare 2	Secondary I	Register							xxxx
OC2R	0188							0	utput Comp	are 2 Regist	ter							xxxx
OC2CON	018A	_	-	OCSIDL	ı	_	_	_	_	_	_	-	OCFLT	OCTSEL		OCM<2:0>		0000

TABLE 3-8: I2C1 REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets		
I2C1RCV	0200	1	1	-	_	_	_	_	_				Receive	Register				0000		
I2C1TRN	0202	-	_	_	_	_	_	_	-	Transmit Register										
I2C1BRG	0204	-	_	_	_	_	_	_		Baud Rate Generator Register										
I2C1CON	0206	I2CEN	_	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN	GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	1000		
I2C1STAT	0208	ACKSTAT	TRSTAT	_	_	_	BCL	GCSTAT	ADD10	IWCOL	I2COV	D_A	Р	S	R_W	RBF	TBF	0000		
I2C1ADD	020A	-	_	_	_	_	_			Address Register										
I2C1MSK	020C	_	_	_	_	_	_			Address Register Address Mask Register										

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-9: UART1 REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
U1MODE	0220	UARTEN	_	USIDL	IREN	RTSMD	_	UEN1	UEN0	WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSE	L<1:0>	STSEL	0000
U1STA	0222	UTXISEL1	UTXINV	UTXISEL0	-	UTXBRK	UTXEN	UTXBF	TRMT	URXISE	EL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
U1TXREG	0224	_	-	-	-	_	-	_				UART	Transmit Re	gister				xxxx
U1RXREG	0226	_	-	-	-	_	-	_	— UART Receive Register									0000
U1BRG	0228		Baud Rate Generator Prescaler												0000			

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-10: SPI1 REGISTER MAP

SFR Name	SFR Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
SPI1STAT	0240	SPIEN	_	SPISIDL				-	_	-	SPIROV		-	_	_	SPITBF	SPIRBF	0000
SPI1CON1	0242	_	_	_	DISSCK	DISSDO	MODE16	SMP	CKE	SSEN	CKP	MSTEN		SPRE<2:0>	•	PPRE	<1:0>	0000
SPI1CON2	0244	FRMEN	SPIFSD	FRMPOL	_	_	_	_	_	_	_	_	_	_	_	FRMDLY	_	0000
SPI1BUF	0248							SPI1 Trans	mit and Red	ceive Buffer	Register							0000

PIC24HJ32GP202/204 and PIC24HJ16GP304

TABLE 3-11: PERIPHERAL PIN SELECT INPUT REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPINR0	0680		1	-		I	NT1R<4:0>	•		_		1	_	_	_	_	1	1F00
RPINR1	0682	1	1	1		I		1	I	1	1	ı		I	INT2R<4:0>	•		001F
RPINR3	0686	1	1	1		Т	3CKR<4:0>	>			1	1		7	T2CKR<4:0	>		1F1F
RPINR7	068E	1	1	1			IC2R<4:0>			1	1	1			IC1R<4:0>			1F1F
RPINR10	0694	1	1	1			IC8R<4:0>				1	1			IC7R<4:0>			1F1F
RPINR11	0696	1	1	1		I		1	I	1	1	ı		(OCFAR<4:0	>		001F
RPINR18	06A4			1		U	1CTSR<4:0)>			-	1		ι	J1RXR<4:0	>		1F1F
RPINR20	06A8	1	1	1		S	CK1R<4:0	>			1	1		:	SDI1R<4:0>			1F1F
RPINR21	06AA	-	-	_	_		_	-	-	-		_			SS1R<4:0>			001F

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-12: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR PIC24HJ32GP202

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPOR0	06C0	1	-	1			RP1R<4:0>			_	_	_			RP0R<4:0>			0000
RPOR1	06C2	I	1	I			RP3R<4:0>			_	_	ı			RP2R<4:0>			0000
RPOR2	06C4	1	-	-			RP5R<4:0>			_	_	-			RP4R<4:0>			0000
RPOR3	06C6			1			RP7R<4:0>			_	_	1			RP6R<4:0>			0000
RPOR4	06C8	1	-	-			RP9R<4:0>			_	_	-			RP8R<4:0>			0000
RPOR5	06CA			1		ı	RP11R<4:0>	>		_	_	1		ı	RP10R<4:0	>		0000
RPOR6	06CC		_	-			RP13R<4:0>	>	•	_	_	-		-	RP12R<4:0	•	•	0000
RPOR7	06CE	_	_	-			RP15R<4:0>	>		_	_	_		-	RP14R<4:0	•		0000

TABLE 3-13: PERIPHERAL PIN SELECT OUTPUT REGISTER MAP FOR PIC24HJ32GP204 AND PIC24HJ16GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPOR0	06C0	_	_	_			RP1R<4:0>			_	_				RP0R<4:0>	•		0000
RPOR1	06C2	_	_	_			RP3R<4:0>			_	_	_			RP2R<4:0>	•		0000
RPOR2	06C4	_	_	_			RP5R<4:0>			_	_	_			RP4R<4:0>	•		0000
RPOR3	06C6	_	_	_			RP7R<4:0>			_	_	_			RP6R<4:0>	•		0000
RPOR4	06C8	_	_	_			RP9R<4:0>			_	_				RP8R<4:0>	•		0000
RPOR5	06CA	_	_	_		I	RP11R<4:0	>		_	_	_			RP10R<4:0	>		0000
RPOR6	06CC	_	_	_		ı	RP13R<4:0	>		_	_	_		I	RP12R<4:0	>		0000
RPOR7	06CE	_	_	_		ı	RP15R<4:0	>		_	_	_		1	RP14R<4:0	>		0000
RPOR8	06D0	_	_	_		ı	RP17R<4:0	>		_	_	_		I	RP16R<4:0	>		0000
RPOR9	06D2	_	_	_		ı	RP19R<4:0	>		_	_				RP18R<4:0	>		0000
RPOR10	06D4	_	_	_		ı	RP21R<4:0	>		_	_	_		I	RP20R<4:0	>		0000
RPOR11	06D6	_	_	_		ı	RP23R<4:0	>		_	_	_		I	RP22R<4:0	>		0000
RPOR12	06D8		_	_		ı	RP25R<4:0	>		_		1		I	RP24R<4:0	>		0000

TABLE 3-14: ADC1 REGISTER MAP FOR PIC24HJ32GP204 AND PIC24HJ16GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ADC1BUF0	0300								ADC Data	Buffer 0								xxxx
ADC1BUF1	0302								ADC Data	Buffer 1								xxxx
ADC1BUF2	0304								ADC Data	Buffer 2								xxxx
ADC1BUF3	0306								ADC Data	Buffer 3								xxxx
ADC1BUF4	0308								ADC Data	Buffer 4								xxxx
ADC1BUF5	030A								ADC Data	Buffer 5								xxxx
ADC1BUF6	030C								ADC Data	Buffer 6								xxxx
ADC1BUF7	030E								ADC Data	Buffer 7								xxxx
ADC1BUF8	0310								ADC Data	Buffer 8								xxxx
ADC1BUF9	0312								ADC Data	Buffer 9								xxxx
ADC1BUFA	0314		ADC Data Buffer 10													xxxx		
ADC1BUFB	0316								ADC Data	Buffer 11								xxxx
ADC1BUFC	0318								ADC Data	Buffer 12								xxxx
ADC1BUFD	031A								ADC Data	Buffer 13								xxxx
ADC1BUFE	031C								ADC Data	Buffer 14								xxxx
ADC1BUFE	031E								ADC Data	Buffer 15								xxxx
AD1CON1	0320	ADON	_	ADSIDL		_	AD12B	FORI	M<1:0>	Ç	SSRC<2:0>		_	SIMSAM	ASAM	SAMP	DONE	0000
AD1CON2	0322	,	VCFG<2:0>	>	_	_	CSCNA	CHP	S<1:0>	BUFS	_		SMPI	<3:0>		BUFM	ALTS	0000
AD1CON3	0324	ADRC	_	_	SAMC<4:0> ADCS<7:0>												0000	
AD1CHS123	0326	_	_	_	_	_	CH123N	NB<1:0>	CH123SB	_	_	_	_	_	CH123N	NA<1:0>	CH123SA	0000
AD1CHS0	0328	CH0NB	_	_		С	H0SB<4:0>	>		CH0NA	_	_		C	H0SA<4:0	>		0000
AD1PCFGL	032C	_	-	_	PCFG12	PCFG11	PCFG10	PCFG9	PCFG8	PCFG7	PCFG6	PCFG5	PCFG4	PCFG3	PCFG2	PCFG1	PCFG0	0000
AD1CSSL	0330	_	_	_	CSS12	CSS11	CSS10	CSS9	CSS8	CSS7	CSS6	CSS5	CSS4	CSS3	CSS2	CSS1	CSS0	0000

TABLE 3-15: ADC1 REGISTER MAP FOR PIC24HJ32GP202

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
ADC1BUF0	0300								ADC Data	a Buffer 0								xxxx
ADC1BUF1	0302								ADC Data	a Buffer 1								xxxx
ADC1BUF2	0304								ADC Data	a Buffer 2								xxxx
ADC1BUF3	0306								ADC Data	a Buffer 3								xxxx
ADC1BUF4	0308								ADC Data	a Buffer 4								xxxx
ADC1BUF5	030A								ADC Data	a Buffer 5								xxxx
ADC1BUF6	030C								ADC Data	a Buffer 6								xxxx
ADC1BUF7	030E								ADC Data	a Buffer 7								xxxx
ADC1BUF8	0310								ADC Data	a Buffer 8								xxxx
ADC1BUF9	0312								ADC Data	a Buffer 9								xxxx
ADC1BUFA	0314		ADC Data Buffer 10														xxxx	
ADC1BUFB	0316		ADC Data Buffer 10 ADC Data Buffer 11														xxxx	
ADC1BUFC	0318								ADC Data	Buffer 12								xxxx
ADC1BUFD	031A								ADC Data	Buffer 13								xxxx
ADC1BUFE	031C								ADC Data	Buffer 14								xxxx
ADC1BUFF	031E								ADC Data	Buffer 15								xxxx
AD1CON1	0320	ADON	_	ADSIDL	_	_	AD12B	FORI	M<1:0>	9	SSRC<2:0	>	_	SIMSAM	ASAM	SAMP	DONE	0000
AD1CON2	0322	\	/CFG<2:0>	>		_	CSCNA	CHP	S<1:0>	BUFS	_		SMPI	<3:0>		BUFM	ALTS	0000
AD1CON3	0324	ADRC		_	- SAMC<4:0> ADCS<7:0>										0000			
AD1CHS123	0326	_	_	_	CH123NB<1:0> CH123SB										CH1231	VA<1:0>	CH123SA	0000
AD1CHS0	0328	CH0NB					CH0SB<4:0			CH0NA		_			CH0SA<4:		ı	0000
AD1PCFGL	032C				PCFG12	PCFG11	PCFG10		_	_		PCFG5	PCFG4	PCFG3	PCFG2	PCFG1	PCFG0	0000
AD1CSSL	0330	_	_	_	CSS12	CSS11	CSS10	CSS9	_	_	_	CSS5	CSS4	CSS3	CSS2	CSS1	CSS0	0000

TABLE 3-16: PORTA REGISTER MAP FOR PIC24HJ32GP202

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISA	02C0	1	_	ı	ı	_	_	1	-	ı			TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	001F
PORTA	02C2	1	_	_	ı	_	-	ı	ı	-	1	ı	RA4	RA3	RA2	RA1	RA0	xxxx
LATA	02C4	1	_	_	ı	_	-	ı	ı	-	1	ı	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx
ODCA	02C6	1	_	-	ı	_	-	ı	1	1	ı	1	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	xxxx

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-17: PORTA REGISTER MAP FOR PIC24HJ32GP204 AND PIC24HJ16GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISA	02C0	_	_	-		_	TRISA10	TRISA9	TRISA8	TRISA7		_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	079F
PORTA	02C2	ı	-	ı	ı	ı	RA10	RA9	RA8	RA7	ı	ı	RA4	RA3	RA2	RA1	RA0	xxxx
LATA	02C4	ı	-	ı	ı	ı	LATA10	LATA9	LATA8	LATA7	ı	ı	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx
ODCA	02C6	-	_	_	_	_	ODCA10	ODCA9	ODCA8	ODCA7	_	_	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	xxxx

PIC24HJ32GP202/204 and PIC24HJ16GP304

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 3-18: PORTB REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C8	TRISB15	TRISB14	TRISB13	TRISB12	TRISB11	TRISB10	TRISB9	TRISB8	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	FFFF
PORTB	02CA	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx
LATB	02CC	LATB15	LATB14	LATB13	LATB12	LATB11	LATB10	LATB9	LATB8	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx
ODCB	02CE	ODCB15	ODCB14	ODCB13	ODCB12	ODCB11	ODCB10	ODCB9	ODCB8	ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0	XXXX

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal for PinHigh devices.

TABLE 3-19: PORTC REGISTER MAP FOR PIC24HJ32GP204 AND PIC24HJ16GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISC	02D0	_	_	_		_		TRISC9	TRISC8	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	03FF
PORTC	02D2	ı	1	1	1	_	1	RC9	RC8	RC7	RC6	RC5	RC4	RC4	RC2	RC1	RC0	xxxx
LATC	02D4	1		1	1	_	1	LATC9	LATC8	LATC7	LATC6	LATC5	LATC4	LATC4	LATC2	LATC1	LATC0	xxxx
ODCC	02D6	ı	1	1	ı	_	ı	ODCC9	ODCC8	ODCC7	ODCC6	ODCC5	ODCC4	ODCC4	ODCC2	ODCC1	ODCC0	xxxx

TABLE 3-20: SYSTEM CONTROL REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	_	_	_	_	СМ	VREGS	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	_{XXXX} (1)
OSCCON	0742	_	(COSC<2:0>	>	_	1	NOSC<2:0:	>	CLKLOCK	IOLOCK	LOCK	_	CF	_	LPOSCEN	OSWEN	0300(2)
CLKDIV	0744	ROI	[OOZE<2:0>	>	DOZEN	F	RCDIV<2:0)>	PLLPOS	ST<1:0>	_		ı	PLLPRE<4	:0>		3040
PLLFBD	0746	1	_	ı	_	_		_			•	F	PLLDIV<8:0)>	•			0030
OSCTUN	0748	_	_	_	_	_	_	_	_	_	_		•	TUN	l<5:0>	•		0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: RCON register Reset values dependent on type of Reset.

2: OSCCON register Reset values dependent on the FOSC Configuration bits and by type of Reset.

TABLE 3-21: NVM REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
NVMCON	0760	WR	WREN	WRERR	_	_	_	-	_	1	ERASE	1	-	NVMOP<3:0>				0000(1)
NVMKEY	0766	_	_	_	_	_	_	_	_	NVMKEY<7:0>								0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: Reset value shown is for POR only. Value on other Reset states is dependent on the state of memory write or erase operations at the time of Reset.

TABLE 3-22: PMD REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
PMD1	0770	_	_	T3MD	T2MD	T1MD	_		_	I2C1MD	_	U1MD	_	SPI1MD	_	_	AD1MD	0000
PMD2	0772	IC8MD	IC7MD	_	1	_	_	IC2MD	IC1MD	_	_	-	-	_	_	OC2MD	OC1MD	0000

3.2.5 SOFTWARE STACK

In addition to its use as a working register, the W15 register in the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices is also used as a software Stack Pointer. The Stack Pointer always points to the first available free word and grows from lower to higher addresses. It pre-decrements for stack pops and post-increments for stack pushes, as shown in Figure 3-4. For a PC push during any CALL instruction, the MSB of the PC is zero-extended before the push, ensuring that the MSB is always clear.

Note: A PC push during exception processing concatenates the SRL register to the MSB of the PC prior to the push.

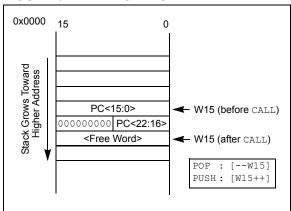
The Stack Pointer Limit register (SPLIM) associated with the Stack Pointer sets an upper address boundary for the stack. SPLIM is uninitialized at Reset. Similarly, the Stack Pointer, SPLIM<0> is forced to '0' because all stack operations must be word aligned.

When an EA is generated using W15 as a source or destination pointer, the resulting address is compared with the value in SPLIM. If the contents of the Stack Pointer (W15) and the SPLIM register are equal and a push operation is performed, a stack error trap will not occur. The stack error trap will occur on a subsequent push operation. For example, to cause a stack error trap when the stack grows beyond address 0x2000 in RAM, initialize the SPLIM with the value 0x1FFE.

Similarly, a Stack Pointer underflow (stack error) trap is generated when the Stack Pointer address is found to be lesser than 0x0800. This prevents the stack from interfering with the Special Function Register (SFR) space.

A write to the SPLIM register should not be immediately followed by an indirect read operation using W15.

FIGURE 3-4: CALL STACK FRAME



3.2.6 DATA RAM PROTECTION FEATURE

The PIC24H product family supports Data RAM protection features that enable segments of RAM to be protected when used in conjunction with Boot and Secure Code Segment Security. BSRAM (Secure RAM segment for BS) is accessible only from the Boot Segment Flash code when enabled. SSRAM (Secure RAM segment for RAM) is accessible only from the Secure Segment Flash code when enabled. See Table 3-1 for an overview of the BSRAM and SSRAM SFRs.

3.3 Instruction Addressing Modes

The addressing modes shown in Table 3-23 form the basis of the addressing modes optimized to support the specific features of individual instructions. The addressing modes provided in the MAC class of instructions differ from those in the other instruction types.

3.3.1 FILE REGISTER INSTRUCTIONS

Most file register instructions use a 13-bit address field (f) to directly address data present in the first 8192 bytes of data memory (Near Data Space). Most file register instructions employ a working register, W0, which is denoted as WREG in these instructions. The destination is typically either the same file register or WREG (with the exception of the MUL instruction), which writes the result to a register or register pair. The $_{\rm MOV}$ instruction allows additional flexibility and can access the entire data space.

3.3.2 MCU INSTRUCTIONS

The three-operand MCU instructions are of the form:

Operand 3 = Operand 1 < function > Operand 2

where, Operand 1 is always a working register (that is, the addressing mode can only be register direct), which is referred to as Wb. Operand 2 can be a W register, fetched from data memory, or a 5-bit literal. The result location can be either a W register or a data memory location. The following addressing modes are supported by MCU instructions:

- · Register Direct
- · Register Indirect
- · Register Indirect Post-Modified
- · Register Indirect Pre-Modified
- 5-bit or 10-bit Literal

Note: Not all instructions support all the addressing modes given above. Individual instructions can support different subsets of these addressing modes.

TABLE 3-23: FUNDAMENTAL ADDRESSING MODES SUPPORTED

Addressing Mode	Description
File Register Direct	The address of the file register is specified explicitly.
Register Direct	The contents of a register are accessed directly.
Register Indirect	The contents of Wn forms the Effective Address (EA.)
Register Indirect Post-Modified	The contents of Wn forms the EA. Wn is post-modified (incremented or decremented) by a constant value.
Register Indirect Pre-Modified	Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA.
Register Indirect with Register Offset (Register Indexed)	The sum of Wn and Wb forms the EA.
Register Indirect with Literal Offset	The sum of Wn and a literal forms the EA.

3.3.3 MOVE (MOV) INSTRUCTION

Move instructions provide a greater degree of addressing flexibility than the other instructions. In addition to the Addressing modes supported by most MCU instructions, MOV instructions also support Register Indirect with Register Offset Addressing mode. This is also referred to as Register Indexed mode.

Note: For the MOV instructions, the addressing mode specified in the instruction can differ for the source and the destination EA. However, the 4-bit Wb (Register Offset) field is shared by both source and destination (but typically only used by one).

In summary, move instructions support the following addressing modes:

- · Register Direct
- · Register Indirect
- · Register Indirect Post-modified
- · Register Indirect Pre-modified
- Register Indirect with Register Offset (Indexed)
- · Register Indirect with Literal Offset
- · 8-bit Literal
- 16-bit Literal

Note:	Not	all	instructions	support	all	the	
	addr	essir	ng modes give	n above. I	ndivi	dual	
	instructions may support different subsets						
	of the	ese a	addressing mo	odes.			

3.3.4 OTHER INSTRUCTIONS

Besides the addressing modes outlined previously, some instructions use literal constants of various sizes. For example, BRA (branch) instructions use 16-bit signed literals to specify the branch destination directly, whereas the DISI instruction uses a 14-bit unsigned literal field. In some instructions, such as ADD Acc, the source of an operand or result is implied by the opcode itself. Certain operations, such as NOP, do not have any operands.

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3.4 Interfacing Program and Data Memory Spaces

The PIC24HJ32GP202/204 and PIC24HJ16GP304 architecture uses a 24-bit-wide program space and a 16-bit wide data space. The architecture is also a modified Harvard scheme, which means that the data can also be present in the program space. To use this data successfully, it must be accessed in a way that preserves the alignment of information in both spaces.

Aside from normal execution, the PIC24HJ32GP202/204 and PIC24HJ16GP304 architecture provides two methods by which program space can be accessed during operation:

- Using table instructions to access individual bytes or words anywhere in the program space
- Remapping a portion of the program space into the data space (Program Space Visibility)

Table instructions allow an application to read or write to small areas of the program memory. This capability makes the method ideal for accessing data tables that need to be updated periodically. It also allows access to all bytes of the program word. The remapping method allows an application to access a large block of data on a read-only basis, which is ideal for look ups from a large table of static data. The application can only access the least significant word of the program word.

3.4.1 ADDRESSING PROGRAM SPACE

Since the address ranges for the data and program spaces are 16 and 24 bits, respectively, a method is needed to create a 23-bit or 24-bit program address from 16-bit data registers. The solution depends on the interface method to be used.

For table operations, the 8-bit Table Page register (TBLPAG) is used to define a 32K word region within the program space. This is concatenated with a 16-bit EA to arrive at a full 24-bit program space address. In this format, the Most Significant bit of TBLPAG is used to determine if the operation occurs in the user memory (TBLPAG<7> = 0) or the configuration memory (TBLPAG<7> = 1).

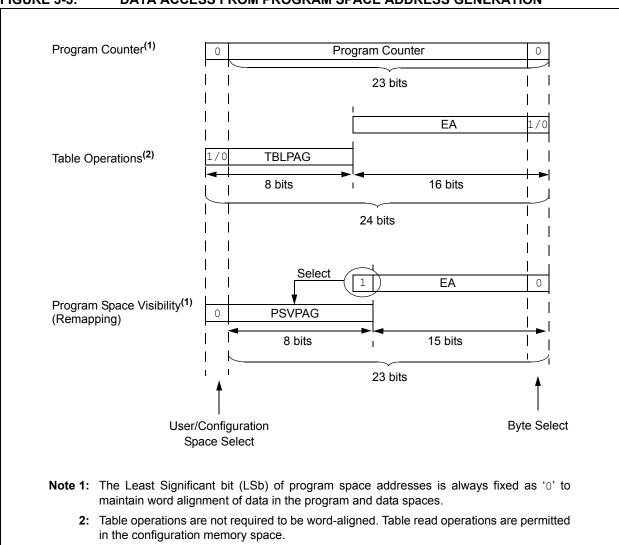
For remapping operations, the 8-bit Program Space Visibility register (PSVPAG) is used to define a 16K word page in the program space. When the Most Significant bit of the EA is '1', PSVPAG is concatenated with the lower 15 bits of the EA to form a 23-bit program space address. Unlike table operations, this limits remapping operations strictly to the user memory area.

Table 3-24 and Figure 3-5 show how the program EA is created for table operations and remapping accesses from the data EA. Here, P<23:0> refers to a program space word, and D<15:0> refers to a data space word.

TABLE 3-24: PROGRAM SPACE ADDRESS CONSTRUCTION

Access Tyres	Access		Prograi	m Space A	Address	
Access Type	Space	<23>	<22:16>	<15>	<14:1>	<0>
Instruction Access	User	0		PC<22:1>		0
(Code Execution)			0xx xxxx x	xxx xxx	x xxxx xxx0	
TBLRD/TBLWT	User	TBLPAG<7:0>		Data EA<15:0>		
(Byte/Word Read/Write)		0	xxx xxxx	XXXX XX	xx xxxx xxxx	
	Configuration	ТВ	LPAG<7:0>		Data EA<15:0>	
		1	xxx xxxx	XXXX X	xxx xxxx xxxx	
Program Space Visibility	User	0	PSVPAG<7:0>		Data EA<14:0>(1)	
(Block Remap/Read)		0	xxxx xxxx	ζ	xxx xxxx xxxx	XXXX

Note 1: Data EA<15> is always '1' in this case, but is not used in calculating the program space address. Bit 15 of the address is PSVPAG<0>.



3.4.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method to read or write the lower word of any address within the program space without going through data space. The TBLRDH and TBLWTH instructions are the only methods to read or write the upper 8 bits of a program space word as data.

The PC is incremented by 2 for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit wide word address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

Two table instructions are provided to move byte or word sized (16-bit) data to and from program space. Both function as either byte or word operations.

TBLRDL (Table Read Low): In Word mode, this
instruction maps the lower word of the program
space location (P<15:0>) to a data address
(D<15:0>).

In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.

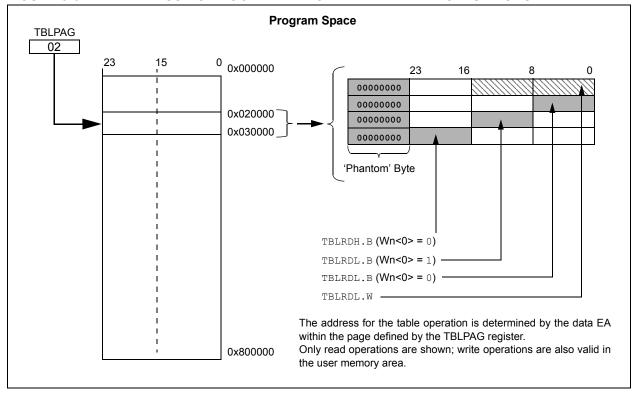
TBLRDH (Table Read High): In Word mode, this
instruction maps the entire upper word of a program
address (P<23:16>) to a data address. Note that
D<15:8>, the 'phantom byte', will always be '0'.

In Byte mode, this instruction maps the upper or lower byte of the program word to D<7:0> of the data address, as in the TBLRDL instruction. Note that the data will always be '0' when the upper 'Phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in **Section 4.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Page register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

FIGURE 3-6: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS



3.4.3 READING DATA FROM PROGRAM MEMORY USING PROGRAM SPACE VISIBILITY

The upper 32 Kbytes of data space may optionally be mapped into any 16K word page of the program space. This option provides transparent access to the stored constant data from the data space without the need to use special instructions (such as TBLRDL/H).

Program space access through the data space occurs if the Most Significant bit of the data space EA is '1' and program space visibility is enabled by setting the PSV bit in the Core Control register (CORCON<2>). The location of the program memory space to be mapped into the data space is determined by the Program Space Visibility Page register (PSVPAG). This 8-bit register defines any one of 256 possible pages of 16K words in program space. In effect, PSVPAG functions as the upper 8 bits of the program memory address, with the 15 bits of the EA functioning as the lower bits. By incrementing the PC by 2 for each program memory word, the lower 15 bits of data space addresses directly map to the lower 15 bits in the corresponding program space addresses.

Data reads to this area add a cycle to the instruction being executed, since two program memory fetches are required.

Although each data space address 8000h and higher maps directly into a corresponding program memory address (see Figure 3-7), only the lower 16 bits of the

24-bit program word are used to contain the data. The upper 8 bits of any program space location used as data should be programmed with '1111 1111' or '0000 0000' to force a NOP. This prevents possible issues should the area of code ever be accidentally executed.

Note: PSV access is temporarily disabled during table reads/writes.

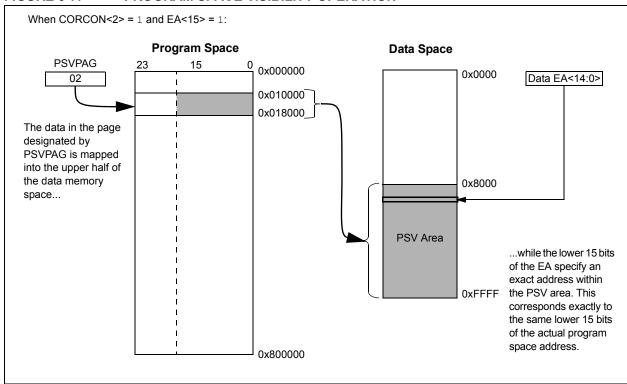
For operations that use PSV and are executed outside a REPEAT loop, the ${\tt MOV}$ and ${\tt MOV.D}$ instructions require one instruction cycle in addition to the specified execution time. All other instructions require two instruction cycles in addition to the specified execution time.

For operations that use PSV, and are executed inside a REPEAT loop, these instances require two instruction cycles in addition to the specified execution time of the instruction:

- · Execution in the first iteration
- · Execution in the last iteration
- Execution prior to exiting the loop due to an interrupt
- Execution upon re-entering the loop after an interrupt is serviced

Any other iteration of the REPEAT loop will allow the instruction using PSV to access data to execute in a single cycle.





PIC24HJ3	PIC24HJ32GP2U2I2U4 and PIC24HJ16GP3U4				
NOTES:					

4.0 FLASH PROGRAM MEMORY

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 4. Program Memory" (DS70228), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices contain internal Flash program memory to store and execute application code. The memory is readable, writable and erasable during normal operation over the entire VDD range.

Flash memory can be programmed in two ways:

- In-Circuit Serial Programming™ (ICSP™) programming capability
- Run-Time Self-Programming (RTSP)

ICSP allows a PIC24HJ32GP202/204 and PIC24HJ16GP304 device to be serially programmed while in the end application circuit. This is done with two lines for programming clock and programming data (one of the alternate programming pin pairs: PGC1/PGD1, PGC2/PGD2 or PGC3/PGD3), and three other lines for power (VDD), ground (VSS) and Master Clear (MCLR). This allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. This also allows the most recent firmware or a custom firmware to be programmed.

RTSP is accomplished using TBLRD (table read) and TBLWT (table write) instructions. With RTSP, the user application can write program memory data either in 'blocks' or 'rows' of 64 instructions (192 bytes) at a time or a single program memory word, and erase program memory in blocks or 'pages' of 512 instructions (1536 bytes) at a time.

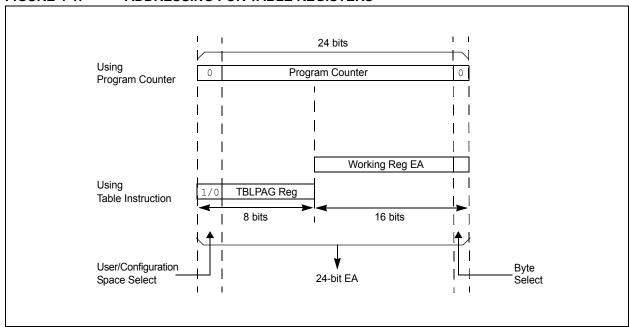
4.1 Table Instructions and Flash Programming

Regardless of the method used, all programming of Flash memory is done with the table read and table write instructions. These allow direct read and write access to the program memory space from the data memory while the device is in normal operating mode. The 24-bit target address in the program memory is formed using bits <7:0> of the TBLPAG register and the Effective Address (EA) from a W register specified in the table instruction, as shown in Figure 4-1.

The TBLRDL and the TBLWTL instructions are used to read or write to the bits<15:0> of program memory. TBLRDL and TBLWTL can access program memory in both Word and Byte modes.

The TBLRDH and TBLWTH instructions are used to read or write to bits<23:16> of program memory. TBLRDH and TBLWTH can also access program memory in Word or Byte mode.

FIGURE 4-1: ADDRESSING FOR TABLE REGISTERS



4.2 RTSP Operation

The PIC24HJ32GP202/204 and PIC24HJ16GP304 Flash program memory array is organized into rows of 64 instructions or 192 bytes. RTSP allows the user application to erase a page of memory, which consists of eight rows (512 instructions) at a time, and to program one row or one word at a time. The 8-row erase pages and single row write rows are edge-aligned from the beginning of program memory, on boundaries of 1536 bytes and 192 bytes, respectively.

The program memory implements holding buffers that can contain 64 instructions of programming data. Prior to the actual programming operation, the write data must be loaded into the buffers sequentially. The instruction words loaded must always be from a group of 64 boundary.

The basic sequence for RTSP programming is to set up a Table Pointer, then do a series of ${\tt TBLWT}$ instructions to load the buffers. Programming is performed by setting the control bits in the NVMCON register. A total of 64 ${\tt TBLWTL}$ and ${\tt TBLWTH}$ instructions are required to load the instructions.

All table write operations are single-word writes (two instruction cycles) because only the buffers are written. A programming cycle is required for programming each row.

4.3 Programming Operations

A complete programming sequence is necessary for programming or erasing the internal Flash in RTSP mode. The processor stalls (waits) until the programming operation is finished.

The programming time depends on the FRC accuracy (see Table 21-18, **AC Characteristics: Internal RC Accuracy**) and the value of the FRC Oscillator Tuning register (see Register 7-4). Use the following formula to calculate the minimum and maximum values for the Row Write Time, Page Erase Time, and Word Write Cycle Time parameters (see Table 21-12, **DC Charateristics: Program Memory**).

EQUATION 4-1: PROGRAMMING TIME

$$\frac{T}{7.37~MHz \times (FRC~Accuracy)\% \times (FRC~Tuning)\%}$$

For example, if the device is operating at $\pm 125^{\circ}$ C, the FRC accuracy will be $\pm 5\%$. If the TUN<5:0> bits (see Register 7-4) are set to 'b111111, the Minimum Row Write Time is:

$$T_{RW} = \frac{11064 \text{ Cycles}}{7.37 \text{ MHz} \times (1 + 0.05) \times (1 - 0.00375)} = 1.435 \text{ms}$$

and, the Maximum Row Write Time is:

$$T_{RW} = \frac{11064 \; Cycles}{7.37 \; MHz \times (1 - 0.05) \times (1 - 0.00375)} = 1.586 ms$$

Setting the WR bit (NVMCON<15>) starts the operation, and the WR bit is automatically cleared when the operation is finished.

4.4 Control Registers

Two SFRs are used to read and write the program Flash memory:

- · NVMCON: Flash Memory Control Register
- NVMKEY: Nonvolatile Memory Key Register

The NVMCON register (Register 4-1) controls which blocks need to be erased, which memory type is to be programmed and the start of the programming cycle.

NVMKEY (Register 4-2) is a write-only register that is used for write protection. To start a programming or erase sequence, the user application must consecutively write 55h and AAh to the NVMKEY register. Refer to **Section 4.3 "Programming Operations"** for further details.

REGISTER 4-1: NVMCON: FLASH MEMORY CONTROL REGISTER

R/SO-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	U-0	U-0	U-0	U-0	U-0
WR	WREN	WRERR	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0 ⁽¹⁾	U-0	U-0	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾	R/W-0 ⁽¹⁾
_	ERASE	_	_		NVMOP	<3:0> ⁽²⁾	
bit 7	•	•		•			bit 0

Legend:SO = Settable Only bitR = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 15 WR: Write Control bit

- 1 = Initiates a Flash memory program or erase operation. The operation is self-timed and the bit is cleared by hardware once operation is complete
- 0 = Program or erase operation is complete and inactive
- bit 14 WREN: Write Enable bit
 - 1 = Enable Flash program/erase operations
 - 0 = Inhibit Flash program/erase operations
- bit 13 WRERR: Write Sequence Error Flag bit
 - 1 = An improper program or erase sequence attempt or termination has occurred (bit is set automatically on any set attempt of the WR bit)
 - 0 = The program or erase operation completed normally
- bit 12-7 Unimplemented: Read as '0'
- bit 6 **ERASE**: Erase/Program Enable bit
 - 1 = Perform the erase operation specified by NVMOP<3:0> on the next WR command
 - 0 = Perform the program operation specified by NVMOP<3:0> on the next WR command
- bit 5-4 **Unimplemented:** Read as '0'
- bit 3-0 NVMOP<3:0>: NVM Operation Select bits⁽²⁾

If ERASE = 1

- 1111 = Memory bulk erase operation
- 1101 = Erase General Segment
- 1100 = Erase Secure Segment
- 0011 = No operation
- 0010 = Memory page erase operation
- 0001 = No operation
- 0000 = Erase a single Configuration register byte

If ERASE = 0:

- 1111 = No operation
- 1101 = No operation
- 1100 = No operation
- 0011 = Memory word program operation
- 0010 = No operation
- 0001 = Memory row program operation
- 0000 = Program a single Configuration register byte
- Note 1: These bits can only be reset on POR.
 - 2: All other combinations of NVMOP<3:0> are unimplemented.

REGISTER 4-2: NVMKEY: NONVOLATILE MEMORY KEY REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0
			NVMKE	EY<7:0>			
bit 7 bit							

Legend: SO = Settable Only bit

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 **NVMKEY<7:0>:** Key Register (write-only) bits

4.4.1 PROGRAMMING ALGORITHM FOR FLASH PROGRAM MEMORY

Programmers can program one row of program Flash memory at a time. To do this, it is necessary to erase the 8-row erase page that contains the desired row. The general process is:

- Read eight rows of program memory (512 instructions) and store in data RAM.
- Update the program data in RAM with the desired new data.
- 3. Erase the block (see Example 4-1):
 - a) Set the NVMOP bits (NVMCON<3:0>) to '0010' to configure for block erase. Set ERASE (NVMCON<6>) and WREN (NVM-CON<14>) bits.
 - b) Write the starting address of the page to be erased into the TBLPAG and W registers.
 - c) Write 0x55 to NVMKEY.
 - d) Write 0xAA to NVMKEY.
 - e) Set the WR bit (NVMCON<15>). The erase cycle begins and the CPU stalls for the duration of the erase cycle. When the erase is done, the WR bit is cleared automatically.

- 4. Write the first 64 instructions from data RAM into the program memory buffers (see Example 4-2).
- 5. Write the program block to Flash memory:
 - a) Set the NVMOP bits to '0001' to configure for row programming. Clear the ERASE bit and set the WREN bit.
 - b) Write 0x55 to NVMKEY.
 - c) Write 0xAA to NVMKEY.
 - d) Set the WR bit. The programming cycle begins and the CPU stalls for the duration of the write cycle. When the write to Flash memory is done, the WR bit is cleared automatically.
- Repeat steps 4 and 5, using the next available 64 instructions from the block in data RAM by incrementing the value in TBLPAG, until all 512 instructions are written back to Flash memory.

To protect against accidental operations, the write initiate sequence for NVMKEY must be used to allow any erase or program operation to proceed. After the programming command has been executed, the user application must wait for the programming time until programming is complete. The two instructions following the start of the programming sequence should be NOPS, as shown in Example 4-3.

EXAMPLE 4-1: ERASING A PROGRAM MEMORY PAGE

```
; Set up NVMCON for block erase operation
             #0x4042, W0
       MOV
       MOV
              WO, NVMCON
                                             ; Initialize NVMCON
; Init pointer to row to be ERASED
       MOV
              #tblpage(PROG ADDR), W0
                                             ; Initialize PM Page Boundary SFR
              WO, TBLPAG
       VOM
             #tbloffset(PROG ADDR), W0
                                            ; Initialize in-page EA[15:0] pointer
       TBLWTL WO, [WO]
                                             ; Set base address of erase block
       DISI
              #5
                                             ; Block all interrupts with priority <7
                                             ; for next 5 instructions
       VOM
              #0x55, W0
              WO, NVMKEY
                                             ; Write the 55 key
       MOV
       MOV
              #0xAA, W1
              W1, NVMKEY
                                             ; Write the AA key
       MOV
       BSET
              NVMCON, #WR
                                             ; Start the erase sequence
                                             ; Insert two NOPs after the erase
       NOP
       NOP
                                             ; command is asserted
```

EXAMPLE 4-2: LOADING THE WRITE BUFFERS

```
; Set up NVMCON for row programming operations
              #0x4001, W0
                                          ; Initialize NVMCON
       MOV
               W0, NVMCON
; Set up a pointer to the first program memory location to be written
; program memory selected, and writes enabled
             #0x0000, W0
            W0, TBLPAG ; Initialize PM Page Boundary SFR #0x6000, W0 ; An example program memory address
       MOV
       MOV
; Perform the TBLWT instructions to write the latches
; 0th program word
            #LOW_WORD_0, W2
       MOV
              #HIGH BYTE 0, W3
       TBLWTL W2, [W0]
                                         ; Write PM low word into program latch
       TBLWTH W3, [W0++]
                                         ; Write PM high byte into program latch
; 1st_program_word
            #LOW WORD 1, W2
      MOV
            #HIGH_BYTE_1, W3
       MOV
       TBLWTL W2, [W0]
                                     ; Write PM low word into program latch
       TBLWTH W3, [W0++]
                                        ; Write PM high byte into program latch
; 2nd program word
       MOV #LOW_WORD_2, W2
MOV #HIGH_BYTE_2, W3
                                    ;
; Write PM low word into program latch
; Write PM high byte into program latch
       TBLWTL W2, [W0]
       TBLWTL W2, [W0]
TBLWTH W3, [W0++]
; 63rd program word
       MOV #LOW_WORD_31, W2
       MOV
              #HIGH BYTE 31, W3
       TBLWTL W2, [W0]
                                         ; Write PM low word into program latch
       TBLWTH W3, [W0++]
                                         ; Write PM high byte into program latch
```

EXAMPLE 4-3: INITIATING A PROGRAMMING SEQUENCE

```
; Block all interrupts with priority <7
DIST
                                ; for next 5 instructions
MOV
       #0x55, W0
MOV
       WO, NVMKEY
                               ; Write the 55 key
       #0xAA, W1
MOV
       W1, NVMKEY
                               ; Write the AA key
MOV
                                ; Start the erase sequence
BSET
       NVMCON, #WR
NOP
                                ; Insert two NOPs after the
NOP
                                 ; erase command is asserted
```

5.0 RESETS

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 8. Reset" (DS70229), which is available from the Microchip website (www.microchip.com).

The Reset module combines all reset <u>sources</u> and controls the device Master Reset Signal, <u>SYSRST</u>. The following is a list of device Reset sources:

POR: Power-on Reset

· BOR: Brown-out Reset

· MCLR: Master Clear Pin Reset

• SWR: RESET Instruction

WDTO: Watchdog Timer Reset

· CM: Configuration Mismatch Reset

· TRAPR: Trap Conflict Reset

· IOPUWR: Illegal Condition Device Reset

- Illegal Opcode Reset

- Uninitialized W Register Reset

- Security Reset

A simplified block diagram of the Reset module is shown in Figure 5-1.

Any active source of reset will make the SYSRST signal active. On system Reset, some of the registers associated with the CPU and peripherals are forced to a known Reset state and some are unaffected.

Note: Refer to the specific peripheral section or Section 2.0 "CPU" of this manual for register Reset states.

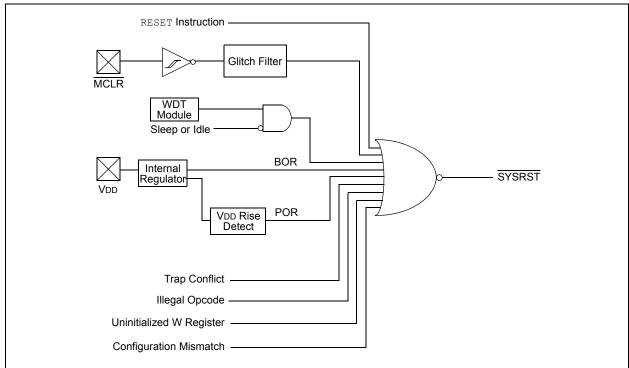
All types of device Reset sets a corresponding status bit in the RCON register to indicate the type of Reset (see Register 5-1).

A POR clears all the bits, except for the POR bit (RCON<0>), that are set. The user application can set or clear any bit at any time during code execution. The RCON bits only serve as status bits. Setting a particular Reset status bit in software does not cause a device Reset to occur.

The RCON register also has other bits associated with the Watchdog Timer and device power-saving states. The function of these bits is discussed in other sections of this manual.

Note: The status bits in the RCON register should be cleared after they are read so that the next RCON register value after a device Reset is meaningful.

FIGURE 5-1: RESET SYSTEM BLOCK DIAGRAM



REGISTER 5-1: RCON: RESET CONTROL REGISTER(1)

R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
TRAPR	IOPUWR	_	_	_	_	CM	VREGS
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1	R/W-1
EXTR	SWR	SWDTEN ⁽²⁾	WDTO	SLEEP	IDLE	BOR	POR
bit 7							bit 0

Legend:

bit 5

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 TRAPR: Trap Reset Flag bit

1 = A Trap Conflict Reset has occurred0 = A Trap Conflict Reset has not occurred

bit 14 IOPUWR: Illegal Opcode or Uninitialized W Access Reset Flag bit

 ${\tt 1}$ = An illegal opcode detection, an illegal address mode or uninitialized W register used as an

Address Pointer caused a Reset

0 = An illegal opcode or uninitialized W Reset has not occurred

bit 13-10 **Unimplemented:** Read as '0'

bit 9 CM: Configuration Mismatch Flag bit

1 = A configuration mismatch Reset has occurred0 = A configuration mismatch Reset has NOT occurred

bit 8 **VREGS:** Voltage Regulator Standby During Sleep bit

1 = Voltage regulator is active during Sleep

0 = Voltage regulator goes into Standby mode during Sleep

bit 7 **EXTR:** External Reset (MCLR) Pin bit

1 = A Master Clear (pin) Reset has occurred 0 = A Master Clear (pin) Reset has not occurred

bit 6 **SWR:** Software Reset (Instruction) Flag bit

1 = A RESET instruction has been executed 0 = A RESET instruction has not been executed

SWDTEN: Software Enable/Disable of WDT bit⁽²⁾

1 = WDT is enabled 0 = WDT is disabled

bit 4 WDTO: Watchdog Timer Time-out Flag bit

1 = WDT time-out has occurred0 = WDT time-out has not occurred

bit 3 SLEEP: Wake-up from Sleep Flag bit

1 = Device has been in Sleep mode

0 = Device has not been in Sleep mode

bit 2 IDLE: Wake-up from Idle Flag bit

1 = Device was in Idle mode

0 = Device was not in Idle mode

Note 1: All of the Reset status bits can be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.

REGISTER 5-1: RCON: RESET CONTROL REGISTER⁽¹⁾ (CONTINUED)

bit 1 BOR: Brown-out Reset Flag bit

1 = A Brown-out Reset has occurred 0 = A Brown-out Reset has not occurred

bit 0 **POR:** Power-on Reset Flag bit

1 = A Power-up Reset has occurred 0 = A Power-up Reset has not occurred

Note 1: All of the Reset status bits can be set or cleared in software. Setting one of these bits in software does not cause a device Reset.

2: If the FWDTEN Configuration bit is '1' (unprogrammed), the WDT is always enabled, regardless of the SWDTEN bit setting.

5.1 System Reset

The PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices have two types of Reset:

- · Cold Reset
- · Warm Reset

A cold Reset is the result of a Power-on Reset (POR) or a Brown-out Reset (BOR). On a cold Reset, the FNOSC configuration bits in the FOSC device configuration register selects the device clock source.

A warm Reset is the result of all other reset sources, including the RESET instruction. On warm Reset, the device will continue to operate from the current clock source as indicated by the Current Oscillator Selection (COSC<2:0>) bits in the Oscillator Control (OSCCON<14:12>) register.

The device is kept in a Reset state until the system power supplies have stabilized at appropriate levels and the oscillator clock is ready. The sequence in which this occurs is detailed below and is shown in Figure 5-2.

 POR Reset: A POR circuit holds the device in Reset when the power supply is turned on. The POR circuit is active until VDD crosses the VPOR threshold and the delay TPOR has elapsed.

- BOR Reset: The on-chip voltage regulator has a BOR circuit that keeps the device in Reset until VDD crosses the VBOR threshold and the delay TBOR has elapsed. The delay TBOR ensures that the voltage regulator output becomes stable.
- 3. **PWRT Timer:** The programmable power-up timer continues to hold the processor in Reset for a specific period of time (TPWRT) after a BOR. The delay TPWRT ensures that the system power supplies have stabilized at the appropriate level for full-speed operation. After the delay TPWRT has elapsed, the SYSRST becomes inactive, which in turn enables the selected oscillator to start generating clock cycles.
- Oscillator Delay: The total delay for the clock to be ready for various clock source selections is given in Table 5-1. Refer to Section 7.0 "Oscillator Configuration" for more information.
- When the oscillator clock is ready, the processor begins execution from location 0x000000. The user application programs a GOTO instruction at the reset address, which redirects program execution to the appropriate start-up routine.
- The Fail-Safe Clock Monitor (FSCM), if enabled, begins to monitor the system clock when the system clock is ready and the delay TFSCM elapsed.

TABLE 5-1: OSCILLATOR DELAY

Oscillator Mode	Oscillator Start-up Delay	Oscillator Start-up Timer	PLL Lock Time	Total Delay
FRC, FRCDIV16, FRCDIVN	Toscd	_	_	Tosco
FRCPLL	Tosco	_	TLOCK	Toscd + Tlock
XT	Tosco	Tost	_	Toscd + Tost
HS	Tosco	Tost	_	Toscd + Tost
EC	_	_	_	_
XTPLL	Tosco	Tost	TLOCK	Toscd + Tost + Tlock
HSPLL	Tosco	Tost	TLOCK	Toscd + Tost + Tlock
ECPLL	_	_	TLOCK	TLOCK
SOSC	Tosco	Tost	_	Toscd + Tost
LPRC	Toscd	_	_	Toscd

- Note 1: Toscp = Oscillator Start-up Delay (1.1 μ s max for FRC, 70 μ s max for LPRC). Crystal Oscillator start-up times vary with crystal characteristics, load capacitance, etc.
 - 2: Tost = Oscillator Start-up Timer Delay (1024 oscillator clock period). For example, Tost = 102.4 μ s for a 10 MHz crystal and Tost = 32 ms for a 32 kHz crystal.
 - 3: TLOCK = PLL lock time (1.5 ms nominal), if PLL is enabled.

POR Reset

BOR Reset

SYSRST

Oscillator Clock

FSCM

Device Status

Reset

Run

Time

FIGURE 5-2: SYSTEM RESET TIMING

- Note 1: POR Reset: A POR circuit holds the device in Reset when the power supply is turned on. The POR circuit is active until VDD crosses the VPOR threshold and the delay TPOR has elapsed.
 - 2: BOR Reset: The on-chip voltage regulator has a BOR circuit that keeps the device in Reset until VDD crosses the VBOR threshold and the delay TBOR has elapsed. The delay TBOR ensures the voltage regulator output becomes stable.
 - 3: **PWRT Timer:** The programmable power-up timer continues to hold the processor in Reset for a specific period of time (TPWRT) after a BOR. The delay TPWRT ensures that the system power supplies have stabilized at the appropriate level for full-speed operation. After the delay TPWRT has elapsed, the SYSRST becomes inactive, which in turn enables the selected oscillator to start generating clock cycles.
 - **4: Oscillator Delay:** The total delay for the clock to be ready for various clock source selections are given in Table 5-1. Refer to **Section 7.0 "Oscillator Configuration"** for more information.
 - 5: When the oscillator clock is ready, the processor begins execution from location 0x000000. The user application programs a GOTO instruction at the reset address, which redirects program execution to the appropriate start-up routine.
 - **6:** The Fail-Safe Clock Monitor (FSCM), if enabled, begins to monitor the system clock when the system clock is ready and the delay TFSCM elapsed.

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TABLE 5-2: OSCILLATOR DELAY

Symbol	Parameter	Value
VPOR	POR threshold	1.8V nominal
Tpor	POR extension time	30 μs maximum
VBOR	BOR threshold	2.5V nominal
TBOR	BOR extension time	100 μs maximum
TPWRT	Programmable power-up time delay	0-128 ms nominal
TFSCM	Fail-Safe Clock Monitor Delay	900 μs maximum

When the device exits the Reset condition (begins normal operation), the device operating parameters (voltage, frequency, temperature, etc.) must be within their operating ranges, otherwise the device may not function correctly. The user application must ensure that the delay between the time POWERST becomes inactive, is long enough to get all operating parameters within specification.

5.2 Power-on Reset (POR)

A Power-on Reset (POR) circuit ensures the device is reset from power-on. The POR circuit is active until VDD crosses the VPOR threshold and the delay TPOR has elapsed. The delay TPOR ensures the internal device bias circuits become stable.

The device supply voltage characteristics must meet the specified starting voltage and rise rate requirements to generate the POR. Refer to **Section 21.0 "Electrical Characteristics"** for details.

The POR status (POR) bit in the Reset Control (RCON<0>) register is set to indicate the Power-on Reset.

5.2.1 Brown-out Reset (BOR) and Power-up timer (PWRT)

The on-chip regulator has a Brown-out Reset (BOR) circuit that resets the device when the VDD is too low (VDD < VBOR) for proper device operation. The BOR circuit keeps the device in Reset until VDD crosses VBOR threshold and the delay TBOR has elapsed. The delay TBOR ensures the voltage regulator output becomes stable.

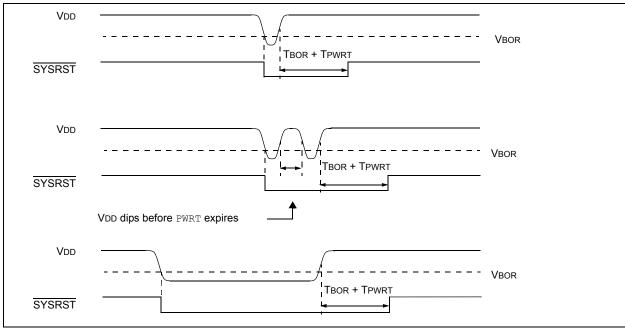
The BOR status (BOR) bit in the Reset Control (RCON<1>) register is set to indicate the Brown-out Reset.

The device will not run at full speed after a BOR as the VDD should rise to acceptable levels for full-speed operation. The PWRT provides power-up time delay (TPWRT) to ensure that the system power supplies have stabilized at the appropriate levels for full-speed operation before the SYSRST is released.

The power-up timer delay (TPWRT) is programmed by the Power-on Reset Timer Value Select (FPWRT<2:0>) bits in the POR Configuration (FPOR<2:0>) register, which provides eight settings (from 0 ms to 128 ms). Refer to **Section 18.0 "Special Features"** for further details.

Figure 5-3 shows the typical brown-out scenarios. The reset delay (TBOR + TPWRT) is initiated each time VDD rises above the VBOR trip point





5.3 External Reset (EXTR)

The external Reset is generated by driving the MCLR pin low. The MCLR pin is a Schmitt trigger input with an additional glitch filter. Reset pulses that are longer than the minimum pulse-width will generate a Reset. Refer to Section 21.0 "Electrical Characteristics" for minimum pulse-width specifications. The External Reset (MCLR) Pin (EXTR) bit in the Reset Control (RCON) register is set to indicate the MCLR Reset.

5.3.1 EXTERNAL SUPERVISORY CIRCUIT

Many systems have external supervisory circuits that generate reset signals to Reset multiple devices in the system. This external Reset signal can be directly connected to the MCLR pin to Reset the device when the rest of system is Reset.

5.3.2 INTERNAL SUPERVISORY CIRCUIT

When using the internal power supervisory circuit to Reset the device, the external reset pin (MCLR) should be tied directly or resistively to VDD. In this case, the MCLR pin will not be used to generate a Reset. The external reset pin (MCLR) does not have an internal pull-up and must not be left unconnected.

5.4 Software RESET Instruction (SWR)

Whenever the RESET instruction is executed, the device will assert \overline{SYSRST} , placing the device in a special Reset state. This Reset state will not re-initialize the clock. The clock source in effect prior to the RESET instruction will remain. \overline{SYSRST} is released at the next instruction cycle, and the reset vector fetch will commence.

The Software Reset (Instruction) Flag (SWR) bit in the Reset Control (RCON<6>) register is set to indicate the software Reset.

5.5 Watchdog Time-out Reset (WDTO)

Whenever a Watchdog time-out occurs, the device will asynchronously assert SYSRST. The clock source will remain unchanged. A WDT time-out during Sleep or Idle mode will wake-up the processor, but will not reset the processor.

The Watchdog Timer Time-out Flag (WDTO) bit in the Reset Control (RCON<4>) register is set to indicate the Watchdog Reset. Refer to **Section 18.4 "Watchdog Timer (WDT)"** for more information on Watchdog Reset.

5.6 Trap Conflict Reset

If a lower-priority hard trap occurs while a higher-priority trap is being processed, a hard trap conflict Reset occurs. The hard traps include exceptions of priority level 13 through level 15, inclusive. The address error (level 13) and oscillator error (level 14) traps fall into this category.

The Trap Reset Flag (TRAPR) bit in the Reset Control (RCON<15>) register is set to indicate the Trap Conflict Reset. Refer to **Section 6.0 "Interrupt Controller"** for more information on trap conflict Resets.

5.7 Configuration Mismatch Reset

To maintain the integrity of the peripheral pin select control registers, they are constantly monitored with shadow registers in hardware. If an unexpected change in any of the registers occur (such as cell disturbances caused by ESD or other external events), a configuration mismatch Reset occurs.

The Configuration Mismatch Flag (CM) bit in the Reset Control (RCON<9>) register is set to indicate the configuration mismatch Reset. Refer to **Section 9.0 "I/O Ports"** for more information on the configuration mismatch Reset.

Note: The configuration mismatch feature and associated reset flag is not available on all devices.

5.8 Illegal Condition Device Reset

An illegal condition device Reset occurs due to the following sources:

- · Illegal Opcode Reset
- · Uninitialized W Register Reset
- · Security Reset

The Illegal Opcode or Uninitialized W Access Reset Flag (IOPUWR) bit in the Reset Control (RCON<14>) register is set to indicate the illegal condition device Reset.

5.8.1 ILLEGAL OPCODE RESET

A device Reset is generated if the device attempts to execute an illegal opcode value that is fetched from program memory.

The illegal opcode Reset function can prevent the device from executing program memory sections that are used to store constant data. To take advantage of the illegal opcode Reset, use only the lower 16 bits of

each program memory section to store the data values. The upper 8 bits should be programmed with 3Fh, which is an illegal opcode value.

5.8.2 UNINITIALIZED W REGISTER RESET

Any attempts to use the uninitialized W register as an address pointer will Reset the device. The W register array (with the exception of W15) is cleared during all resets and is considered uninitialized until written to.

5.8.3 SECURITY RESET

If a Program Flow Change (PFC) or Vector Flow Change (VFC) targets a restricted location in a protected segment (Boot and Secure Segment), that operation will cause a security Reset.

The PFC occurs when the Program Counter is reloaded as a result of a Call, Jump, Computed Jump, Return, Return from Subroutine, or other form of branch instruction.

The VFC occurs when the Program Counter is reloaded with an Interrupt or Trap vector.

Refer to Section 18.6 "Code Protection and CodeGuard™ Security" for more information on Security Reset.

5.9 Using the RCON Status Bits

The user application can read the Reset Control (RCON) register after any device Reset to determine the cause of the reset.

Note:	The status bits in the RCON register									
	should be cleared after they are read so									
	that the next RCON register value after a									
	device Reset will be meaningful.									

Table 5-3 provides a summary of the reset flag bit operation.

TABLE 5-3: RESET FLAG BIT OPERATION

Flag Bit	Set by:	Cleared by:
TRAPR (RCON<15>)	Trap conflict event	POR,BOR
IOPWR (RCON<14>)	Illegal opcode or uninitialized W register access or Security Reset	POR,BOR
CM (RCON<9>)	Configuration Mismatch	POR,BOR
EXTR (RCON<7>)	MCLR Reset	POR
SWR (RCON<6>)	RESET instruction	POR,BOR
WDTO (RCON<4>)	WDT time-out	PWRSAV instruction, CLRWDT instruction, POR,BOR
SLEEP (RCON<3>)	PWRSAV #SLEEP instruction	POR,BOR
IDLE (RCON<2>)	PWRSAV #IDLE instruction	POR,BOR
BOR (RCON<1>)	POR, BOR	_
POR (RCON<0>)	POR	_

Note: All Reset flag bits can be set or cleared by user software.

6.0 INTERRUPT CONTROLLER

Note:

This data sheet summarizes the features PIC24HJ32GP202/204 PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section Interrupts" (DS70224), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 interrupt controllers reduce the numerous peripheral interrupt request signals to a single interrupt request signal to the PIC24HJ32GP202/204 and PIC24HJ16GP304 CPU.

It has the following features:

- · Up to eight processor exceptions and software traps
- · Seven user-selectable priority levels
- Interrupt Vector Table (IVT) with up to 118 vectors
- A unique vector for each interrupt or exception source
- · Fixed priority within a specified user priority level
- Alternate Interrupt Vector Table (AIVT) for debug support
- · Fixed interrupt entry and return latencies

6.1 Interrupt Vector Table

Figure 6-1 shows the Interrupt Vector Table. The IVT resides in program memory, starting at location 000004h. The IVT contains 126 vectors consisting of eight nonmaskable trap vectors and up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority; this priority is linked to their position in the vector table. Lower addresses generally have a higher natural priority. For example, the interrupt associated with vector 0 will take priority over interrupts at any other vector address.

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices implement up to 21 unique interrupts and 4 nonmaskable traps. These are summarized in Table 6-1 and Table 6-2.

6.1.1 ALTERNATE INTERRUPT VECTOR TABLE

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 6-1. Access to the AIVT is provided by the ALTIVT control bit (INTCON2<15>). If the ALTIVT bit is set, all interrupt and exception processes use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

The AIVT supports debugging by providing a means to switch between an application and a support environment without requiring the interrupt vectors to be reprogrammed. This feature also enables switching between applications for evaluation of different software algorithms at run time. If the AIVT is not needed, the AIVT should be programmed with the same addresses used in the IVT.

6.2 Reset Sequence

A device Reset is not a true exception because the interrupt controller is not involved in the Reset process. The PIC24HJ32GP202/204 and PIC24HJ16GP304 device clear its registers in response to a Reset, which forces the PC to zero. The microcontroller then begins the program execution at location 0x000000. The user application can use a GOTO instruction at the Reset address which redirects program execution to the appropriate start-up routine.

Note: Any unimplemented or unused vector locations in the IVT and AIVT should be programmed with the address of a default interrupt handler routine that contains a RESET instruction.

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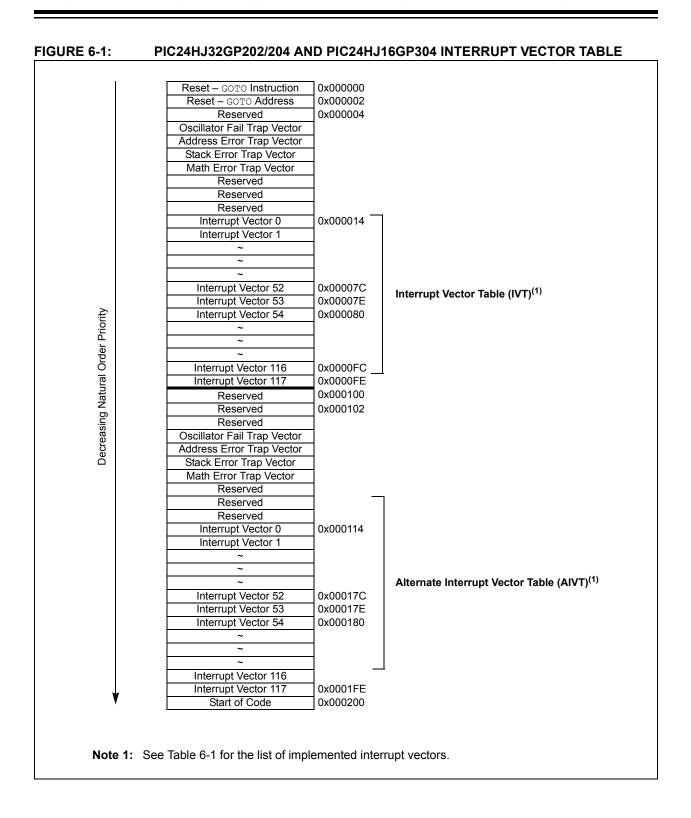


TABLE 6-1: INTERRUPT VECTORS

ΓABLE 6-1 :	E 6-1: INTERRUPT VECTORS					
Vector Number	Interrupt Request (IRQ) Number	IVT Address	AIVT Address	Interrupt Source		
8	0	0x000014	0x000114	INT0 – External Interrupt 0		
9	1	0x000016	0x000116	IC1 – Input Compare 1		
10	2	0x000018	0x000118	OC1 – Output Compare 1		
11	3	0x00001A	0x00011A	T1 – Timer1		
12	4	0x00001C	0x00011C	Reserved		
13	5	0x00001E	0x00011E	IC2 – Input Capture 2		
14	6	0x000020	0x000120	OC2 – Output Compare 2		
15	7	0x000022	0x000122	T2 – Timer2		
16	8	0x000024	0x000124	T3 – Timer3		
17	9	0x000026	0x000126	SPI1E – SPI1 Error		
18	10	0x000028	0x000128	SPI1 – SPI1 Transfer Done		
19	11	0x00002A	0x00012A	U1RX – UART1 Receiver		
20	12	0x00002C	0x00012C	U1TX – UART1 Transmitter		
21	13	0x00002E	0x00012E	ADC1 – ADC1		
22	14	0x000030	0x000130	Reserved		
23	15	0x000032	0x000132	Reserved		
24	16	0x000034	0x000134	SI2C1 – I2C1 Slave Events		
25	17	0x000036	0x000136	MI2C1 – I2C1 Master Events		
26	18	0x000038	0x000138	Reserved		
27	19	0x00003A	0x00013A	Change Notification Interrupt		
28	20	0x00003C	0x00013C	INT1 – External Interrupt 1		
29	21	0x00003E	0x00013E	Reserved		
30	22	0x000040	0x000140	IC7 – Input Capture 7		
31	23	0x000042	0x000142	IC8 – Input Capture 8		
32	24	0x000044	0x000144	Reserved		
33	25	0x000046	0x000146	Reserved		
34	26	0x000048	0x000148	Reserved		
35	27	0x00004A	0x00014A	Reserved		
36	28	0x00004C	0x00014C	Reserved		
37	29	0x00004E	0x00014E	INT2 – External Interrupt 2		
38	30	0x000050	0x000150	Reserved		
39	31	0x000052	0x000152	Reserved		
40	32	0x000054	0x000154	Reserved		
41	33	0x000056	0x000156	Reserved		
42	34	0x000058	0x000158	Reserved		
43	35	0x00005A	0x00015A	Reserved		
44	36	0x00005C	0x00015C	Reserved		
45	37	0x00005E	0x00015E	Reserved		
46	38	0x000060	0x000160	Reserved		
47	39	0x000062	0x000162	Reserved		
48	40	0x000064	0x000164	Reserved		
49	41	0x000066	0x000166	Reserved		
50	42	0x000068	0x000168	Reserved		
51	43	0x00006A	0x00016A	Reserved		
52	44	0x00006C	0x00016C	Reserved		
53	45	0x00006E	0x00016E	Reserved		

TABLE 6-1: INTERRUPT VECTORS (CONTINUED)

Vector Number	Interrupt Request (IRQ) Number	IVT Address	AIVT Address	Interrupt Source
54	46	0x000070	0x000170	Reserved
55	47	0x000072	0x000172	Reserved
56	48	0x000074	0x000174	Reserved
57	49	0x000076	0x000176	Reserved
58	50	0x000078	0x000178	Reserved
59	51	0x00007A	0x00017A	Reserved
60	52	0x00007C	0x00017C	Reserved
61	53	0x00007E	0x00017E	Reserved
62	54	0x000080	0x000180	Reserved
63	55	0x000082	0x000182	Reserved
64	56	0x000084	0x000184	Reserved
65	57	0x000086	0x000186	Reserved
66	58	0x000088	0x000188	Reserved
67	59	0x00008A	0x00018A	Reserved
68	60	0x00008C	0x00018C	Reserved
69	61	0x00008E	0x00018E	Reserved
70	62	0x000090	0x000190	Reserved
71	63	0x000092	0x000192	Reserved
72	64	0x000094	0x000194	Reserved
73	65	0x000096	0x000196	U1E – UART1 Error
74	66	0x000098	0x000198	Reserved
75	67	0x00009A	0x00019A	Reserved
76	68	0x00009C	0x00019C	Reserved
77	69	0x00009E	0x00019E	Reserved
78	70	0x0000A0	0x0001A0	Reserved
79	71	0x0000A2	0x0001A2	Reserved
80-125	72-117	0x0000A4-0x0000 FE	0x0001A4-0x0001 FE	Reserved

TABLE 6-2: TRAP VECTORS

Vector Number	Vector Number IVT Address		Trap Source
0	0x000004	0x000104	Reserved
1	0x000006	0x000106	Oscillator Failure
2	2 0x000008		Address Error
3	0x00000A	0x00010A	Stack Error
4	0x00000C	0x00010C	Math Error
5	0x00000E	0x00010E	Reserved
6	6 0x000010		Reserved
7	0x000012	0x000112	Reserved

6.3 Interrupt Control and Status Registers

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices implement a total of 17 registers for the interrupt controller:

- Interrupt Control Register 1 (INTCON1)
- · Interrupt Control Register 2 (INTCON2)
- · Interrupt Flag Status Registers (IFSx)
- · Interrupt Enable Control Registers (IECx)
- Interrupt Priority Control Registers (IPCx)
- Interrupt Control and Status Register (INTTREG)

6.3.1 INTCON1 AND INTCON2

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit as well as the control and status flags for the processor trap sources. The INTCON2 register controls the external interrupt request signal behavior and the use of the Alternate Interrupt Vector Table.

6.3.2 IFSx

The IFS registers maintain all the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal and this is cleared via software.

6.3.3 IECx

The IEC registers maintain all the interrupt enable bits. These control bits are used individually to enable interrupts from the peripherals or external signals.

6.3.4 IPCx

The IPC registers are used to set the interrupt priority level for each source of interrupt. Each user interrupt source can be assigned to one of the eight priority levels

6.3.5 INTTREG

The INTTREG register contains the associated interrupt vector number and the new CPU interrupt priority level, which are latched into vector number (VECNUM<6:0>) and Interrupt level (ILR<3:0>) bit fields in the INTTREG register. The new interrupt priority level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence that they are listed in Table 6-1. For example, the INT0 (External Interrupt 0) is shown as having vector number 8 and a natural order priority of 0. Thus, the INT0IF bit is found in IFS0<0>, the INT0IE bit in IEC0<0>, and the INT0IP bits in the first position of IPC0 (IPC0<2:0>).

6.3.6 STATUS REGISTERS

Although these are not specifically part of the interrupt control hardware, two of the CPU Control registers contain bits that control interrupt functionality:

- The CPU STATUS register, SR, contains the IPL<2:0> bits (SR<7:5>). These bits indicate the current CPU interrupt priority level. The user can change the current CPU priority level by writing to the IPL bits.
- The CORCON register contains the IPL3 bit which, together with IPL<2:0>, also indicates the current CPU priority level. IPL3 is a read-only bit, so that trap events cannot be masked by the user software.

All Interrupt registers are described in Register 6-1 through Register 6-19 in the following pages.

REGISTER 6-1: SR: CPU STATUS REGISTER⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	DC
bit 15							bit 8

R/W-0 ⁽³⁾	R/W-0 ⁽³⁾	R/W-0 ⁽³⁾	R-0	R/W-0	R/W-0	R/W-0	R/W-0
IPL2 ⁽²⁾	IPL1 ⁽²⁾	IPL0 ⁽²⁾	RA	N	OV	Z	С
bit 7							bit 0

Legend:

C = Clear only bit R = Readable bit U = Unimplemented bit, read as '0'

S = Set only bit W = Writable bit -n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-5 IPL<2:0>: CPU Interrupt Priority Level Status bits⁽²⁾

111 = CPU Interrupt Priority Level is 7 (15), user interrupts disabled

110 = CPU Interrupt Priority Level is 6 (14)

101 = CPU Interrupt Priority Level is 5 (13)

100 = CPU Interrupt Priority Level is 4 (12)

011 = CPU Interrupt Priority Level is 3 (11)

010 = CPU Interrupt Priority Level is 2 (10)

001 = CPU Interrupt Priority Level is 1 (9)

000 = CPU Interrupt Priority Level is 0 (8)

over or o interrupt i field, Eaver to o (e)

Note 1: For complete register details, see Register 2-1: "SR: CPU STATUS Register".

- 2: The IPL<2:0> bits are concatenated with the IPL<3> bit (CORCON<3>) to form the CPU Interrupt Priority Level. The value in parentheses indicates the IPL if IPL<3> = 1. User interrupts are disabled when IPL<3> = 1.
- 3: The IPL<2:0> Status bits are read-only when NSTDIS (INTCON1<15>) = 1.

CORCON: CORE CONTROL REGISTER⁽¹⁾ **REGISTER 6-2:**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	R/C-0	R/W-0	U-0	U-0
_	_	_	_	IPL3 ⁽²⁾	PSV	_	_
bit 7							bit 0

Legend:	C = Clear only bit		
R = Readable bit	W = Writable bit	-n = Value at POR	'1' = Bit is set
0' = Bit is cleared	'x = Bit is unknown	U = Unimplemented bit, rea	ad as '0'

IPL3: CPU Interrupt Priority Level Status bit 3⁽²⁾ bit 3

1 = CPU interrupt priority level is greater than 7

0 = CPU interrupt priority level is 7 or less

Note 1: For complete register details, see Register 2-2: "CORCON: CORE Control Register".

2: The IPL3 bit is concatenated with the IPL<2:0> bits (SR<7:5>) to form the CPU Interrupt Priority Level.

REGISTER 6-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	U-0						
NSTDIS	_	_	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
_	DIV0ERR	_	MATHERR	ADDRERR	STKERR	OSCFAIL	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **NSTDIS:** Interrupt Nesting Disable bit

1 = Interrupt nesting is disabled

0 = Interrupt nesting is enabled

bit 14-7 **Unimplemented:** Read as '0'

bit 6 **DIV0ERR:** Arithmetic Error Status bit

1 = Math error trap was caused by a divide by zero

0 = Math error trap was not caused by a divide by zero

bit 5 **Unimplemented:** Read as '0'

bit 4 MATHERR: Arithmetic Error Status bit

1 = Math error trap has occurred0 = Math error trap has not occurred

bit 3 ADDRERR: Address Error Trap Status bit

1 = Address error trap has occurred0 = Address error trap has not occurred

bit 2 STKERR: Stack Error Trap Status bit

1 = Stack error trap has occurred

0 = Stack error trap has not occurred

bit 1 OSCFAIL: Oscillator Failure Trap Status bit

1 = Oscillator failure trap has occurred

 \circ = Oscillator failure trap has not occurred

bit 0 **Unimplemented:** Read as '0'

REGISTER 6-4: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	_	_	_	_	INT2EP	INT1EP	INT0EP
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 ALTIVT: Enable Alternate Interrupt Vector Table bit

1 = Use alternate vector table

0 = Use standard (default) vector table

bit 14 DISI: DISI Instruction Status bit

1 = DISI instruction is active
0 = DISI instruction is not active

bit 13-3 Unimplemented: Read as '0'

bit 2 INT2EP: External Interrupt 2 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

bit 1 INT1EP: External Interrupt 1 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

bit 0 INT0EP: External Interrupt 0 Edge Detect Polarity Select bit

1 = Interrupt on negative edge0 = Interrupt on positive edge

REGISTER 6-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	AD1IF	U1TXIF	U1RXIF	SPI1IF	SPI1EIF	T3IF
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
T2IF	OC2IF	IC2IF	_	T1IF	OC1IF	IC1IF	INT0IF
bit 7							bit 0

Legend:

bit 7

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 Unimplemented: Read as '0'

bit 13 AD1IF: ADC1 Conversion Complete Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 12 U1TXIF: UART1 Transmitter Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 11 **U1RXIF:** UART1 Receiver Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 10 SPI1IF: SPI1 Event Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 9 SPI1EIF: SPI1 Fault Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 8 T3IF: Timer3 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

T2IF: Timer2 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 6 OC2IF: Output Compare Channel 2 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 5 IC2IF: Input Capture Channel 2 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 4 Unimplemented: Read as '0'

bit 3 **T1IF:** Timer1 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 2 OC1IF: Output Compare Channel 1 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

REGISTER 6-5: IFS0: INTERRUPT FLAG STATUS REGISTER 0 (CONTINUED)

bit 1 IC1IF: Input Capture Channel 1 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 0 INT0IF: External Interrupt 0 Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

REGISTER 6-6: IFS1: INTERRUPT FLAG STATUS REGISTER 1

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	INT2IF	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
IC8IF	IC7IF	_	INT1IF	CNIF	_	MI2C1IF	SI2C1IF
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 **Unimplemented:** Read as '0'

bit 13 INT2IF: External Interrupt 2 Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 12-8 **Unimplemented:** Read as '0'

bit 7 IC8IF: Input Capture Channel 8 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 6 IC7IF: Input Capture Channel 7 Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 5 **Unimplemented:** Read as '0'

bit 4 INT1IF: External Interrupt 1 Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 3 CNIF: Input Change Notification Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 2 Unimplemented: Read as '0'

bit 1 MI2C1IF: I2C1 Master Events Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 0 SI2C1IF: I2C1 Slave Events Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

REGISTER 6-7: IFS4: INTERRUPT FLAG STATUS REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	U1EIF	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-2 Unimplemented: Read as '0'

bit 1 U1EIF: UART1 Error Interrupt Flag Status bit

1 = Interrupt request has occurred0 = Interrupt request has not occurred

bit 0 Unimplemented: Read as '0'

REGISTER 6-8: IEC0: INTERRUPT ENABLE CONTROL REGISTER 0

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	AD1IE	U1TXIE	U1RXIE	SPI1IE	SPI1EIE	T3IE
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
T2IE	OC2IE	IC2IE	_	T1IE	OC1IE	IC1IE	INT0IE
bit 7							bit 0

Legend:

bit 8

bit 4

bit 3

bit 2

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-4 Unimplemented: Read as '0'

bit 13 AD1IE: ADC1 Conversion Complete Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 12 **U1TXIE:** UART1 Transmitter Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 11 **U1RXIE:** UART1 Receiver Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 10 SPI1IE: SPI1 Event Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 9 SPI1EIE: SPI1 Error Interrupt Enable bit

1 = Interrupt request enabled 0 = Interrupt request not enabled T3IE: Timer3 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabledT2IE: Timer2 Interrupt Enable bit

bit 7 **T2IE:** Timer2 Interrupt Enable bit

1 = Interrupt request enabled

0 = Interrupt request not enabled

bit 6 OC2IE: Output Compare Channel 2 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 5 IC2IE: Input Capture Channel 2 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabledUnimplemented: Read as '0'

T1IE: Timer1 Interrupt Enable bit 1 = Interrupt request enabled

0 = Interrupt request not enabledOC1IE: Output Compare Channel 1 Interrupt Enable bit

1 = Interrupt request enabled 0 = Interrupt request not enabled

REGISTER 6-8: IEC0: INTERRUPT ENABLE CONTROL REGISTER 0 (CONTINUED)

bit 1 IC1IE: Input Capture Channel 1 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 0 INTOIE: External Interrupt 0 Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

REGISTER 6-9: IEC1: INTERRUPT ENABLE CONTROL REGISTER 0

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	INT2IE	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
IC8IE	IC7IE	_	INT1IE	CNIE	_	MI2C1IE	SI2C1IE
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 Unimplemented: Read as '0'

bit 13 INT2IE: External Interrupt 2 Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 12-8 **Unimplemented:** Read as '0'

bit 7 IC8IE: Input Capture Channel 8 Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 6 IC7IE: Input Capture Channel 7 Interrupt Enable bit

1 = Interrupt request enabled 0 = Interrupt request not enabled

bit 5 Unimplemented: Read as '0'

bit 4 **INT1IE:** External Interrupt 1 Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 3 CNIE: Input Change Notification Interrupt Enable bit

1 = Interrupt request enabled 0 = Interrupt request not enabled

bit 2 Unimplemented: Read as '0'

bit 1 MI2C1IE: I2C1 Master Events Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 0 SI2C1IE: I2C1 Slave Events Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

REGISTER 6-10: IEC4: INTERRUPT ENABLE CONTROL REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
_	_	_	_	_	_	U1EIE	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-2 Unimplemented: Read as '0'

bit 1 **U1EIE:** UART1 Error Interrupt Enable bit

1 = Interrupt request enabled0 = Interrupt request not enabled

bit 0 **Unimplemented:** Read as '0'

REGISTER 6-11: IPC0: INTERRUPT PRIORITY CONTROL REGISTER 0

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		T1IP<2:0>		_		OC1IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		IC1IP<2:0>		_		INT0IP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 Unimplemented: Read as '0'

bit 14-12 T1IP<2:0>: Timer1 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 OC1IP<2:0>: Output Compare Channel 1 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

.

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 Unimplemented: Read as '0'

bit 6-4 IC1IP<2:0>: Input Capture Channel 1 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **INT0IP<2:0>:** External Interrupt 0 Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

.

.

001 = Interrupt is priority 1

REGISTER 6-12: IPC1: INTERRUPT PRIORITY CONTROL REGISTER 1

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		T2IP<2:0>		_		OC2IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_		IC2IP<2:0>		_	_	_	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T2IP<2:0>:** Timer2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 OC2IP<2:0>: Output Compare Channel 2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 IC2IP<2:0>: Input Capture Channel 2 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

-

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

REGISTER 6-13: IPC2: INTERRUPT PRIORITY CONTROL REGISTER 2

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		U1RXIP<2:0>		_		SPI1IP<2:0>	
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		SPI1EIP<2:0>		_		T3IP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 U1RXIP<2:0>: UART1 Receiver Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 SPI1IP<2:0>: SPI1 Event Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

.

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 Unimplemented: Read as '0'

bit 6-4 SPI1EIP<2:0>: SPI1 Error Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 T3IP<2:0>: Timer3 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

REGISTER 6-14: IPC3: INTERRUPT PRIORITY CONTROL REGISTER 3

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		AD1IP<2:0>		_		U1TXIP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 AD1IP<2:0>: ADC1 Conversion Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 U1TXIP<2:0>: UART1 Transmitter Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

.

001 = Interrupt is priority 1

REGISTER 6-15: IPC4: INTERRUPT PRIORITY CONTROL REGISTER 4

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_		CNIP<2:0>		_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		MI2C1IP<2:0>		_		SI2C1IP<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 CNIP<2:0>: Change Notification Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11-7 Unimplemented: Read as '0'

bit 6-4 MI2C1IP<2:0>: I2C1 Master Events Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

.

.

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 Unimplemented: Read as '0'

bit 2-0 SI2C1IP<2:0>: I2C1 Slave Events Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

REGISTER 6-16: IPC5: INTERRUPT PRIORITY CONTROL REGISTER 5

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
_		IC8IP<2:0>		_		IC7IP<2:0>	
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-1	R/W-0	R/W-0
_	_	_	_	_		INT1IP<2:0>	
bit 7							bit 0

Legend:

bit 7-3

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 Unimplemented: Read as '0'

bit 14-12 IC8IP<2:0>: Input Capture Channel 8 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 IC7IP<2:0>: Input Capture Channel 7 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

.

001 = Interrupt is priority 1 000 = Interrupt source is disabled

Unimplemented: Read as '0'

bit 2-0 **INT1IP<2:0>:** External Interrupt 1 Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

•

001 = Interrupt is priority 1

REGISTER 6-17: IPC7: INTERRUPT PRIORITY CONTROL REGISTER 7

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_		INT2IP<2:0>		_	_	_	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 **INT2IP<2:0>:** External Interrupt 2 Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

REGISTER 6-18: IPC16: INTERRUPT PRIORITY CONTROL REGISTER 16

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
_		U1EIP<2:0>		_	_	_	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR $(1)^2$ = Bit is set $(0)^2$ = Bit is cleared $(0)^2$ = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 **U1EIP<2:0>:** UART1 Error Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•

:

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

REGISTER 6-19: INTTREG: INTERRUPT CONTROL AND STATUS REGISTER

U-0	U-0	U-0	U-0	R-0	R-0	R-0	R-0	
_		_	_	ILR<3:0>				
bit 15		_					bit 8	

U-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
_				VECNUM<6:0	>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-12 Unimplemented: Read as '0'

bit 11-8 ILR<3:0>: New CPU Interrupt Priority Level bits

1111 = CPU Interrupt Priority Level is 15

0001 = CPU Interrupt Priority Level is 1

0000 = CPU Interrupt Priority Level is 0

bit 7 Unimplemented: Read as '0'

bit 6-0 VECNUM<6:0>: Vector Number of Pending Interrupt bits

0111111 = Interrupt Vector pending is number 135

0000001 = Interrupt Vector pending is number 9 0000000 = Interrupt Vector pending is number 8

6.4 Interrupt Setup Procedures

6.4.1 INITIALIZATION

To configure an interrupt source at initialization:

- Set the NSTDIS bit (INTCON1<15>) if nested interrupts are not desired.
- Select the user-assigned priority level for the interrupt source by writing the control bits in the appropriate IPCx register. The priority level will depend on the specific application and type of interrupt source. If multiple priority levels are not desired, the IPCx register control bits for all enabled interrupt sources can be programmed to the same non-zero value.

Note: At a device Reset, the IPCx registers are initialized such that all user interrupt sources are assigned to priority level 4.

- Clear the interrupt flag status bit associated with the peripheral in the associated IFSx register.
- Set the interrupt enable control bit associated with the source in the appropriate IECx register to enable the interrupt source.

6.4.2 INTERRUPT SERVICE ROUTINE

The method used to declare an ISR and initialize the IVT with the correct vector address depends on the programming language (C or Assembler) and the language development toolsuite used to develop the application.

In general, the user application must clear the interrupt flag in the appropriate IFSx register for the source of interrupt that the ISR handles. Otherwise, the program will re-enter the ISR immediately after exiting the routine. If the ISR is coded in assembly language, it must be terminated using a RETFIE instruction to unstack the saved PC value, SRL value and old CPU priority level.

6.4.3 TRAP SERVICE ROUTINE

A Trap Service Routine (TSR) is coded like an ISR, except that the appropriate trap status flag in the INTCON1 register must be cleared to avoid re-entry into the TSR.

6.4.4 INTERRUPT DISABLE

All user interrupts can be disabled using this procedure:

- Push the current SR value onto the software stack using the PUSH instruction.
- 2. Force the CPU to priority level 7 by inclusive ORing the value OEh with SRL.

To enable user interrupts, the ${\tt POP}$ instruction can be used to restore the previous SR value.

Note: Only user interrupts with a priority level of 7 or lower can be disabled. Trap sources (level 8-level 15) cannot be disabled.

The DISI instruction provides a convenient way to disable interrupts of priority levels 1-6 for a fixed period of time. Level 7 interrupt sources are not disabled by the DISI instruction.

NOTES:	

7.0 OSCILLATOR CONFIGURATION

Note: This data sheet summarizes the features PIC24HJ32GP202/204 PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section Oscillator" (DS70227), which is available from the Microchip website (www.microchip.com).

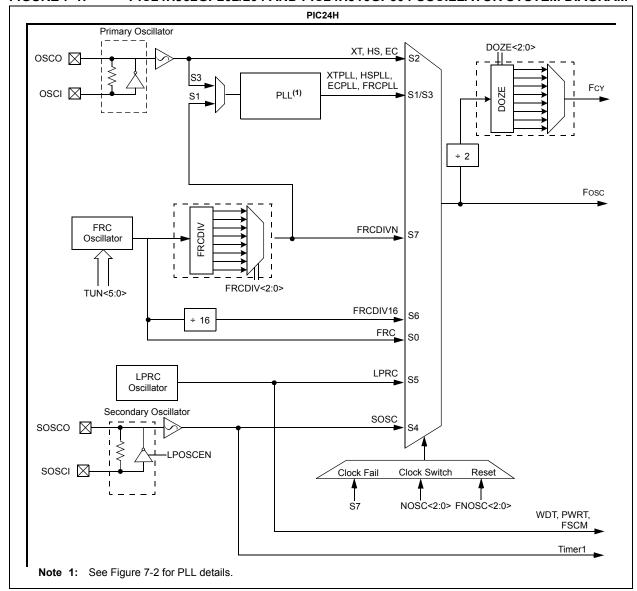
The PIC24HJ32GP202/204 and PIC24HJ16GP304 oscillator system provides:

 External and internal oscillator options as clock sources.

- An on-chip PLL to scale the internal operating frequency to the required system clock frequency.
- An internal FRC oscillator that can also be used with the PLL, thereby allowing full speed operation without any external clock generation hardware.
- · Clock switching between various clock sources.
- Programmable clock postscaler for system power savings.
- A Fail-Safe Clock Monitor (FSCM) that detects clock failure and takes fail-safe measures.
- A Clock Control register (OSCCON).
- Nonvolatile Configuration bits for main oscillator selection

A simplified diagram of the oscillator system is shown in Figure 7-1.

FIGURE 7-1: PIC24HJ32GP202/204 AND PIC24HJ16GP304 OSCILLATOR SYSTEM DIAGRAM



7.1 CPU Clocking System

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices provide the following seven system clock options.

- · Fast RC (FRC) Oscillator
- · FRC Oscillator with PLL
- · Primary (XT, HS or EC) Oscillator
- · Primary Oscillator with PLL
- · Secondary (LP) Oscillator
- · Low-Power RC (LPRC) Oscillator
- · FRC Oscillator with postscaler

7.1.1 SYSTEM CLOCK SOURCES

7.1.1.1 Fast RC

The Fast RC (FRC) internal oscillator runs at a nominal frequency of 7.37 MHz. User software can tune the FRC frequency. User software can optionally specify a factor (ranging from 1:2 to 1:256) by which the FRC clock frequency is divided. This factor is selected using the FRCDIV<2:0> (CLKDIV<10:8>) bits.

7.1.1.2 Primary

The primary oscillator can use one of the following as its clock source:

- Crystal (XT): Crystals and ceramic resonators in the range of 3 MHz to 10 MHz. The crystal is connected to the OSC1 and OSC2 pins.
- HS (High-Speed Crystal): Crystals in the range of 10 MHz to 40 MHz. The crystal is connected to the OSC1 and OSC2 pins.
- EC (External Clock): The external clock signal is directly applied to the OSC1 pin.

7.1.1.3 Secondary

The secondary (LP) oscillator is designed for low power and uses a 32.768 kHz crystal or ceramic resonator. The LP oscillator uses SOSCI and SOSCO pins.

7.1.1.4 Low-Power RC

The Low-Power RC (LPRC) internal oscillator runs at a nominal frequency of 32.768 kHz. It is also used as a reference clock by the Watchdog Timer (WDT) and Fail-Safe Clock Monitor (FSCM).

7.1.1.5 FRC

The clock signals generated by the FRC and primary oscillators can be optionally applied to an on-chip Phase Locked Loop (PLL) to provide a wide range of output frequencies for device operation. PLL configuration is described in **Section 7.1.3 "PLL Configuration"**.

The FRC frequency depends on the FRC accuracy (see Table 21-18) and the value of the FRC Oscillator Tuning register (see Register 7-4).

7.1.2 SYSTEM CLOCK SELECTION

The oscillator source used at a device Power-on Reset event is selected using Configuration bit settings. The oscillator Configuration bit settings are located in the Configuration registers in the program memory. (Refer to Section 18.1 "Configuration Bits" for further details.) The Initial Oscillator Selection Configuration bits, FNOSC<2:0> (FOSCSEL<2:0>), and the Primary Oscillator Mode Select Configuration bits, POSCMD<1:0> (FOSC<1:0>), select the oscillator source that is used at a Power-on Reset. The FRC primary oscillator is the default (unprogrammed) selection.

The Configuration bits allow users to choose among 12 different clock modes, shown in Table 7-1.

The output of the oscillator (or the output of the PLL if a PLL mode has been selected) Fosc is divided by 2 to generate the device instruction clock (FcY). FcY defines the operating speed of the device, and speeds up to 40 MHz are supported by the PIC24HJ32GP202/204 and PIC24HJ16GP304 architecture.

Instruction execution speed or device operating frequency, Fcy, is given by:

EQUATION 7-1: DEVICE OPERATING FREQUENCY

FCY = FOSC/2

7.1.3 PLL CONFIGURATION

The primary oscillator and internal FRC oscillator can optionally use on-chip PLL to obtain higher speeds of operation. The PLL provides significant flexibility in selecting the device operating speed. A block diagram of the PLL is shown in Figure 7-2.

The output of the primary oscillator or FRC, denoted as 'FIN' is divided down by a prescale factor (N1) of 2, 3, ... or 33 before it is being provided to the PLL's Voltage Controlled Oscillator (VCO). The input to the VCO must be selected in the range of 0.8 MHz to 8 MHz. The prescale factor 'N1' is selected using the PLLPRE<4:0> bits (CLKDIV<4:0>).

The PLL Feedback Divisor, selected using the PLLDIV<8:0> bits (PLLFBD<8:0>), provides a factor 'M', by which the input to the VCO is multiplied. This factor must be selected such that the resulting VCO output frequency is in the range of 100 MHz to 200 MHz.

The VCO output is further divided by a postscale factor 'N2.' This factor is selected using the PLLPOST<1:0> bits (CLKDIV<7:6>). 'N2' can be 2, 4 or 8, and must be selected such that the PLL output frequency (Fosc) is in the range of 12.5 MHz to 80 MHz, which generates device operating speeds of 6.25-40 MIPS.

For a primary oscillator or FRC oscillator, output 'FIN', the PLL output 'Fosc' is given by:

EQUATION 7-2: Fosc CALCULATION

$$FOSC = FIN* \left(\frac{M}{N1*N2} \right)$$

For example, when a 10 MHz crystal is being used, with "XT with PLL" being the selected oscillator mode.

 If PLLPRE<4:0> = 0, then N1 = 2. This yields a VCO input of 10/2 = 5 MHz, which is within the acceptable range of 0.8-8 MHz.

- If PLLDIV<8:0> = 0x1E, then M = 32. This yields a VCO output of 5 x 32 = 160 MHz, which is within the 100 MHz to 200 MHz range, which is needed.
- If PLLPOST<1:0> = 0, then N2 = 2. This provides a Fosc of 160/2 = 80 MHz. The resultant device operating speed is 80/2 = 40 MIPS.

EQUATION 7-3: XT WITH PLL MODE EXAMPLE

$$F_{CY} = \frac{F_{OSC}}{2} = \frac{1}{2} \left(\frac{10000000*32}{2*2} \right) = 40 \text{ MIPS}$$

FIGURE 7-2: PIC24HJ32GP202/204 AND PIC24HJ16GP304 PLL BLOCK DIAGRAM

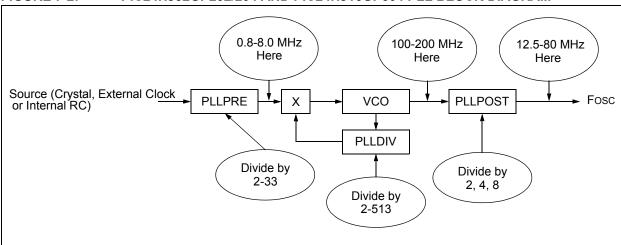


TABLE 7-1: CONFIGURATION BIT VALUES FOR CLOCK SELECTION

Oscillator Mode	Oscillator Source	POSCMD<1:0>	FNOSC<2:0>	Note
Fast RC Oscillator with Divide-by-N (FRCDIVN)	Internal	XX	111	1, 2
Fast RC Oscillator with Divide-by-16 (FRCDIV16)	Internal	XX	110	1
Low-Power RC Oscillator (LPRC)	Internal	XX	101	1
Secondary (Timer1) Oscillator (SOSC)	Secondary	XX	100	1
Primary Oscillator (HS) with PLL (HSPLL)	Primary	10	011	_
Primary Oscillator (XT) with PLL (XTPLL)	Primary	01	011	_
Primary Oscillator (EC) with PLL (ECPLL)	Primary	00	011	1
Primary Oscillator (HS)	Primary	10	010	_
Primary Oscillator (XT)	Primary	01	010	_
Primary Oscillator (EC)	Primary	00	010	1
Fast RC Oscillator with PLL (FRCPLL)	Internal	XX	001	1
Fast RC Oscillator (FRC)	Internal	XX	000	1

Note 1: OSC2 pin function is determined by the OSCIOFNC Configuration bit.

2: This is the default oscillator mode for an unprogrammed (erased) device.

REGISTER 7-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R-0	R-0	R-0	U-0	R/W-y	R/W-y	R/W-y
_		COSC<2:0>		_		NOSC<2:0>	
bit 15							bit 8

R/W-0	R/W-0	R-0	U-0	R/C-0	U-0	R/W-0	R/W-0
CLKLOCK	IOLOCK	LOCK	_	CF	_	LPOSCEN	OSWEN
bit 7							bit 0

Legend: y = Value set from Configuration bits on POR

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 COSC<2:0>: Current Oscillator Selection bits (read-only)

000 = Fast RC oscillator (FRC)

001 = Fast RC oscillator (FRC) with PLL

010 = Primary oscillator (XT, HS, EC)

011 = Primary oscillator (XT, HS, EC) with PLL

100 = Secondary oscillator (SOSC)

101 = Low-Power RC oscillator (LPRC)

110 = Fast RC oscillator (FRC) with Divide-by-16

111 = Fast RC oscillator (FRC) with Divide-by-n

bit 11 **Unimplemented:** Read as '0'

bit 10-8 NOSC<2:0>: New Oscillator Selection bits

000 = Fast RC oscillator (FRC)

001 = Fast RC oscillator (FRC) with PLL

010 = Primary oscillator (XT, HS, EC)

011 = Primary oscillator (XT, HS, EC) with PLL

100 = Secondary oscillator (SOSC)

101 = Low-Power RC oscillator (LPRC)

110 = Fast RC oscillator (FRC) with Divide-by-16

111 = Fast RC oscillator (FRC) with Divide-by-n

bit 7 CLKLOCK: Clock Lock Enable bit

If clock switching is enabled and FSCM is disabled (FOSC<FCKSM> = 0b01)

1 = Clock switching is disabled, system clock source is locked

0 = Clock switching is enabled, system clock source can be modified by clock switching

bit 6 **IOLOCK:** Peripheral Pin Select Lock bit

1 = Peripherial Pin Select is locked, write to peripheral pin select register is not allowed

0 = Peripherial Pin Select is unlocked, write to peripheral pin select register is allowed

bit 5 LOCK: PLL Lock Status bit (read-only)

1 = Indicates that PLL is in lock, or PLL start-up timer is satisfied

0 = Indicates that PLL is out of lock, start-up timer is in progress or PLL is disabled

bit 4 **Unimplemented:** Read as '0'

bit 3 **CF**: Clock Fail Detect bit (read/clear by application)

1 = FSCM has detected clock failure

0 = FSCM has not detected clock failure

bit 2 **Unimplemented:** Read as '0'

REGISTER 7-1: OSCCON: OSCILLATOR CONTROL REGISTER (CONTINUED)

bit 1 LPOSCEN: Secondary (LP) Oscillator Enable bit

1 = Enable secondary oscillator0 = Disable secondary oscillator

bit 0 **OSWEN:** Oscillator Switch Enable bit

1 = Request oscillator switch to selection specified by NOSC<2:0> bits

0 = Oscillator switch is complete

REGISTER 7-2: CLKDIV: CLOCK DIVISOR REGISTER

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
ROI		DOZE<2:0>		DOZEN ⁽¹⁾		FRCDIV<2:0>	
bit 15							bit 8

R/W-0	R/W-1	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PLLPOS	ST<1:0>	_	PLLPRE<4:0>				
bit 7			bi				

Legend:	y = Value set from Configu	y = Value set from Configuration bits on POR					
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown				

bit 15 ROI: Recover on Interrupt bit

1 = Interrupts will clear the DOZEN bit and the processor clock/peripheral clock ratio is set to 1:1

0 = Interrupts have no effect on the DOZEN bit

bit 14-12 **DOZE<2:0>:** Processor Clock Reduction Select bits

000 = Fcy/1

001 = Fcy/2

010 = Fcy/4

011 = Fcy/8 (default)

100 = Fcy/16

101 = Fcy/32

110 = Fcy/64

111 = Fcy/128

bit 11 **DOZEN:** DOZE Mode Enable bit⁽¹⁾

1 = DOZE<2:0> field specifies the ratio between the peripheral clocks and the processor clocks

0 = Processor clock/peripheral clock ratio forced to 1:1

bit 10-8 FRCDIV<2:0>: Internal Fast RC Oscillator Postscaler bits

000 = FRC divide by 1 (default)

001 = FRC divide by 2

010 = FRC divide by 4

011 = FRC divide by 8

100 = FRC divide by 16

101 = FRC divide by 32

110 = FRC divide by 64

110 - I'KC divide by 04

111 = FRC divide by 256

bit 7-6 PLLPOST<1:0>: PLL VCO Output Divider Select bits (also denoted as 'N2', PLL postscaler)

00 = Output/2

01 = Output/4 (default)

10 = Reserved

11 = Output/8

bit 5 **Unimplemented:** Read as '0'

bit 4-0 PLLPRE<4:0>: PLL Phase Detector Input Divider bits (also denoted as 'N1', PLL prescaler)

00000 = Input/2 (default)

00001 = Input/3

•

•

•

11111 = Input/33

Note 1: This bit is cleared when the ROI bit is set and an interrupt occurs.

REGISTER 7-3: PLLFBD: PLL FEEDBACK DIVISOR REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0
_	_	_	_	_	_	_	PLLDIV<8>
bit 15							bit 8

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
PLLDIV<7:0>							
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-9 **Unimplemented:** Read as '0'

bit 8-0 PLLDIV<8:0>: PLL Feedback Divisor bits (also denoted as 'M', PLL multiplier)

0000000000 = 2 000000001 = 3

000000010 = 4

•

000110000 - **FO** /do

000110000 **= 50 (default)**

.

•

111111111 = 513

REGISTER 7-4: OSCTUN: FRC OSCILLATOR TUNING REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_			TUN	<5:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5-0 **TUN<5:0>:** FRC Oscillator Tuning bits

011111 = Center frequency + 11.625% (8.23 MHz)

011110 = Center frequency + 11.25% (8.20 MHz)

•

00001 = Contar fraguency | 0.27

000001 = Center frequency + 0.375% (7.40 MHz)

000000 = Center frequency (7.37 MHz nominal)

111111 = Center frequency - 0.375% (7.345 MHz)

•

100001 = Center frequency - 11.625% (6.52 MHz)

100000 = Center frequency - 12% (6.49 MHz)

7.2 Clock Switching Operation

Applications are free to switch among any of the four clock sources (Primary, LP, FRC and LPRC) under software control at any time. To limit the possible side effects of this flexibility, PIC24HJ32GP202/204 and PIC24HJ16GP304 devices have a safeguard lock built into the switch process.

ote: Primary Oscillator mode has three different submodes (XT, HS and EC), which are determined by the POSCMD<1:0> Configuration bits. While an application can switch to and from Primary Oscillator mode in software, it cannot switch among the different primary submodes without reprogramming the device.

7.2.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in the Configuration register must be programmed to '0'. (Refer to **Section 18.1 "Configuration Bits"** for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and Fail-Safe Clock Monitor function are disabled. This is the default setting.

The NOSC control bits (OSCCON<10:8>) do not control the clock selection when clock switching is disabled. However, the COSC bits (OSCCON<14:12>) reflect the clock source selected by the FNOSC Configuration bits.

The OSWEN control bit (OSCCON<0>) has no effect when clock switching is disabled. It is held at '0' at all times.

7.2.2 OSCILLATOR SWITCHING SEQUENCE

Performing a clock switch requires the following basic sequence:

- Read the COSC bits (OSCCON<14:12>) to determine the current oscillator source, if desired.
- Perform the unlock sequence to allow a write to the OSCCON register high byte.
- Write the appropriate value to the NOSC control bits (OSCCON<10:8>) for the new oscillator source.
- 4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
- Set the OSWEN bit to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically as follows:

 The clock switching hardware compares the COSC status bits with the new value of the NOSC control bits. If both of them are the same, the clock switch is a redundant operation. In this

- case, the OSWEN bit is cleared automatically and the clock switch is aborted.
- If a valid clock switch has been initiated, the LOCK (OSCCON<5>) and the CF (OSCCON<3>) status bits are cleared.
- The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator has to be turned on, the hardware waits until the Oscillator Start-up Timer (OST) expires. If the new source is using the PLL, the hardware waits until a PLL lock is detected (LOCK = 1).
- The hardware waits for 10 clock cycles from the new clock source and then performs the clock switch.
- The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSC bit values are transferred to the COSC status bits.
- The old clock source is turned off at this time, with the exception of LPRC (if WDT or FSCM are enabled) or LP (if LPOSCEN remains set).
 - Note 1: The processor continues to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time.
 - 2: Direct clock switches between any primary oscillator mode with PLL and FRCPLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transition clock source between the two PLL modes.

7.3 Fail-Safe Clock Monitor (FSCM)

The Fail-Safe Clock Monitor (FSCM) allows the device to continue to operate even in the event of an oscillator failure. The FSCM function is enabled by programming. If the FSCM function is enabled, the LPRC internal oscillator runs at all times (except during Sleep mode) and is not subject to control by the Watchdog Timer.

In the event of an oscillator failure, the FSCM generates a clock failure trap event and switches the system clock over to the FRC oscillator. Then the application program can either attempt to restart the oscillator or execute a controlled shutdown. The trap can be treated as a warm Reset by simply loading the Reset address into the oscillator fail trap vector.

If the PLL multiplier is used to scale the system clock, the internal FRC is also multiplied by the same factor on clock failure. Essentially, the device switches to FRC with PLL on a clock failure.

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NOTES:			

8.0 POWER-SAVING FEATURES

Note:

This data sheet summarizes the features PIC24HJ32GP202/204 PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family "Section Reference Manual, Watchdog Timer and Power Savings Modes" (DS70236), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices provide the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. PIC24HJ32GP202/204 and PIC24HJ16GP304 devices can manage power consumption in four different ways:

- · Clock frequency
- · Instruction-based Sleep and Idle modes
- · Software-controlled Doze mode
- · Selective peripheral control in software

Combinations of the above methods can be used to selectively customize an application's power consumption while still maintaining critical application features, such as timing-sensitive communications.

8.1 Clock Frequency and Clock Switching

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices allow a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC bits (OSCCON<10:8>). The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in **Section 7.0** "Oscillator Configuration".

8.2 Instruction-Based Power-Saving Modes

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution. Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation. Example 8-1 shows the Assembler syntax of the PWRSAV instruction.

Note: SLEEP_MODE and IDLE_MODE are constants defined in the assembler include file for the selected device.

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to wake-up.

8.2.1 SLEEP MODE

In the Sleep mode,

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption is reduced to a minimum, provided that no I/O pin is sourcing current.
- The Fail-Safe Clock Monitor does not operate, since the system clock source is disabled.
- The LPRC clock continues to run if the WDT is enabled.
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode.
- Some device features or peripherals may continue to operate. This includes items such as the input change notification on the I/O ports, or peripherals that use an external clock input.
- Any peripheral that requires the system clock source for its operation is disabled.

The device will wake-up from Sleep mode on any of these events:

- · Any interrupt source that is individually enabled
- · Any form of device Reset
- · A WDT time-out

On wake-up from Sleep mode, the processor restarts with the same clock source that was active when Sleep mode was entered.

EXAMPLE 8-1: PWRSAV INSTRUCTION SYNTAX

PWRSAV $\#SLEEP_MODE$; Put the device into SLEEP mode PWRSAV $\#IDLE_MODE$; Put the device into IDLE mode

8.2.2 IDLE MODE

The following occur in Idle mode:

- · The CPU stops executing instructions.
- · The WDT is automatically cleared.
- The system clock source remains active. By default, all peripheral modules continue to operate normally from the system clock source, but can also be selectively disabled (see Section 8.4 "Peripheral Module Disable").
- If the WDT or FSCM is enabled, the LPRC also remains active.

The device will wake from Idle mode on any of these events:

- · Any interrupt that is individually enabled.
- · Any device Reset
- A WDT time-out

On wake-up from Idle mode, the clock is reapplied to the CPU and instruction execution begins immediately, starting with the instruction following the PWRSAV instruction, or the first instruction in the ISR.

8.2.3 INTERRUPTS COINCIDENT WITH POWER SAVE INSTRUCTIONS

Any interrupt that coincides with the execution of a PWRSAV instruction is held off until entry into Sleep or Idle mode is completed. The device then wakes up from Sleep or Idle mode.

8.3 Doze Mode

The preferred strategies for reducing power consumption are changing clock speed and invoking one of the power-saving modes. In some circumstances, however, these are not practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed can introduce communication errors, while using a power-saving mode can stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed, while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:128, with 1:1 being the default setting.

Programs can use Doze mode to selectively reduce power consumption in event-driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU idles, waiting for something to invoke an interrupt routine. An automatic return to full-speed CPU operation on interrupts can be enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

For example, suppose the device is operating at 20 MIPS and the CAN module has been configured for 500 kbps based on this device operating speed. If the device is placed in Doze mode with a clock frequency ratio of 1:4, the CAN module continues to communicate at the required bit rate of 500 kbps, but the CPU now starts executing instructions at a frequency of 5 MIPS.

8.4 Peripheral Module Disable

The Peripheral Module Disable (PMD) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled using the appropriate PMD control bit, the peripheral is in a minimum power consumption state. The control and status registers associated with the peripheral are also disabled. So writes to those registers will have no effect and read values will be invalid.

A peripheral module is enabled only if both the associated bit in the PMD register are cleared and the peripheral is supported by the specific PIC24H variant. If the peripheral is present in the device, it is enabled in the PMD register by default.

Note: If a PMD bit is set, the corresponding module is disabled after a delay of one instruction cycle. Similarly, if a PMD bit is cleared, the corresponding module is enabled after a delay of one instruction cycle (assuming the module control registers are already configured to enable module operation).

REGISTER 8-1: PMD1: PERIPHERAL MODULE DISABLE CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0
_	_	T3MD	T2MD	T1MD	_	_	_
bit 15							bit 8

R/W-0	U-0	R/W-0	U-0	R/W-0	U-0	U-0	R/W-0
I2C1MD	_	U1MD	_	SPI1MD	_	_	AD1MD
bit 7							bit 0

Lege	nd
------	----

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0' bit 13 **T3MD:** Timer3 Module Disable bit 1 = Timer3 module is disabled

1 = Timer3 module is disabled 0 = Timer3 module is enabled

bit 12 **T2MD:** Timer2 Module Disable bit

1 = Timer2 module is disabled0 = Timer2 module is enabled

bit 11 T1MD: Timer1 Module Disable bit

1 = Timer1 module is disabled 0 = Timer1 module is enabled Unimplemented: Read as '0'

bit 10-8 **Unimplemented:** Read as '0' bit 7 **I2C1MD:** I²C1 Module Disable bit

1 = I^2C1 module Disabled 0 = I^2C1 module is disabled

bit 6 **Unimplemented:** Read as '0' bit 5 **U1MD:** UART1 Module Disable bit

1 = UART1 module is disabled 0 = UART1 module is enabled Unimplemented: Read as '0'

bit 4 Unimplemented: Read as '0' bit 3 SPI1MD: SPI1 Module Disable bit

1 = SPI1 module is disabled 0 = SPI1 module is enabled

bit 2-1 **Unimplemented:** Read as '0'

bit 0 **AD1MD:** ADC1 Module Disable bit

1 = ADC1 module is disabled 0 = ADC1 module is enabled

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REGISTER 8-2: PMD2: PERIPHERAL MODULE DISABLE CONTROL REGISTER 2

R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
IC8MD	IC7MD	_	_	_	_	IC2MD	IC1MD
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	
_	_	_	_	_	_	OC2MD	OC1MD	
bit 7 bi								

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 IC8MD: Input Capture 8 Module Disable bit

> 1 = Input Capture 8 module is disabled 0 = Input Capture 8 module is enabled

bit 14 IC7MD: Input Capture 2 Module Disable bit

1 = Input Capture 7 module is disabled 0 = Input Capture 7 module is enabled

bit 13-10 Unimplemented: Read as '0'

bit 9 IC2MD: Input Capture 2 Module Disable bit

> 1 = Input Capture 2 module is disabled 0 = Input Capture 2 module is enabled

bit 8 IC1MD: Input Capture 1 Module Disable bit

> 1 = Input Capture 1 module is disabled 0 = Input Capture 1 module is enabled

bit 7-2 Unimplemented: Read as '0'

bit 1 OC2MD: Output Compare 2 Module Disable bit

> 1 = Output Compare 2 module is disabled 0 = Output Compare 2 module is enabled

bit 0 OC1MD: Output Compare 1 Module Disable bit

> 1 = Output Compare 1 module is disabled 0 = Output Compare 1 module is enabled

9.0 I/O PORTS

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 10. I/O Ports" (DS70230), which is available from the Microchip website (www.microchip.com).

All of the device pins (except VDD, VSS, $\overline{\text{MCLR}}$ and OSC1/CLKI) are shared among the peripherals and the parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

9.1 Parallel I/O (PIO) Ports

A parallel I/O port that shares a pin with a peripheral is generally subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. The logic also prevents "loop through", in which a port's digital output can drive the input of a

peripheral that shares the same pin. Figure 9-1 shows how ports are shared with other peripherals and the associated I/O pin to which they are connected.

When a peripheral is enabled and the peripheral is actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin can be read, but the output driver for the parallel port bit is disabled. If a peripheral is enabled, but the peripheral is not actively driving a pin, that pin can be driven by a port.

All port pins have three registers directly associated with their operation as digital I/O. The data direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is '1', then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx) read the latch. Writes to the latch, write the latch. Reads from the port (PORTx) read the port pins, while writes to the port pins write the latch.

Any bit and its associated data and control registers that are not valid for a particular device will be disabled. This means that the corresponding LATx and TRISx registers and the port pin will read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs.

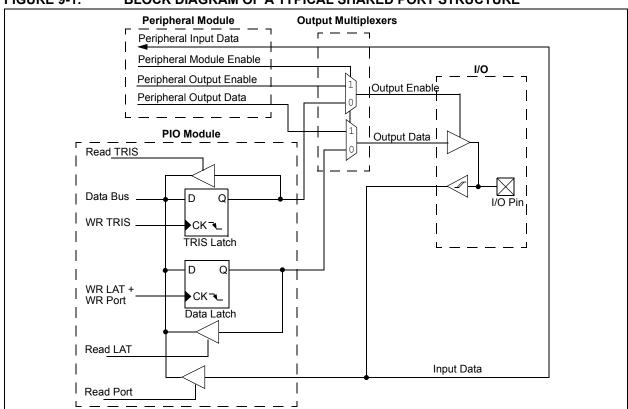


FIGURE 9-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE

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9.1.1 OPEN-DRAIN CONFIGURATION

In addition to the PORT, LAT and TRIS registers for data control, some port pins can also be individually configured for either digital or open-drain output. This is controlled by the Open-Drain Control register, ODCx, associated with each port. Setting any of the bits configures the corresponding pin to act as an open-drain output.

The open-drain feature allows the generation of outputs higher than VDD (e.g., 5V) on any desired digital-only pins by using external pull-up resistors. The maximum open-drain voltage allowed is the same as the maximum VIH specification.

Some I/O pins may have internal analog functionality that will not be shown on the device pin diagram. These pins must be treated as analog pins. Table 9-1 lists all available pins and their functionality.

TABLE 9-1: AVAILABLE I/O PINS AND THEIR FUNCTIONALITY

I/O Pin	Digital-Only/5V Tolerant				
RA0	No				
RA1	No				
RA2	No				
RA3	No				
RA4	No				
RA7	Yes				
RA8	Yes				
RA9	Yes				
RA10	Yes				
RB0	No				
RB1	No				
RB2	No				
RB3	No				
RB4	Yes				
RB5	Yes				
RB6	Yes				
RB7	Yes				
RB8	Yes				
RB9	Yes				
RB10	Yes				
RB11	Yes				
RB12	No				
RB13	No				
RB14	No				
RB15	No				
RC0	No				
RC1	No				
RC2	No				
RC3	Yes				
RC4	Yes				
RC5	Yes				
RC6	Yes				
RC7	Yes				
RC8	Yes				
RC9	Yes				

9.2 Configuring Analog Port Pins

The AD1PCFG and TRIS registers control the operation of the analog-to-digital (A/D) port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bit set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

When the PORT register is read, all pins configured as analog input channels will read as cleared (a low level).

Pins configured as digital inputs will not convert an analog input. Analog levels on any pin that is defined as a digital input (including the ANx pins) can cause the input buffer to consume current that exceeds the device specifications.

9.2.1 I/O PORT WRITE/READ TIMING

One instruction cycle is required between a port direction change or port write operation and a read operation of the same port. Typically this instruction would be a NOP. An example is shown in Example 9-1.

9.3 Input Change Notification

The input change notification function of the I/O ports allows the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices to generate interrupt requests to the processor in response to a change-of-state on selected input pins. This feature can detect input change-of-states even in Sleep mode, when the clocks are disabled. Depending on the device pin count, up to 31 external signals (CNx pin) can be selected (enabled) for generating an interrupt request on a change-of-state.

Four control registers are associated with the CN module. The CNEN1 and CNEN2 registers contain the interrupt enable control bits for each of the CN input pins. Setting any of these bits enables a CN interrupt for the corresponding pins.

Each CN pin also has a weak pull-up connected to it. The pull-ups act as a current source connected to the pin, and eliminate the need for external resistors when push button or keypad devices are connected. The pull-ups are enabled separately using the CNPU1 and CNPU2 registers, which contain the control bits for each of the CN pins. Setting any of the control bits enables the weak pull-ups for the corresponding pins.

Note: Pull-ups on change notification pins should always be disabled when the port pin is configured as a digital output.

EXAMPLE 9-1: PORT WRITE/READ EXAMPLE

```
MOV 0xFF00, W0 ; Configure PORTB<15:8> as inputs
MOV W0, TRISBB ; and PORTB<7:0> as outputs
NOP ; Delay 1 cycle
btss PORTB, #13 ; Next Instruction
```

9.4 **Peripheral Pin Select**

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. The challenge is even greater on low-pin count devices. In an application where more than one peripheral must be assigned to a single pin, inconvenient workarounds in application code or a complete redesign may be the only option.

Peripheral pin select configuration enables peripheral set selection and placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, programmers can better tailor the microcontroller to their entire application, rather than trimming the application to fit the device.

The peripheral pin select configuration feature operates over a fixed subset of digital I/O pins. Programmers can independently map the input and/or output of most digital peripherals to any one of these I/O pins. Peripheral pin select is performed in software, and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping, once it has been established.

9.4.1 **AVAILABLE PINS**

The peripheral pin select feature is used with a range of up to 26 pins. The number of available pins depends on the particular device and its pin count. Pins that support the peripheral pin select feature include the designation "RPn" in their full pin designation, where "RP" designates a remappable peripheral and "n" is the remappable pin number.

9.4.2 CONTROLLING PERIPHERAL PIN **SELECT**

Peripheral pin select features are controlled through two sets of special function registers to map peripherals and to map outputs.

Since they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral selectable pin is handled in two different ways, depending on whether an input or output is being mapped.

9.4.2.1 Input Mapping

The inputs of the peripheral pin select options are mapped on the basis of the peripheral. A control register associated with a peripheral dictates the pin it will be mapped to. The RPINRx registers are used to configure peripheral input mapping (see Register 9-1 through Register 9-9). Each register contains sets of 5-bit fields, with each set associated with one of the remappable peripherals. Programming a given peripheral's bit field with an appropriate 5-bit value maps the RPn pin with that value to that peripheral. For any given device, the valid range of values for any bit field corresponds to the maximum number of peripheral pin selections supported by the device.

Figure 9-2 Illustrates remappable pin selection for U1RX input.

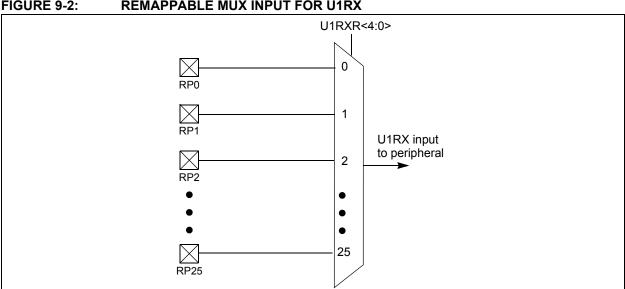


FIGURE 9-2: **REMAPPABLE MUX INPUT FOR U1RX**

TABLE 9-2: REMAPPABLE PERIPHERAL INPUTS⁽¹⁾

Input Name	Function Name	Register	Configuration Bits
External Interrupt 1	INT1	RPINR0	INT1R<4:0>
External Interrupt 2	INT2	RPINR1	INT2R<4:0>
Timer 2 External Clock	T2CK	RPINR3	T2CKR<4:0>
Timer 3 External Clock	T3CK	RPINR3	T3CKR<4:0>
Input Capture 1	IC1	RPINR7	IC1R<4:0>
Input Capture 2	IC2	RPINR7	IC2R<4:0>
Input Capture 7	IC7	RPINR10	IC7R<4:0>
Input Capture 8	IC8	RPINR10	IC8R<4:0>
Output Compare Fault A	OCFA	RPINR11	OCFAR<4:0>
UART 1 Receive	U1RX	RPINR18	U1RXR<4:0>
UART 1 Clear To Send	U1CTS	RPINR18	U1CTSR<4:0>
SPI 1 Data Input	SDI1	RPINR20	SDI1R<4:0>
SPI 1 Clock Input	SCK1IN	RPINR20	SCK1R<4:0>
SPI 1 Slave Select Input	SS1IN	RPINR21	SS1R<4:0>

Note 1: Unless otherwise noted, all inputs use the Schmitt input buffers.

9.4.2.2 Output Mapping

In contrast to inputs, the outputs of the peripheral pin select options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPORx registers are used to control output mapping. Like the RPINRx registers, each register contains sets of 5-bit fields, with each set associated with one RPn pin (see Register 9-10 through Register 9-22). The

value of the bit field corresponds to one of the peripherals, and that peripheral's output is mapped to the pin (see Table 9-3 and Figure 9-3).

The list of peripherals for output mapping also includes a null value of 00000 because of the mapping technique. This permits any given pin to remain unconnected from the output of any of the pin selectable peripherals.

FIGURE 9-3: MULTIPLEXING OF REMAPPABLE OUTPUT FOR RPn

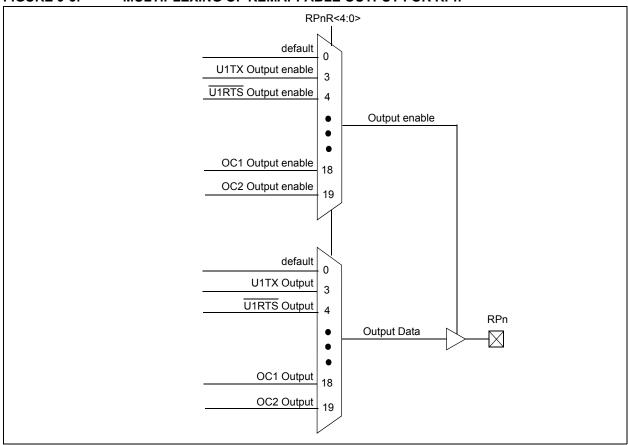


TABLE 9-3: OUTPUT SELECTION FOR REMAPPABLE PIN (RPn)

Function	RPnR<4:0>	Output Name
NULL	00000	RPn tied to default port pin
U1TX	00011	RPn tied to UART 1 Transmit
U1RTS	00100	RPn tied to UART 1 Ready To Send
SDO1	00111	RPn tied to SPI 1 Data Output
SCK1OUT	01000	RPn tied to SPI 1 Clock Output
SS1OUT	01001	RPn tied to SPI 1 Slave Select Output
OC1	10010	RPn tied to Output Compare 1
OC2	10011	RPn tied to Output Compare 2

9.4.3 CONTROLLING CONFIGURATION CHANGES

Because peripheral remapping can be changed during run time, some restrictions on peripheral remapping are needed to prevent accidental configuration changes. PIC24H devices include three features to prevent alterations to the peripheral map:

- · Control register lock sequence
- · Continuous state monitoring
- · Configuration bit pin select lock

9.4.3.1 Control Register Lock

Under normal operation, writes to the RPINRx and RPORx registers are not allowed. Attempted writes appear to execute normally, but the contents of the registers remain unchanged. To change these registers, they must be unlocked in hardware. The register lock is controlled by the IOLOCK bit (OSCCON<6>). Setting IOLOCK prevents writes to the control registers; clearing IOLOCK allows writes.

To set or clear IOLOCK, a specific command sequence must be executed:

- 1. Write 46h to OSCCON<7:0>.
- 2. Write 57h to OSCCON<7:0>.
- 3. Clear (or set) IOLOCK as a single operation.

```
Note: MPLAB® C30 provides built-in C language functions for unlocking the OSCCON register:

__builtin_write_OSCCONL(value)
__builtin_write_OSCCONH(value)
See MPLAB Help for more information.
```

Unlike the similar sequence with the oscillator's LOCK bit, IOLOCK remains in one state until changed. This allows all the peripheral pin selects to be configured with a single unlock sequence followed by an update to all control registers, then locked with a second lock sequence.

9.4.3.2 Continuous State Monitoring

In addition to being protected from direct writes, the contents of the RPINRx and RPORx registers are constantly monitored in hardware by shadow registers. If an unexpected change in any of the registers occurs (such as cell disturbances caused by ESD or other external events), a configuration mismatch Reset will be triggered.

9.4.3.3 Configuration Bit Pin Select Lock

As an additional level of safety, the device can be configured to prevent more than one write session to the RPINRx and RPORx registers. The IOL1WAY (FOSC<IOL1WAY>) configuration bit blocks the IOLOCK bit from being cleared after it has been set once.

In the default (unprogrammed) state, IOL1WAY is set restricting the users to one write session. Programming IOL1WAY allows user applications unlimited access (with the proper use of the unlock sequence) to the peripheral pin select registers.

9.5 Peripheral Pin Select Registers

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices implement 17 registers for remappable peripheral configuration:

- Input Remappable Peripheral Registers (9)
- Output Remappable Peripheral Registers (8)

Note: Input and Output Register values can only be changed if OSCCON[IOLOCK] = 0. See Section 9.4.3.1 "Control Register Lock" for a specific command sequence.

REGISTER 9-1: RPINRO: PERIPHERAL PIN SELECT INPUT REGISTER 0

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			INT1R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
_	_	_	_	_	_	_	_	
bit 7 bit								

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 INT1R<4:0>: Assign External Interrupt 1 (INTR1) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

bit 7-0 **Unimplemented:** Read as '0'

REGISTER 9-2: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
_	_	_	_	_	_	_	_	
bit 15 bit								

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			INT2R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR $(1)^2$ = Bit is set $(0)^2$ = Bit is cleared $(0)^2$ = Bit is unknown

bit 15-5 **Unimplemented:** Read as '0'

bit 4-0 INT2R<4:0>: Assign External Interrupt 2 (INTR2) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1

00000 = Input tied to RP0

REGISTER 9-3: RPINR3: PERIPHERAL PIN SELECT INPUT REGISTER 3

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			T3CKR<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			T2CKR<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 T3CKR<4:0>: Assign Timer3 External Clock (T3CK) to the Corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 T2CKR<4:0>: Assign Timer2 External Clock (T2CK) to the Corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

REGISTER 9-4: RPINR7: PERIPHERAL PIN SELECT INPUT REGISTER 7

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			IC2R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_				IC1R<4:0>		
bit 7							bit 0

R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
n = Value at DOD	'1' - Dit is set	'O' - Dit is alcored	v – Di

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 IC2R<4:0>: Assign Input Capture 2 (IC2) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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Legend:

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00001 = Input tied to RP1 00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 IC1R<4:0>: Assign Input Capture 1 (IC1) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

REGISTER 9-5: RPIR10: PERIPHERAL PIN SELECT INPUT REGISTER 10

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_					IC8R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			IC7R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 IC8R<4:0>: Assign Input Capture 8 (IC8) to the corresponding pin RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 IC7R<4:0>: Assign Input Capture 7 (IC7) to the corresponding pin RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

REGISTER 9-6: RPINR11: PERIPHERAL PIN SELECT INPUT REGISTER 11

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			OCFAR<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-5 **Unimplemented:** Read as '0'

bit 4-0 OCFAR<4:0>: Assign Output Capture A (OCFA) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

RPINR18: PERIPHERAL PIN SELECT INPUT REGISTER 18 REGISTER 9-7:

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			U1CTSR<4:0	>	
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			U1RXR<4:0>		
bit 7							bit 0

Legend:

R = Readable bit U = Unimplemented bit, read as '0' W = Writable bit

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 U1CTSR<4:0>: Assign UART 1 Clear to Send (U1CTS) to the corresponding RPn pin

11111 = Input tied to Vss

11001 = Input tied to RP25

00001 = Input tied to RP1

00000 = Input tied to RP0

bit 7-5 Unimplemented: Read as '0'

bit 4-0 U1RXR<4:0>: Assign UART 1 Receive (U1RX) to the corresponding RPn pin

11111 = Input tied to Vss

11001 = Input tied to RP25

00001 = Input tied to RP1

00000 = Input tied to RP0

REGISTER 9-8: RPINR20: PERIPHERAL PIN SELECT INPUT REGISTER 20

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			SCK1R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			SDI1R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 SCK1R<4:0>: Assign SPI 1 Clock Input (SCK1IN) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 SDI1R<4:0>: Assign SPI 1 Data Input (SDI1) to the corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

•

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•

00001 = Input tied to RP1 00000 = Input tied to RP0

REGISTER 9-9: RPINR21: PERIPHERAL PIN SELECT INPUT REGISTER 21

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
_	_	_	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
_	_	_			SS1R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-5 **Unimplemented:** Read as '0'

bit 4-0 SS1R<4:0>: Assign SPI1 Slave Select Input (SS1IN) to the Corresponding RPn pin

11111 = Input tied to Vss 11001 = Input tied to RP25

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00001 = Input tied to RP1 00000 = Input tied to RP0

REGISTER 9-10: RPOR0: PERIPHERAL PIN SELECT OUTPUT REGISTERS 0

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP1R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP0R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP1R<4:0>: Peripheral Output Function is Assigned to RP1 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP0R<4:0>: Peripheral Output Function is Assigned to RP0 Output Pin (see Table 9-3 for peripheral

function numbers)

REGISTER 9-11: RPOR1: PERIPHERAL PIN SELECT OUTPUT REGISTERS 1

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP3R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_				RP2R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 RP3R<4:0>: Peripheral Output Function is Assigned to RP3 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP2R<4:0>: Peripheral Output Function is Assigned to RP2 Output Pin (see Table 9-3 for peripheral

function numbers)

REGISTER 9-12: RPOR2: PERIPHERAL PIN SELECT OUTPUT REGISTERS 2

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP5R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP4R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP5R<4:0>: Peripheral Output Function is Assigned to RP5 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP4R<4:0>: Peripheral Output Function is Assigned to RP4 Output Pin (see Table 9-3 for peripheral

function numbers)

REGISTER 9-13: RPOR3: PERIPHERAL PIN SELECT OUTPUT REGISTERS 3

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP7R<4:0>		
bit 15	_				_	_	bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP6R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 RP7R<4:0>: Peripheral Output Function is Assigned to RP7 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP6R<4:0>: Peripheral Output Function is Assigned to RP6 Output Pin (see Table 9-3 for peripheral

function numbers)

REGISTER 9-14: RPOR4: PERIPHERAL PIN SELECT OUTPUT REGISTERS 4

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP9R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP8R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP9R<4:0>: Peripheral Output Function is Assigned to RP9 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP8R<4:0>: Peripheral Output Function is Assigned to RP8 Output Pin (see Table 9-3 for peripheral

function numbers)

REGISTER 9-15: RPOR5: PERIPHERAL PIN SELECT OUTPUT REGISTERS 5

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP11R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP10R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP11R<4:0>: Peripheral Output Function is Assigned to RP11 Output Pin (see Table 9-3 for peripheral

function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP10R<4:0>: Peripheral Output Function is Assigned to RP10 Output Pin (see Table 9-3 for

REGISTER 9-16: RPOR6: PERIPHERAL PIN SELECT OUTPUT REGISTERS 6

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP13R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP12R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 RP13R<4:0>: Peripheral Output Function is Assigned to RP13 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP12R<4:0>: Peripheral Output Function is Assigned to RP12 Output Pin (see Table 9-3 for

peripheral function numbers)

REGISTER 9-17: RPOR7: PERIPHERAL PIN SELECT OUTPUT REGISTERS 7

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP15R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP14R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP15R<4:0>: Peripheral Output Function is Assigned to RP15 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP14R<4:0>: Peripheral Output Function is Assigned to RP14 Output Pin (see Table 9-3 for

REGISTER 9-18: RPOR8: PERIPHERAL PIN SELECT OUTPUT REGISTERS 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_		_			RP17R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP16R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP17R<4:0>: Peripheral Output Function is Assigned to RP15 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP16R<4:0>: Peripheral Output Function is Assigned to RP14 Output Pin (see Table 9-3 for

peripheral function numbers)

REGISTER 9-19: RPOR9: PERIPHERAL PIN SELECT OUTPUT REGISTERS 9

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP19R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_				RP18R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP19R<4:0>: Peripheral Output Function is Assigned to RP19 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP18R<4:0>: Peripheral Output Function is Assigned to RP18 Output Pin (see Table 9-3 for

REGISTER 9-20: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTERS 10

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP21R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP20R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-8 RP21R<4:0>: Peripheral Output Function is Assigned to RP21 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP20R<4:0>: Peripheral Output Function is Assigned to RP20 Output Pin (see Table 9-3 for

peripheral function numbers)

REGISTER 9-21: RPOR11: PERIPHERAL PIN SELECT OUTPUT REGISTERS 11

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP23R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP22R<4:0>		
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12-8 RP23R<4:0>: Peripheral Output Function is Assigned to RP23 Output Pin (see Table 9-3 for

peripheral function numbers)

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 RP22R<4:0>: Peripheral Output Function is Assigned to RP22 Output Pin (see Table 9-3 for

REGISTER 9-22: RPOR12: PERIPHERAL PIN SELECT OUTPUT REGISTERS 12

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP25R<4:0>		
bit 15							bit 8

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_			RP24R<4:0>		
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'
bit 12-8 RP25R<4:0>: Peripheral Output Function is Assigned to RP25 Output Pin (see Table 9-3 for peripheral function numbers)
bit 7-5 Unimplemented: Read as '0'
bit 4-0 RP24R<4:0>: Peripheral Output Function is Assigned to RP24 Output Pin (see Table 9-3 for peripheral function numbers)

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PIC24HJ3	PIC24HJ32GP2U2I2U4 and PIC24HJ16GP3U4									
NOTES:										

10.0 TIMER1

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 11. Timers" (DS70244), which is available from the Microchip website (www.microchip.com).

The Timer1 module is a 16-bit timer, which can serve as the time counter for the real-time clock, or operate as a free-running interval timer/counter. Timer1 can operate in three modes:

- · 16-bit Timer
- · 16-bit Synchronous Counter
- · 16-bit Asynchronous Counter

Timer1 also supports these features:

· Timer gate operation

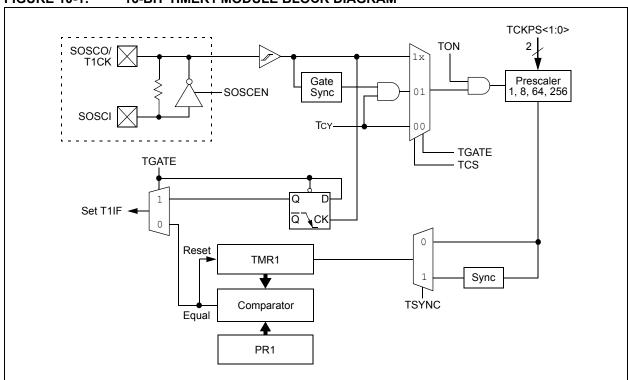
- · Selectable prescaler settings
- Timer operation during CPU Idle and Sleep modes
- Interrupt on 16-bit Period register match or falling edge of external gate signal

Figure 10-1 shows a block diagram of the 16-bit timer module.

To configure Timer1 for operation:

- Set the TON bit (= 1) in the T1CON register.
- Select the timer prescaler ratio using the TCKPS<1:0> bits in the T1CON register.
- 3. Set the Clock and Gating modes using the TCS and TGATE bits in the T1CON register.
- 4. Set or clear the TSYNC bit in T1CON to select synchronous or asynchronous operation.
- Load the timer period value into the PR1 register.
- If interrupts are required, set the interrupt enable bit, T1IE. Use the priority bits, T1IP<2:0>, to set the interrupt priority.

FIGURE 10-1: 16-BIT TIMER1 MODULE BLOCK DIAGRAM



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REGISTER 10-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON	_	TSIDL	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
_	TGATE	TCKPS<1:0>		_	TSYNC	TCS	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 TON: Timer1 On bit

1 = Starts 16-bit Timer1

0 = Stops 16-bit Timer1

bit 14 Unimplemented: Read as '0'

bit 13 TSIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 TGATE: Timer1 Gated Time Accumulation Enable bit

When T1CS = 1: This bit is ignored. When T1CS = 0:

1 = Gated time accumulation enabled 0 = Gated time accumulation disabled

bit 5-4 TCKPS<1:0> Timer1 Input Clock Prescale Select bits

11 = 1:256

10 = 1:64

01 = 1:8

00 = 1:1

bit 3 **Unimplemented:** Read as '0'

bit 2 TSYNC: Timer1 External Clock Input Synchronization Select bit

When TCS = 1:

1 = Synchronize external clock input

0 = Do not synchronize external clock input

When TCS = 0: This bit is ignored.

bit 1 TCS: Timer1 Clock Source Select bit

1 = External clock from pin T1CK (on the rising edge)

0 = Internal clock (FCY)

bit 0 **Unimplemented:** Read as '0'

11.0 TIMER2/3 FEATURE

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 11. Timers" (DS70244), which is available from the Microchip website (www.microchip.com).

The Timer2/3 feature has 32-bit timers that can also be configured as two independent 16-bit timers with selectable operating modes.

As a 32-bit timer, the Timer2/3 feature permits operation in three modes:

- Two Independent 16-bit timers (Timer2 and Timer3) with all 16-bit operating modes (except Asynchronous Counter mode)
- Single 32-bit timer (Timer2/3)
- Single 32-bit synchronous counter (Timer2/3)

The Timer2/3 feature also supports:

- · Timer gate operation
- · Selectable Prescaler Settings
- · Timer operation during Idle and Sleep modes
- · Interrupt on a 32-bit Period Register Match
- Time Base for Input Capture and Output Compare Modules (Timer2 and Timer3 only)
- ADC1 Event Trigger (Timer2/3 only)

Individually, all eight of the 16-bit timers can function as synchronous timers or counters. They also offer the features that are listed above, except for the event trigger. The operating modes and enabled features are determined by setting the appropriate bit(s) in the T2CON and T3CON registers. T2CON registers are shown in generic form in Register 11-1. T3CON registers are shown in Register 11-2.

For 32-bit timer/counter operation, Timer2 is the least significant word (lsw), and Timer3 is the most significant word (msw) of the 32-bit timers.

Note:

For 32-bit operation, T3CON control bits are ignored. Only T2CON control bit is used for setup and control. Timer2 clock and gate inputs are used for the 32-bit timer modules, but an interrupt is generated with the Timer3 interrupt flags.

11.1 32-bit Operation

To configure the Timer2/3 feature for 32-bit operation:

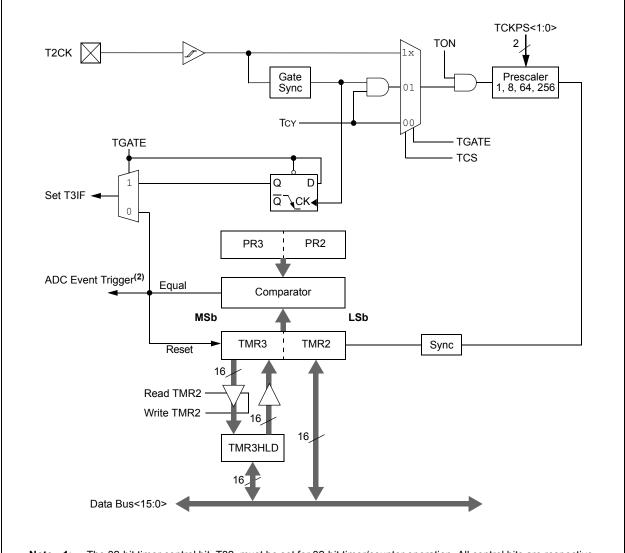
- 1. Set the corresponding T32 control bit.
- Select the prescaler ratio for Timer2 using the TCKPS<1:0> bits.
- Set the Clock and Gating modes using the corresponding TCS and TGATE bits.
- 4. Load the timer period value. PR3 contains the most significant word of the value, while PR2 contains the least significant word.
- Set the interrupt enable bit T3IE, if interrupts are required. Use the priority bits T3IP<2:0> to set the interrupt priority. While Timer2 controls the timer, the interrupt appears as a Timer3 interrupt.
- 6. Set the corresponding TON bit.

The timer value at any point is stored in the register pair TMR3:TMR2. TMR3 always contains the most significant word of the count, while TMR2 contains the least significant word.

To configure any of the timers for individual 16-bit operation:

- 1. Clear the T32 bit corresponding to that timer.
- Select the timer prescaler ratio using the TCKPS<1:0> bits.
- Set the Clock and Gating modes using the TCS and TGATE bits.
- Load the timer period value into the PRx register.
- 5. If interrupts are required, set the interrupt enable bit, TxIE. Use the priority bits, TxIP<2:0>, to set the interrupt priority.
- 6. Set the TON bit.

FIGURE 11-1: TIMER2/3 (32-BIT) BLOCK DIAGRAM⁽¹⁾



- Note 1: The 32-bit timer control bit, T32, must be set for 32-bit timer/counter operation. All control bits are respective to the T2CON register.
 - 2: The ADC event trigger is available only on Timer2/3.

TCKPS<1:0> TON 2 T2CK Prescaler 1, 8, 64, 256 Gate Sync 01 00 TGATE TCS TCY **TGATE** D Q Set T2IF ◀ <u>а</u> √ск 0 Reset TMR2 Sync Comparator Equal PR2

FIGURE 11-2: TIMER2 (16-BIT) BLOCK DIAGRAM

REGISTER 11-1: T2CON CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON	_	TSIDL	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
_	TGATE	TCKPS	S<1:0>	T32 ⁽¹⁾	_	TCS	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

'1' = Bit is set -n = Value at POR '0' = Bit is cleared x = Bit is unknown

bit 15 TON: Timer2 On bit

When T32 = 1:

1 = Starts 32-bit Timer2/3

0 = Stops 32-bit Timer2/3

When T32 = 0:

1 = Starts 16-bit Timer2

0 = Stops 16-bit Timer2

bit 14 Unimplemented: Read as '0'

bit 13 TSIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 Unimplemented: Read as '0'

bit 6 TGATE: Timer2 Gated Time Accumulation Enable bit

> When TCS = 1: This bit is ignored.

When TCS = 0:

1 = Gated time accumulation enabled 0 = Gated time accumulation disabled

bit 5-4 TCKPS<1:0>: Timer2 Input Clock Prescale Select bits

> 11 = 1:25610 = 1:64

01 = 1:800 = 1:1

T32: 32-bit Timer Mode Select bit(1) bit 3

1 = Timer2 and Timer3 form a single 32-bit timer

0 = Timer2 and Timer3 act as two 16-bit timers

bit 2 Unimplemented: Read as '0'

bit 1 TCS: Timer2 Clock Source Select bit

1 = External clock from pin T2CK (on the rising edge)

0 = Internal clock (Fcy)

bit 0 Unimplemented: Read as '0'

Note 1: In 32-bit mode, T3CON control bits do not affect 32-bit timer operation.

REGISTER 11-2: T3CON CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON ⁽¹⁾	_	TSIDL ⁽¹⁾	_	_	_	_	_
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	U-0
_	TGATE ⁽¹⁾	TCKPS:	<1:0> ⁽¹⁾	_	_	TCS ⁽¹⁾	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 **TON:** Timer3 On bit⁽¹⁾

1 = Starts 16-bit Timer3

0 = Stops 16-bit Timer3

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Stop in Idle Mode bit⁽¹⁾

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 Unimplemented: Read as '0'

bit 6 **TGATE:** Timer3 Gated Time Accumulation Enable bit⁽¹⁾

When TCS = 1: This bit is ignored. When TCS = 0:

WHEN ICS - 0.

1 = Gated time accumulation enabled0 = Gated time accumulation disabled

bit 5-4 TCKPS<1:0>: Timer3 Input Clock Prescale Select bits⁽¹⁾

11 = 1:256

10 = 1:64

01 = 1:8

00 = 1:1

bit 3-2 **Unimplemented:** Read as '0'

bit 1 TCS: Timer3 Clock Source Select bit⁽¹⁾

1 = External clock from pin T3CK (on the rising edge)

0 = Internal clock (FCY)

bit 0 **Unimplemented:** Read as '0'

Note 1: When 32-bit operation is enabled (T2CON<3> = 1), these bits have no effect on Timer3 operation; all timer functions are set through T2CON.

PICZ4HJ	PIC24HJ32GP202/204 and PIC24HJ16GP304									
NOTES:										

12.0 INPUT CAPTURE

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 12. Input Capture" (DS70248), which is available from the Microchip website (www.microchip.com).

The input capture module is useful in applications requiring frequency (period) and pulse measurement. The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices support up to eight input capture channels.

The input capture module captures the 16-bit value of the selected Time Base register when an event occurs at the ICx pin. The events that cause a capture event are listed below in three categories:

- · Simple Capture Event modes:
 - Capture timer value on every falling edge of input at ICx pin

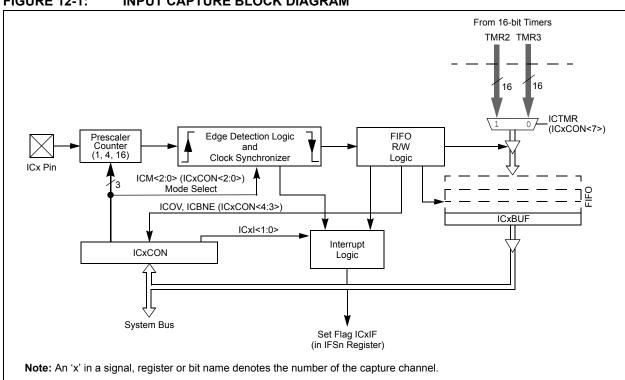
- Capture timer value on every rising edge of input at ICx pin
- Capture timer value on every edge (rising and falling).
- · Prescaler Capture Event modes:
 - Capture timer value on every 4th rising edge of input at ICx pin
 - -Capture timer value on every 16th rising edge of input at ICx pin

Each input capture channel can select one of the two 16-bit timers (Timer2 or Timer3) for the time base. The selected timer can use either an internal or external clock.

Other operational features include:

- Device wake-up from capture pin during CPU Sleep and Idle modes
- · Interrupt on input capture event
- · Four-word FIFO buffer for capture values
 - Interrupt optionally generated after 1, 2, 3 or 4 buffer locations are filled
- Use of input capture to provide additional sources of external interrupts

FIGURE 12-1: INPUT CAPTURE BLOCK DIAGRAM



12.1 Input Capture Registers

REGISTER 12-1: ICxCON: INPUT CAPTURE x CONTROL REGISTER

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	ICSIDL	_	_	_	_	_
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R-0, HC	R-0, HC	R/W-0	R/W-0	R/W-0
ICTMR	ICI<	1:0>	ICOV	ICBNE		ICM<2:0>	
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13 ICSIDL: Input Capture Module Stop in Idle Control bit

1 = Input capture module will halt in CPU Idle mode

0 = Input capture module will continue to operate in CPU Idle mode

bit 12-8 **Unimplemented:** Read as '0'

bit 7 ICTMR: Input Capture Timer Select bits

1 = TMR2 contents are captured on capture event 0 = TMR3 contents are captured on capture event

bit 6-5 ICI<1:0>: Select Number of Captures per Interrupt bits

11 = Interrupt on every fourth capture event
10 = Interrupt on every third capture event
01 = Interrupt on every second capture event
00 = Interrupt on every capture event

bit 4 ICOV: Input Capture Overflow Status Flag bit (read-only)

1 = Input capture overflow occurred0 = No input capture overflow occurred

bit 3 ICBNE: Input Capture Buffer Empty Status bit (read-only)

1 = Input capture buffer is not empty, at least one more capture value can be read

0 = Input capture buffer is empty

bit 2-0 ICM<2:0>: Input Capture Mode Select bits

111 = Input capture functions as interrupt pin only when device is in Sleep or Idle mode (Rising edge detect only, all other control bits are not applicable.)

110 = Unused (module disabled)

101 = Capture mode, every 16th rising edge

100 = Capture mode, every 4th rising edge

011 = Capture mode, every rising edge

010 = Capture mode, every falling edge

001 = Capture mode, every edge (rising and falling)

(ICI<1:0> bits do not control interrupt generation for this mode.)

000 = Input capture module turned off

13.0 OUTPUT COMPARE

Note: This data sheet summarizes the features PIC24HJ32GP202/204 the PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 13. Output Compare" (DS70247), which is available website from the Microchip (www.microchip.com).

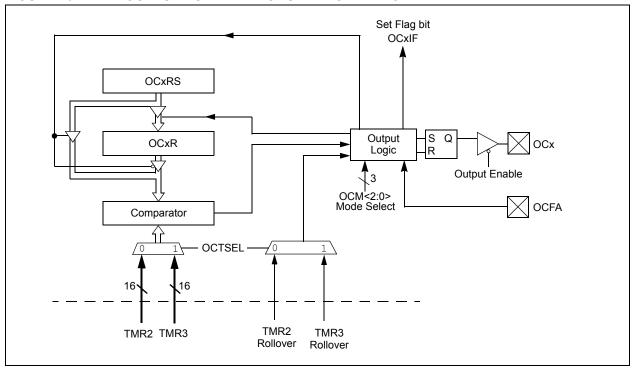
The Output Compare module can select either Timer2 or Timer3 for its time base. The module compares the value of the timer with the value of one or two compare registers depending on the operating mode selected. The state of the output pin changes when the timer

value matches the compare register value. The Output Compare module generates either a single output pulse or a sequence of output pulses, by changing the state of the output pin on the compare match events. The Output Compare module can also generate interrupts on compare match events.

The Output Compare module has multiple operating modes:

- · Active-Low One-Shot mode
- · Active-High One-Shot mode
- · Toggle mode
- · Delayed One-Shot mode
- · Continuous Pulse mode
- · PWM mode without fault protection
- · PWM mode with fault protection

FIGURE 13-1: OUTPUT COMPARE MODULE BLOCK DIAGRAM



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13.1 Output Compare Modes

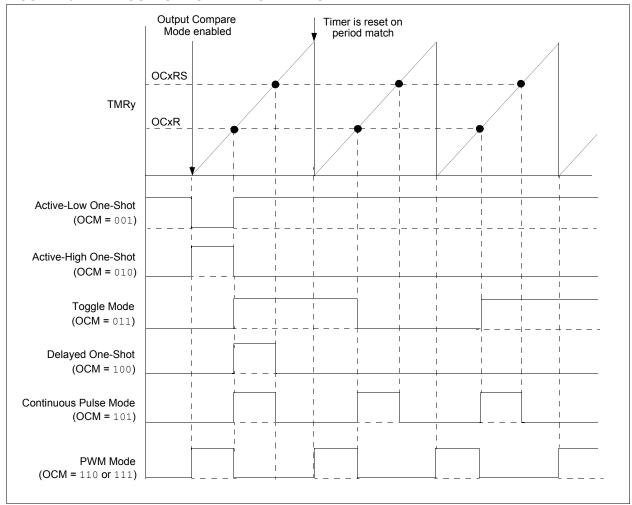
Configure the Output Compare modes by setting the appropriate Output Compare Mode (OCM<2:0>) bits in the Output Compare Control (OCxCON<2:0>) register. Table 13-1 lists the different bit settings for the Output

Compare modes. Figure 13-2 illustrates the output compare operation for various modes. The user application must disable the associated timer when writing to the output compare control registers to avoid malfunctions.

TABLE 13-1: OUTPUT COMPARE MODES

OCM<2:0>	Mode	OCx Pin Initial State	OCx Interrupt Generation
000	Module Disabled	Controlled by GPIO register	_
001	Active-Low One-Shot	0	OCx Rising edge
010	Active-High One-Shot	1	OCx Falling edge
011	Toggle Mode	Current output is maintained	OCx Rising and Falling edge
100	Delayed One-Shot	0	OCx Falling edge
101	Continuous Pulse mode	0	OCx Falling edge
110	PWM mode without fault protection	0, if OCxR is zero 1, if OCxR is non-zero	No interrupt
111	PWM mode with fault protection	0, if OCxR is zero 1, if OCxR is non-zero	OCFA Falling edge for OC1 to OC4

FIGURE 13-2: OUTPUT COMPARE OPERATION



13.2 Output Compare Register

REGISTER 13-1: OCxCON: OUTPUT COMPARE x CONTROL REGISTER

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
_	_	OCSIDL	_	_	_	_	_
bit 15							bit 8

U-0	U-0	U-0	R-0 HC	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	OCFLT	OCTSEL		OCM<2:0>	
bit 7							bit 0

Legend:	HC = Cleared in Hardware	HS = Set in Hardware		
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	ad as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 15-14 Unimplemented: Read as '0'

bit 13 OCSIDL: Stop Output Compare in Idle Mode Control bit

1 = Output Compare x will halt in CPU Idle mode

0 = Output Compare x will continue to operate in CPU Idle mode

bit 12-5 **Unimplemented:** Read as '0'

bit 4 OCFLT: PWM Fault Condition Status bit

1 = PWM Fault condition has occurred (cleared in hardware only)

0 = No PWM Fault condition has occurred (This bit is only used when OCM<2:0> = 111.)

bit 3 OCTSEL: Output Compare Timer Select bit

1 = Timer3 is the clock source for Compare x0 = Timer2 is the clock source for Compare x

bit 2-0 OCM<2:0>: Output Compare Mode Select bits

111 = PWM mode on OCx, Fault pin enabled

110 = PWM mode on OCx, Fault pin disabled

101 = Initialize OCx pin low, generate continuous output pulses on OCx pin

100 = Initialize OCx pin low, generate single output pulse on OCx pin

011 = Compare event toggles OCx pin

010 = Initialize OCx pin high, compare event forces OCx pin low

001 = Initialize OCx pin low, compare event forces OCx pin high

000 = Output compare channel is disabled

NOTES:	

14.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 18. Serial Peripheral Interface (SPI™)" (DS70243), which is available from the Microchip website (www.microchip.com).

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices can be serial EEPROMs, shift registers, display drivers, Analog-to-Digital Converters (ADC) and so on. The SPI module is compatible with SPI and SIOP from Motorola[®].

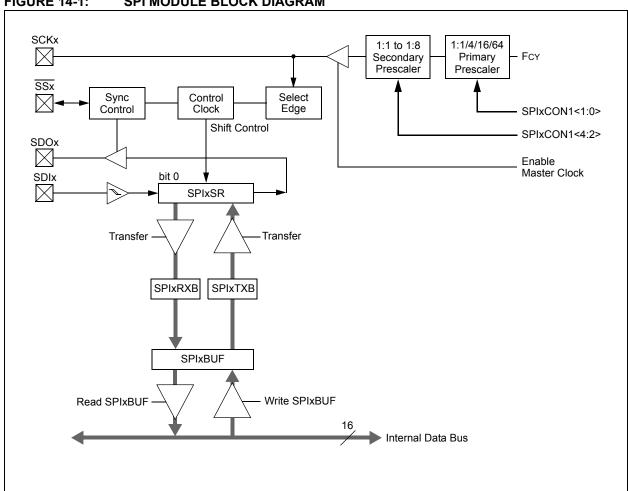
Each SPI module consists of a 16-bit shift register, SPIxSR (where x = 1 or 2), used for shifting data in and out, and a buffer register, SPIxBUF. A control register, SPIxCON, configures the module. Additionally, a status register, SPIxSTAT, indicates status conditions.

The serial interface consists of these four pins:

- · SDIx (serial data input)
- SDOx (serial data output)
- · SCKx (shift clock input or output)
- · SSx (active-low slave select)

In Master mode operation, SCK is a clock output. In Slave mode, it is a clock input.

FIGURE 14-1: SPI MODULE BLOCK DIAGRAM



REGISTER 14-1: SPIXSTAT: SPIX STATUS AND CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
SPIEN	_	SPISIDL	_	_	_	_	_
bit 15							bit 8

U-0	R/C-0	U-0	U-0	U-0	U-0	R-0	R-0
_	SPIROV	_	_	_	_	SPITBF	SPIRBF
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 SPIEN: SPIx Enable bit

1 = Enables module and configures SCKx, SDOx, SDIx and SSx as serial port pins

0 = Disables module

bit 14 **Unimplemented:** Read as '0' bit 13 **SPISIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-7 Unimplemented: Read as '0'

bit 6 SPIROV: Receive Overflow Flag bit

1 = A new byte/word is completely received and discarded. The user software has not read the

previous data in the SPIxBUF register

0 = No overflow has occurred.

bit 5-2 **Unimplemented:** Read as '0'

bit 1 SPITBF: SPIx Transmit Buffer Full Status bit

1 = Transmit not yet started, SPIxTXB is full

0 = Transmit started, SPIxTXB is empty

Automatically set in hardware when CPU writes SPIxBUF location, loading SPIxTXB.

Automatically cleared in hardware when SPIx module transfers data from SPIxTXB to SPIxSR.

bit 0 SPIRBF: SPIx Receive Buffer Full Status bit

1 = Receive complete, SPIxRXB is full

0 = Receive is not complete, SPIxRXB is empty

Automatically set in hardware when SPIx transfers data from SPIxSR to SPIxRXB. Automatically cleared in hardware when core reads SPIxBUF location, reading SPIxRXB.

REGISTER 14-2: SPIXCON1: SPIX CONTROL REGISTER 1

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	DISSCK	DISSDO	MODE16	SMP	CKE ⁽¹⁾
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SSEN	CKP	MSTEN		SPRE<2:0>		PPRE	<1:0>
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 Unimplemented: Read as '0'

bit 12 DISSCK: Disable SCKx pin bit (SPI Master modes only)

1 = Internal SPI clock is disabled, pin functions as I/O

0 = Internal SPI clock is enabled

bit 11 DISSDO: Disable SDOx pin bit

1 = SDOx pin is not used by module; pin functions as I/O

0 = SDOx pin is controlled by the module

bit 10 MODE16: Word/Byte Communication Select bit

1 = Communication is word-wide (16 bits)0 = Communication is byte-wide (8 bits)

bit 9 SMP: SPIx Data Input Sample Phase bit

Master mode:

1 = Input data sampled at end of data output time

0 = Input data sampled at middle of data output time

Slave mode:

SMP must be cleared when SPIx is used in Slave mode.

bit 8 **CKE:** SPIx Clock Edge Select bit⁽¹⁾

1 = Serial output data changes on transition from active clock state to Idle clock state (see bit 6)

0 = Serial output data changes on transition from Idle clock state to active clock state (see bit 6)

bit 7 SSEN: Slave Select Enable bit (Slave mode)

 $1 = \overline{SSx}$ pin used for Slave mode

0 = SSx pin not used by module. Pin controlled by port function

bit 6 **CKP:** Clock Polarity Select bit

1 = Idle state for clock is a high level; active state is a low level

0 = Idle state for clock is a low level; active state is a high level

bit 5 MSTEN: Master Mode Enable bit

1 = Master mode

0 = Slave mode

Note 1: The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).

REGISTER 14-2: SPIXCON1: SPIX CONTROL REGISTER 1 (CONTINUED)

Note 1: The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).

REGISTER 14-3: SPIxCON2: SPIx CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0
FRMEN	SPIFSD	FRMPOL	_	_	_	_	
bit 15 bit 8							

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
_	_	_	_	_	_	FRMDLY	_
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 FRMEN: Framed SPIx Support bit

1 = Framed SPIx support enabled (\overline{SSx} pin used as frame sync pulse input/output)

0 = Framed SPIx support disabled

bit 14 SPIFSD: Frame Sync Pulse Direction Control bit

1 = Frame sync pulse input (slave)0 = Frame sync pulse output (master)

bit 13 FRMPOL: Frame Sync Pulse Polarity bit

1 = Frame sync pulse is active-high0 = Frame sync pulse is active-low

bit 12-2 **Unimplemented:** Read as '0'

bit 1 FRMDLY: Frame Sync Pulse Edge Select bit

1 = Frame sync pulse coincides with first bit clock0 = Frame sync pulse precedes first bit clock

bit 0 **Unimplemented:** This bit must not be set to '1' by the user application

1 102-1110020	JI ZUZIZ	J T alla I	102-1110	1001 00	
NOTES:					

15.0 INTER-INTEGRATED CIRCUIT (I²C™)

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family "Section Reference Manual, 19. Inter-Integrated Circuit (I²C™)" (DS70235), which is available from the Microchip website (www.microchip.com).

The Inter-Integrated Circuit (I^2C) module provides complete hardware support for both Slave and Multi-Master modes of the I^2C serial communication standard, with a 16-bit interface.

The I²C module has a 2-pin interface:

- · The SCLx pin is clock
- · The SDAx pin is data.

The I²C module offers the following key features:

- I²C interface supporting both Master and Slave modes of operation.
- I²C Slave mode supports 7-bit and 10-bit address
- I²C Master mode supports 7-bit and 10-bit address
- I²C port allows bidirectional transfers between master and slaves.
- Serial clock synchronization for I²C port can be used as a handshake mechanism to suspend and resume serial transfer (SCLREL control).
- I²C supports multi-master operation, detects bus collision and arbitrates accordingly.

15.1 Operating Modes

The hardware fully implements all the master and slave functions of the I²C Standard and Fast mode specifications, as well as 7 and 10-bit addressing.

The I^2C module can operate either as a slave or a master on an I^2C bus.

The following types of I²C operation are supported:

- I²C slave operation with 7-bit address
- I²C slave operation with 10-bit address
- I²C master operation with 7-bit or 10-bit address

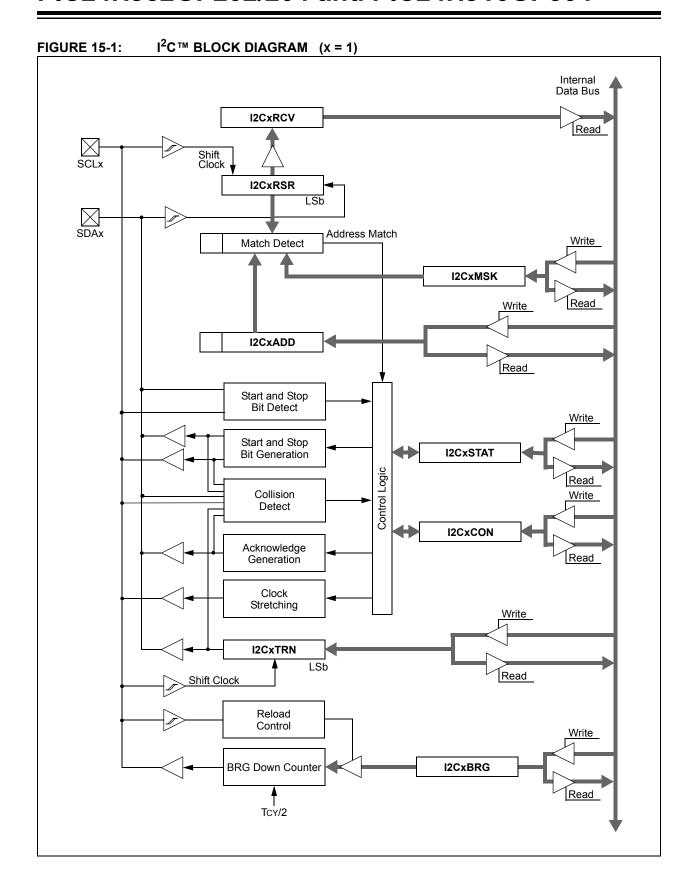
For details about the communication sequence in each of these modes, refer to the "PIC24H Family Reference Manual".

15.2 I²C Registers

I2CxCON and I2CxSTAT are control and status registers, respectively. The I2CxCON register is readable and writable. The lower six bits of I2CxSTAT are read-only. The remaining bits of the I2CSTAT are read/write.

- I2CxRSR is the shift register used for shifting data.
- I2CxRCV is the receive buffer and the register to which data bytes are written, or from which data bytes are read.
- I2CxTRN is the transmit register to which bytes are written during a transmit operation.
- · The I2CxADD register holds the slave address.
- A status bit, ADD10, indicates 10-bit Address mode.
- I2CxBRG acts as the Baud Rate Generator (BRG) reload value.

In receive operations, I2CxRSR and I2CxRCV together form a double-buffered receiver. When I2CxRSR receives a complete byte, it is transferred to I2CxRCV, and an interrupt pulse is generated.



REGISTER 15-1: I2CxCON: I2Cx CONTROL REGISTER

R/W-0	U-0	R/W-0	R/W-1 HC	R/W-0	R/W-0	R/W-0	R/W-0
I2CEN	_	I2CSIDL	SCLREL	IPMIEN	A10M	DISSLW	SMEN
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0 HC				
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

Legend:	U = Unimplemented bit, re	U = Unimplemented bit, read as '0'						
R = Readable bit	W = Writable bit	W = Writable bit HS = Set in hardware HC = Cleared in hardware						
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown					

bit 15 I2CEN: I2Cx Enable bit

1 = Enables the I2Cx module and configures the SDAx and SCLx pins as serial port pins

0 = Disables the I2Cx module. All I²C pins are controlled by port functions

bit 14 **Unimplemented:** Read as '0'

bit 13 I2CSIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters an Idle mode

0 = Continue module operation in Idle mode

bit 12 **SCLREL:** SCLx Release Control bit (when operating as I²C slave)

1 = Release SCLx clock

0 = Hold SCLx clock low (clock stretch)

If STREN = 1:

Bit is R/W (i.e., software can write '0' to initiate stretch and write '1' to release clock). Hardware clear at beginning of slave transmission. Hardware clear at end of slave reception.

If STREN = 0:

Bit is R/S (i.e., software can only write '1' to release clock). Hardware clear at beginning of slave transmission.

bit 11 IPMIEN: Intelligent Peripheral Management Interface (IPMI) Enable bit

1 = IPMI mode is enabled; all addresses Acknowledged

0 = IPMI mode disabled

bit 10 A10M: 10-bit Slave Address bit

1 = I2CxADD is a 10-bit slave address

0 = I2CxADD is a 7-bit slave address

bit 9 DISSLW: Disable Slew Rate Control bit

1 = Slew rate control disabled

0 = Slew rate control enabled

bit 8 SMEN: SMBus Input Levels bit

1 = Enable I/O pin thresholds compliant with SMBus specification

0 = Disable SMBus input thresholds

bit 7 **GCEN:** General Call Enable bit (when operating as I²C slave)

1 = Enable interrupt when a general call address is received in the I2CxRSR

(module is enabled for reception)

0 = General call address disabled

bit 6 STREN: SCLx Clock Stretch Enable bit (when operating as I²C slave)

Used in conjunction with SCLREL bit.

1 = Enable software or receive clock stretching

0 = Disable software or receive clock stretching

REGISTER 15-1: I2CxCON: I2Cx CONTROL REGISTER (CONTINUED)

ACKDT: Acknowledge Data bit (when operating as I²C master, applicable during master receive) bit 5 Value that will be transmitted when the software initiates an Acknowledge sequence. 1 = Send NACK during Acknowledge 0 = Send ACK during Acknowledge bit 4 ACKEN: Acknowledge Sequence Enable bit (when operating as I²C master, applicable during master receive) 1 = Initiate Acknowledge sequence on SDAx and SCLx pins and transmit ACKDT data bit. Hardware clear at end of master Acknowledge sequence 0 = Acknowledge sequence not in progress **RCEN:** Receive Enable bit (when operating as I²C master) bit 3 1 = Enables Receive mode for I²C. Hardware clear at end of eighth bit of master receive data byte 0 = Receive sequence not in progress bit 2 **PEN:** Stop Condition Enable bit (when operating as I²C master) 1 = Initiate Stop condition on SDAx and SCLx pins. Hardware clear at end of master Stop sequence 0 = Stop condition not in progress **RSEN:** Repeated Start Condition Enable bit (when operating as I²C master) bit 1 1 = Initiate Repeated Start condition on SDAx and SCLx pins. Hardware clear at end of master Repeated Start sequence 0 = Repeated Start condition not in progress

1 = Initiate Start condition on SDAx and SCLx pins. Hardware clear at end of master Start sequence

0 = Start condition not in progress

bit 0

REGISTER 15-2: I2CxSTAT: I2Cx STATUS REGISTER

R-0 HSC	R-0 HSC	U-0	U-0	U-0	R/C-0 HS	R-0 HSC	R-0 HSC
ACKSTAT	TRSTAT	_	_	_	BCL	GCSTAT	ADD10
bit 15							bit 8

R/C-0 HS	R/C-0 HS	R-0 HSC	R/C-0 HSC	R/C-0 HSC	R-0 HSC	R-0 HSC	R-0 HSC
IWCOL	I2COV	D_A	Р	S	R_W	RBF	TBF
bit 7							bit 0

Legend:	U = Unimplemented bit, read as '0'					
R = Readable bit	W = Writable bit HS = Set in hardware HSC = Hardware set/cleared					
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown			

bit 15 ACKSTAT: Acknowledge Status bit

(when operating as I²C master, applicable to master transmit operation)

1 = NACK received from slave

0 = ACK received from slave

Hardware set or clear at end of slave Acknowledge.

bit 14 **TRSTAT:** Transmit Status bit (when operating as I²C master, applicable to master transmit operation)

1 = Master transmit is in progress (8 bits + ACK)

0 = Master transmit is not in progress

Hardware set at beginning of master transmission. Hardware clear at end of slave Acknowledge.

bit 13-11 **Unimplemented:** Read as '0'

bit 10 BCL: Master Bus Collision Detect bit

1 = A bus collision has been detected during a master operation

0 = No collision

Hardware set at detection of bus collision.

bit 9 GCSTAT: General Call Status bit

1 = General call address was received

0 = General call address was not received

Hardware set when address matches general call address. Hardware clear at Stop detection.

bit 8 ADD10: 10-bit Address Status bit

1 = 10-bit address was matched

0 = 10-bit address was not matched

Hardware set at match of 2nd byte of matched 10-bit address. Hardware clear at Stop detection.

bit 7 **IWCOL:** Write Collision Detect bit

1 = An attempt to write the I2CxTRN register failed because the I²C module is busy

0 = No collision

Hardware set at occurrence of write to I2CxTRN while busy (cleared by software).

bit 6 I2COV: Receive Overflow Flag bit

1 = A byte was received while the I2CxRCV register is still holding the previous byte

0 = No overflow

Hardware set at attempt to transfer I2CxRSR to I2CxRCV (cleared by software).

bit 5 **D_A:** Data/Address bit (when operating as I²C slave)

1 = Indicates that the last byte received was data

0 = Indicates that the last byte received was device address

Hardware clear at device address match. Hardware set by reception of slave byte.

bit 4 **P:** Stop bit

1 = Indicates that a Stop bit has been detected last

0 = Stop bit was not detected last

Hardware set or clear when Start, Repeated Start or Stop detected.

REGISTER 15-2: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)

bit 3 S: Start bit

1 = Indicates that a Start (or Repeated Start) bit has been detected last

0 = Start bit was not detected last

Hardware set or clear when Start, Repeated Start or Stop detected.

bit 2 **R_W**: Read/Write Information bit (when operating as I²C slave)

1 = Read – indicates data transfer is output from slave 0 = Write – indicates data transfer is input to slave

Hardware set or clear after reception of I²C device address byte.

bit 1 RBF: Receive Buffer Full Status bit

1 = Receive complete, I2CxRCV is full

0 = Receive not complete, I2CxRCV is empty

Hardware set when I2CxRCV is written with received byte. Hardware clear when software

reads I2CxRCV.

bit 0 TBF: Transmit Buffer Full Status bit

1 = Transmit in progress, I2CxTRN is full

0 = Transmit complete, I2CxTRN is empty

Hardware set when software writes I2CxTRN. Hardware clear at completion of data transmission.

REGISTER 15-3: I2CxMSK: I2Cx SLAVE MODE ADDRESS MASK REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
_	_	_	_	_	_	AMSK9	AMSK8
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| AMSK7 | AMSK6 | AMSK5 | AMSK4 | AMSK3 | AMSK2 | AMSK1 | AMSK0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-10 Unimplemented: Read as '0'

bit 9-0 AMSKx: Mask for Address bit x Select bit

1 = Enable masking for bit x of incoming message address; bit match not required in this position

0 = Disable masking for bit x; bit match required in this position

NOTES:			

16.0 UNIVERSAL ASYNCHRONOUS RECEIVER TRANSMITTER (UART)

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 17. UART" (DS70232), which is available from the Microchip website (www.microchip.com).

The Universal Asynchronous Receiver Transmitter (UART) module is one of the serial I/O modules available in the PIC24HJ32GP202/204 and PIC24HJ16GP304 device family. The UART is a full-duplex asynchronous system that can communicate with peripheral devices, such as personal computers, LIN, RS-232 and RS-485 interfaces. The module also supports a hardware flow control option with the UxCTS and UxRTS pins and also includes an IrDA® encoder and decoder.

The primary features of the UART module are:

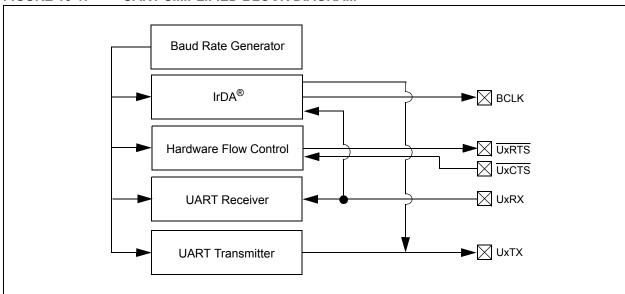
- Full-Duplex 8- or 9-bit Data Transmission through the UxTX and UxRX pins
- Even, odd or no parity options (for 8-bit data)
- · One or two stop bits

- Hardware Flow Control Option with UxCTS and UxRTS pins
- Fully Integrated Baud Rate Generator with 16-bit prescaler
- Baud rates ranging from 1 Mbps to 15 bps at 16x mode at 40 MIPS
- Baud rates ranging from 4 Mbps to 61 bps at 4x mode at 40 MIPS
- 4-deep first-in-first-out (FIFO) Transmit Data Buffer
- · 4-Deep FIFO Receive Data Buffer
- · Parity, framing and buffer overrun error detection
- Support for 9-bit mode with Address Detect (9th bit = 1)
- Transmit and Receive interrupts
- · A separate interrupt for all UART error conditions
- Loopback mode for diagnostic support
- · Support for Sync and Break characters
- · Support for automatic baud rate detection
- · IrDA encoder and decoder logic
- · 16x baud clock output for IrDA support

A simplified block diagram of the UART module is shown in Figure 16-1. The UART module consists of the following key hardware elements:

- · Baud Rate Generator
- · Asynchronous Transmitter
- · Asynchronous Receiver

FIGURE 16-1: UART SIMPLIFIED BLOCK DIAGRAM



REGISTER 16-1: UXMODE: UARTX MODE REGISTER

R/W-0	U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
UARTEN	_	USIDL	IREN ⁽¹⁾	RTSMD	_	UEN:	<1:0>
bit 15							bit 8

R/W-0 HC	R/W-0	R/W-0 HC	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WAKE	LPBACK	ABAUD	URXINV	BRGH	PDSEL	_<1:0>	STSEL
bit 7							bit 0

Legend:	HC = Hardware cleared		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	I as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **UARTEN:** UARTx Enable bit

1 = UARTx is enabled; all UARTx pins are controlled by UARTx as defined by UEN<1:0>

0 = UARTx is disabled; all UARTx pins are controlled by port latches; UARTx power consumption

minimal

bit 14 **Unimplemented:** Read as '0'

bit 13 USIDL: Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12 IREN: IrDA Encoder and Decoder Enable bit⁽¹⁾

1 = IrDA encoder and decoder enabled0 = IrDA encoder and decoder disabled

bit 11 RTSMD: Mode Selection for UxRTS Pin bit

 $1 = \overline{\text{UxRTS}} \text{ pin in Simplex mode}$ $0 = \overline{\text{UxRTS}} \text{ pin in Flow Control mode}$

bit 10 **Unimplemented:** Read as '0'

bit 9-8 **UEN<1:0>:** UARTx Enable bits

11 = UxTX, UxRX and BCLK pins are enabled and used; UxCTS pin controlled by port latches

10 = UxTX, UxRX, $\overline{\text{UxCTS}}$ and $\overline{\text{UxRTS}}$ pins are enabled and used

01 = UxTX, UxRX and UxRTS pins are enabled and used; UxCTS pin controlled by port latches

00 = UxTX and UxRX pins are enabled and used; UxCTS and UxRTS/BCLK pins controlled by port latches

bit 7 WAKE: Wake-up on Start bit Detect During Sleep Mode Enable bit

1 = UARTx will continue to sample the UxRX pin; interrupt generated on falling edge; bit cleared in hardware on following rising edge

0 = No wake-up enabled

bit 6 LPBACK: UARTx Loopback Mode Select bit

1 = Enable Loopback mode0 = Loopback mode is disabled

ADALID: Auto Doud Frankla hit

ABAUD: Auto-Baud Enable bit

1 = Enable baud rate measurement on the next character – requires reception of a Sync field (55h) before other data; cleared in hardware upon completion

0 = Baud rate measurement disabled or completed

bit 4 URXINV: Receive Polarity Inversion bit

1 = UxRX Idle state is '0' 0 = UxRX Idle state is '1'

Note 1: This feature is only available for the 16x BRG mode (BRGH = 0).

bit 5

REGISTER 16-1: UXMODE: UARTX MODE REGISTER (CONTINUED)

bit 3 BRGH: High Baud Rate Enable bit

1 = BRG generates 4 clocks per bit period (4x baud clock, High-Speed mode)
 0 = BRG generates 16 clocks per bit period (16x baud clock, Standard mode)

bit 2-1 PDSEL<1:0>: Parity and Data Selection bits

11 = 9-bit data, no parity 10 = 8-bit data, odd parity 01 = 8-bit data, even parity 00 = 8-bit data, no parity

bit 0 STSEL: Stop Bit Selection bit

1 = Two Stop bits0 = One Stop bit

Note 1: This feature is only available for the 16x BRG mode (BRGH = 0).

REGISTER 16-2: UxSTA: UARTx STATUS AND CONTROL REGISTER

R/W-0	R/W-0	R/W-0	U-0	R/W-0 HC	R/W-0	R-0	R-1
UTXISEL1	UTXINV ⁽¹⁾	UTXISEL0	_	UTXBRK	UTXEN	UTXBF	TRMT
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R-1	R-0	R-0	R/C-0	R-0
URXISE	L<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA
bit 7		•					bit 0

 Legend:
 HC = Hardware cleared

 R = Readable bit
 W = Writable bit
 U = Unimplemented bit, read as '0'

 -n = Value at POR
 '1' = Bit is set
 '0' = Bit is cleared
 x = Bit is unknown

- bit 15,13 UTXISEL<1:0>: Transmission Interrupt Mode Selection bits
 - 11 = Reserved; do not use
 - 10 = Interrupt when a character is transferred to the Transmit Shift Register, and as a result, the transmit buffer becomes empty
 - 01 = Interrupt when the last character is shifted out of the Transmit Shift Register; all transmit operations are completed
 - 00 = Interrupt when a character is transferred to the Transmit Shift Register (this implies there is at least one character open in the transmit buffer)
- bit 14 UTXINV: Transmit Polarity Inversion bit
 - 1 = UxTX Idle state is '1'
 - 0 = UxTX Idle state is '0'
- bit 12 **Unimplemented:** Read as '0'
- bit 11 UTXBRK: Transmit Break bit
 - 1 = Send Sync Break on next transmission Start bit, followed by twelve '0' bits, followed by Stop bit; cleared by hardware upon completion
 - 0 = Sync Break transmission disabled or completed
- bit 10 UTXEN: Transmit Enable bit
 - 1 = Transmit enabled, UxTX pin controlled by UARTx
 - 0 = Transmit disabled, any pending transmission is aborted and buffer is reset. UxTX pin controlled by port
- bit 9 UTXBF: Transmit Buffer Full Status bit (read-only)
 - 1 = Transmit buffer is full
 - 0 = Transmit buffer is not full, at least one more character can be written
- bit 8 **TRMT:** Transmit Shift Register Empty bit (read-only)
 - 1 = Transmit Shift Register is empty and transmit buffer is empty (the last transmission has completed)
 - 0 = Transmit Shift Register is not empty, a transmission is in progress or queued
- bit 7-6 **URXISEL<1:0>:** Receive Interrupt Mode Selection bits
 - 11 = Interrupt is set on UxRSR transfer making the receive buffer full (i.e., has 4 data characters)
 - 10 = Interrupt is set on UxRSR transfer making the receive buffer 3/4 full (i.e., has 3 data characters)
 - 0x = Interrupt is set when any character is received and transferred from the UxRSR to the receive buffer. Receive buffer has one or more characters
- bit 5 **ADDEN:** Address Character Detect bit (bit 8 of received data = 1)
 - 1 = Address Detect mode enabled. If 9-bit mode is not selected, this does not take effect
 - 0 = Address Detect mode disabled
 - **Note 1:** Value of bit only affects the transmit properties of the module when the IrDA encoder is enabled (IREN = 1).

REGISTER 16-2: UxSTA: UARTx STATUS AND CONTROL REGISTER (CONTINUED)

bit 4	RIDLE: Receiver Idle bit (read-only)
	1 = Receiver is Idle
	0 = Receiver is active
bit 3	PERR: Parity Error Status bit (read-only)
	 1 = Parity error has been detected for the current character (character at the top of the receive FIFO) 0 = Parity error has not been detected
bit 2	FERR: Framing Error Status bit (read-only)
	1 = Framing error has been detected for the current character (character at the top of the receive FIFO)
	0 = Framing error has not been detected
bit 1	OERR: Receive Buffer Overrun Error Status bit (read/clear only)
	1 = Receive buffer has overflowed

- the receiver buffer and the UxRSR to the empty state **URXDA:** Receive Buffer Data Available bit (read-only)
- 1 = Receive buffer has data, at least one more character can be read
- 0 = Receive buffer is empty

bit 0

Note 1: Value of bit only affects the transmit properties of the module when the IrDA encoder is enabled (IREN = 1).

0 = Receive buffer has not overflowed. Clearing a previously set OERR bit ($1 \rightarrow 0$ transition) will reset

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17.0 10-BIT/12-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the PIC24H Family Reference Manual, "Section 16. Analog-to-Digital Converter (ADC) with DMA" (DS70225), which is available from the Microchip website (www.microchip.com).

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices have up to 13 Analog-to-Digital Conversion (ADC) module input channels.

The AD12B bit (AD1CON1<10>) allows each of the ADC modules to be configured as either a 10-bit, 4-sample-and-hold ADC (default configuration), or a 12-bit, 1-sample-and-hold ADC.

Note: The ADC module must be disabled before the AD12B bit can be modified.

17.1 Key Features

The 10-bit ADC configuration has the following key features:

- · Successive Approximation (SAR) conversion
- · Conversion speeds of up to 1.1 Msps
- · Up to 13 analog input pins
- · External voltage reference input pins
- Simultaneous sampling of up to four analog input pins
- · Automatic Channel Scan mode
- · Selectable conversion trigger source
- · Selectable Buffer Fill modes
- · Operation during CPU Sleep and Idle modes
- · 16-word conversion result buffer

The 12-bit ADC configuration supports all the above features, except:

- In the 12-bit configuration, conversion speeds of up to 500 ksps are supported.
- There is only 1 sample-and-hold amplifier in the 12-bit configuration, so simultaneous sampling of multiple channels is not supported.

Depending on the particular device pinout, the ADC can have up to 13 analog input pins, designated AN0 through AN12. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs can be shared with other analog input pins.

The actual number of analog input pins and external voltage reference input configuration will depend on the specific device. Refer to the device data sheet for further details.

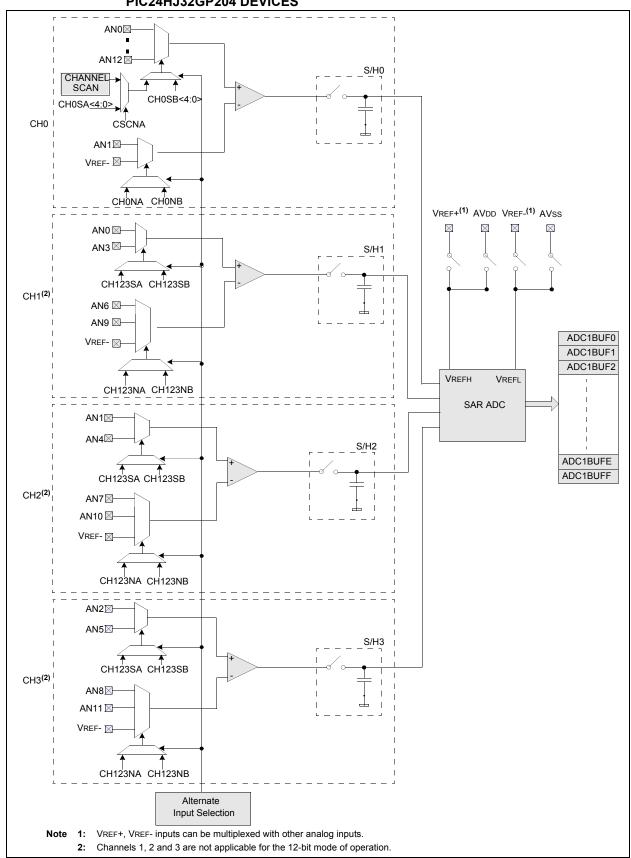
A block diagram of ADC for PIC24HJ16GP304 and PIC24HJ32GP204 devices is shown in Figure 17-1. A block diagram of the ADC for the PIC24HJ32GP202 device is shown in Figure 17-2.

17.2 ADC Initialization

To configure the ADC module:

- 1. Select port pins as analog inputs (AD1PCFGH<15:0> or AD1PCFGL<15:0>).
- Select voltage reference source to match expected range on analog inputs (AD1CON2<15:13>).
- Select the analog conversion clock to match desired data rate with processor clock (AD1CON3<7:0>).
- Determine how many sample-and-hold channels will be used (AD1CON2<9:8> and AD1PCFGH<15:0> or AD1PCFGL<15:0>).
- 5. Select the appropriate sample/conversion sequence (AD1CON1<7:5> and AD1CON3<12:8>).
- Select the way conversion results are presented in the buffer (AD1CON1<9:8>).
- 7. Turn on the ADC module (AD1CON1<15>).
- 8. Configure ADC interrupt (if required):
 - a) Clear the AD1IF bit.
 - b) Select ADC interrupt priority.

FIGURE 17-1: ADC1 MODULE BLOCK DIAGRAM FOR PIC24HFJ16GP304 AND PIC24HJ32GP204 DEVICES



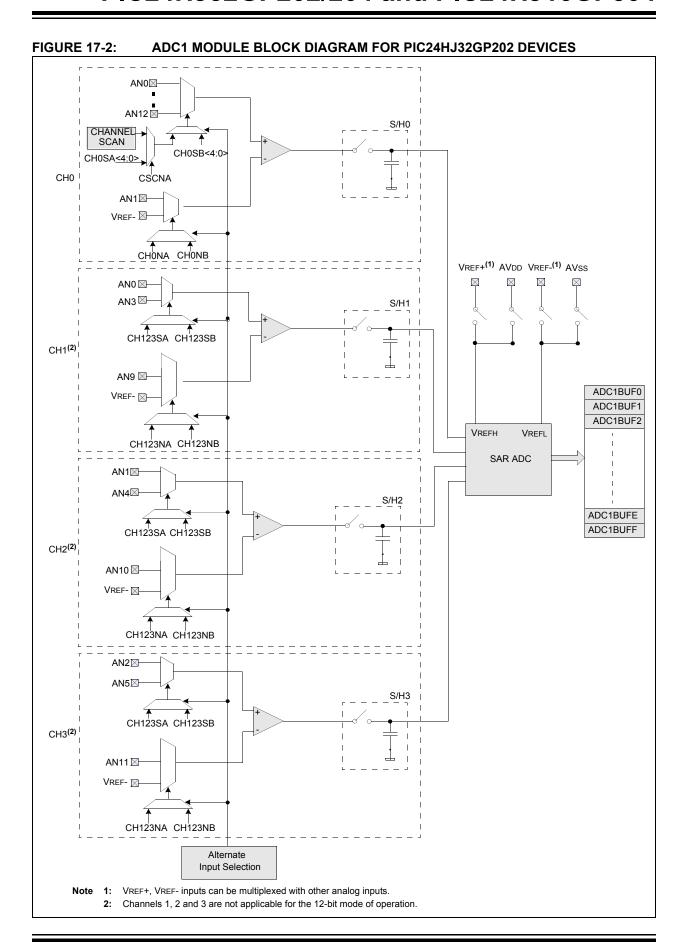
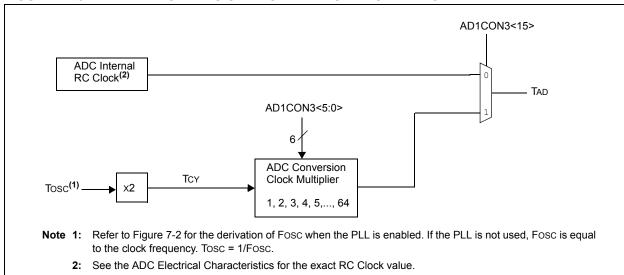


FIGURE 17-3: ADC CONVERSION CLOCK PERIOD BLOCK DIAGRAM



REGISTER 17-1: AD1CON1: ADC1 CONTROL REGISTER 1

R/W-0	U-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
ADON	_	ADSIDL	_	_	AD12B	FORM	1<1:0>
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0 HC,HS	R/C-0 HC, HS
	SSRC<2:0>		_	SIMSAM	ASAM	SAMP	DONE
bit 7							bit 0

Legend: HC = Cleared by hardware		HS = Set by hardware			
R = Readable bit	W = Writable bit	U = Unimplemented bit, rea	nd as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown		

bit 15 ADON: ADC Operating Mode bit

1 = ADC module is operating

0 = ADC is off

bit 14 **Unimplemented:** Read as '0' bit 13 **ADSIDL:** Stop in Idle Mode bit

1 = Discontinue module operation when device enters Idle mode

0 = Continue module operation in Idle mode

bit 12-11 **Unimplemented:** Read as '0'

bit 10 AD12B: 10-bit or 12-bit Operation Mode bit

1 = 12-bit, 1-channel ADC operation0 = 10-bit, 4-channel ADC operation

bit 9-8 **FORM<1:0>:** Data Output Format bits

For 10-bit operation:

11 = Reserved

10 = Reserved

01 = Signed integer (Dout = ssss sssd dddd dddd, where s = .NOT.d<9>)

00 = Integer (Dout = 0000 00dd dddd dddd)

For 12-bit operation:

11 = Reserved

10 = Reserved

01 = Signed Integer (Dout = ssss sddd dddd dddd, where s = .NOT.d<11>)

00 = Integer (Dout = 0000 dddd dddd dddd)

bit 7-5 SSRC<2:0>: Sample Clock Source Select bits

111 = Internal counter ends sampling and starts conversion (auto-convert)

110 = Reserved

101 = Reserved

100 = Reserved

011 = Reserved

010 = GP timer 3 compare ends sampling and starts conversion

001 = Active transition on INT0 pin ends sampling and starts conversion

000 = Clearing sample bit ends sampling and starts conversion

bit 4 Unimplemented: Read as '0'

bit 3 SIMSAM: Simultaneous Sample Select bit (applicable only when CHPS<1:0> = 01 or 1x)

When AD12B = 1, SIMSAM is: U-0, Unimplemented, Read as '0'

1 = Samples CH0, CH1, CH2, CH3 simultaneously (when CHPS<1:0> = 1x); or

Samples CH0 and CH1 simultaneously (when CHPS<1:0> = 01)

0 = Samples multiple channels individually in sequence

REGISTER 17-1: AD1CON1: ADC1 CONTROL REGISTER 1 (CONTINUED)

bit 2 **ASAM:** ADC Sample Auto-Start bit

1 = Sampling begins immediately after last conversion. SAMP bit is auto-set

0 = Sampling begins when SAMP bit is set

bit 1 SAMP: ADC Sample Enable bit

> 1 = ADC sample-and-hold amplifiers are sampling 0 = ADC sample-and-hold amplifiers are holding

If ASAM = 0, software can write '1' to begin sampling. Automatically set by hardware if ASAM = 1. If SSRC = 000, software can write '0' to end sampling and start conversion. If SSRC ≠ 000,

automatically cleared by hardware to end sampling and start conversion.

bit 0 DONE: ADC Conversion Status bit

1 = ADC conversion cycle is completed

0 = ADC conversion not started or in progress

Automatically set by hardware when ADC conversion is complete. Software can write '0' to clear DONE status (software not allowed to write '1'). Clearing this bit will NOT affect any operation in prog-

ress. Automatically cleared by hardware at start of a new conversion.

REGISTER 17-2: AD1CON2: ADC1 CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0
	VCFG<2:0>		_	_	CSCNA	CHPS	i<1:0>
bit 15							bit 8

R-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
BUFS	_		SMPI	<3:0>		BUFM	ALTS
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 VCFG<2:0>: Converter Voltage Reference Configuration bits

	ADREF+	ADREF-
000	AVDD	Avss
001	External VREF+	Avss
010	Avdd	External VREF-
011	External VREF+	External VREF-
1xx	Avdd	Avss

bit 12-11 Unimplemented: Read as '0'

bit 10 CSCNA: Scan Input Selections for CH0+ during Sample A bit

1 = Scan inputs

0 = Do not scan inputs

bit 9-8 CHPS<1:0>: Select Channels Utilized bits

When AD12B = 1, CHPS<1:0> is: U-0, Unimplemented, Read as '0'

1x = Converts CH0, CH1, CH2 and CH3

01 = Converts CH0 and CH1

00 = Converts CH0

bit 7 **BUFS:** Buffer Fill Status bit (valid only when BUFM = 1)

1 = ADC is currently filling second half of buffer, user application should access data in the first half

0 = ADC is currently filling first half of buffer, user application should access data in the second half

bit 6 **Unimplemented:** Read as '0'

bit 5-2 SMPI<3:0>: Sample/Convert Sequences Per Interrupt Selection bits

1111 = Interrupts at the completion of conversion for each 16th sample/convert sequence

1110 = Interrupts at the completion of conversion for each 15th sample/convert sequence

•

0001 = Interrupts at the completion of conversion for each 2nd sample/convert sequence

0000 = Interrupts at the completion of conversion for each sample/convert sequence

bit 1 **BUFM:** Buffer Fill Mode Select bit

1 = Starts filling first half of buffer on first interrupt and the second half of buffer on next interrupt

0 = Always starts filling buffer from the beginning

bit 0 ALTS: Alternate Input Sample Mode Select bit

1 = Uses channel input selects for Sample A on first sample and Sample B on next sample

0 = Always uses channel input selects for Sample A

REGISTER 17-3: AD1CON3: ADC1 CONTROL REGISTER 3

R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ADRC	_	_			SAMC<4:0>		
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| | | | ADCS: | <7:0> | | | |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 ADRC: ADC Conversion Clock Source bit

1 = ADC internal RC clock

0 = Clock derived from system clock

bit 14-13 Unimplemented: Read as '0'

bit 12-8 **SAMC<4:0>:** Auto Sample Time bits

11111 **= 31 T**AD

•

• 00001 = 1 TAD

00000 **= 0** TAD

bit 7-0 ADCS<7:0>: ADC Conversion Clock Select bits

111111111 = Tcy · (ADCS<7:0> + 1) = 256 · Tcy = TAD

•

•

 $00000010 = Tcy \cdot (ADCS < 7:0 > + 1) = 3 \cdot Tcy = Tad$

 $00000001 = Tcy \cdot (ADCS < 7:0 > + 1) = 2 \cdot Tcy = TaD$

 $000000000 = Tcy \cdot (ADCS < 7:0 > + 1) = 1 \cdot Tcy = TaD$

REGISTER 17-4: AD1CHS123: ADC1 INPUT CHANNEL 1, 2, 3 SELECT REGISTER

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	_	_	-	-	CH123N	IB<1:0>	CH123SB
bit 15		_			_		bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
_	_	_	_	_	CH123N	IA<1:0>	CH123SA
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-11 **Unimplemented:** Read as '0'

bit 10-9 CH123NB<1:0>: Channel 1, 2, 3 Negative Input Select for Sample B bits

PIC24HJ32GP202 devices only:

<u>If AD12B = 1:</u>

11 = Reserved

10 = Reserved

01 = Reserved 00 = Reserved

If AD12B = 0:

11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is AN11

10 = Reserved

01 = CH1, CH2, CH3 negative input is VREF-

00 = CH1, CH2, CH3 negative input is VREF-

PIC24HJ32GP204 and PIC24HJ16GP304 devices only:

If AD12B = 1:

11 = Reserved

10 = Reserved

01 = Reserved

00 = Reserved

If AD12B = 0:

11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is AN11

10 = CH1 negative input is AN6, CH2 negative input is AN7, CH3 negative input is AN8

01 = CH1, CH2, CH3 negative input is VREF-

00 = CH1, CH2, CH3 negative input is VREF-

bit 8 CH123SB: Channel 1, 2, 3 Positive Input Select for Sample B bit

<u>If AD12B = 1:</u>

1 = Reserved

0 = Reserved

If AD12B = 0:

1 = CH1 positive input is AN3, CH2 positive input is AN4, CH3 positive input is AN5

0 = CH1 positive input is AN0, CH2 positive input is AN1, CH3 positive input is AN2

bit 7-3 **Unimplemented:** Read as '0'

REGISTER 17-4: AD1CHS123: ADC1 INPUT CHANNEL 1, 2, 3 SELECT REGISTER (CONTINUED)

bit 2-1 CH123NA<1:0>: Channel 1, 2, 3 Negative Input Select for Sample A bits

PIC24HJ32GP202 devices only:

If AD12B = 1:

- 11 = Reserved
- 10 = Reserved
- 01 = Reserved
- 00 = Reserved

If AD12B = 0:

- 11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is AN11
- 10 = Reserved
- 01 = CH1, CH2, CH3 negative input is VREF-
- 00 = CH1, CH2, CH3 negative input is VREF-

PIC24HJ32GP204 and PIC24HJ16GP304 devices only:

If AD12B = 1:

- 11 = Reserved
- 10 = Reserved
- 01 = Reserved
- 00 = Reserved

If AD12B = 0:

- 11 = CH1 negative input is AN9, CH2 negative input is AN10, CH3 negative input is AN11
- 10 = CH1 negative input is AN6, CH2 negative input is AN7, CH3 negative input is AN8
- 01 = CH1, CH2, CH3 negative input is VREF-
- 00 = CH1, CH2, CH3 negative input is VREF-

bit 0 CH123SA: Channel 1, 2, 3 Positive Input Select for Sample A bit

If AD12B = 1:

- 1 = Reserved
- 0 = Reserved

If AD12B = 0:

- 1 = CH1 positive input is AN3, CH2 positive input is AN4, CH3 positive input is AN5
- $_{\mathrm{0}}$ = CH1 positive input is AN0, CH2 positive input is AN1, CH3 positive input is AN2

REGISTER 17-5: AD1CHS0: ADC1 INPUT CHANNEL 0 SELECT REGISTER

R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NB	_	_			CH0SB<4:0>		
bit 15							bit 8

R/W-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CH0NA	_	_			CH0SA<4:0>		
bit 7							bit 0

Legend:

bit 14-13

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15 CH0NB: Channel 0 Negative Input Select for Sample B bit

1 = Channel 0 negative input is AN10 = Channel 0 negative input is VREF-

Unimplemented: Read as '0'

bit 12-8 CH0SB<4:0>: Channel 0 Positive Input Select for Sample B bits

PIC24HJ32GP204 and PIC24HJ16GP304 devices only:

01100 = Channel 0 positive input is AN12

.

.

00010 = Channel 0 positive input is AN2

00001 = Channel 0 positive input is AN1

00000 = Channel 0 positive input is AN0

PIC24HJ32GP202 devices only:

01100 = Channel 0 positive input is AN12

_

•

01000 = Reserved

00111 = Reserved

00110 = Reserved

•

_

00010 = Channel 0 positive input is AN2

00001 = Channel 0 positive input is AN1

00000 = Channel 0 positive input is AN0

bit 7 CH0NA: Channel 0 Negative Input Select for Sample A bit

1 = Channel 0 negative input is AN1

0 = Channel 0 negative input is VREF-

bit 6-5 **Unimplemented:** Read as '0'

REGISTER 17-5: AD1CHS0: ADC1 INPUT CHANNEL 0 SELECT REGISTER (CONTINUED)

00000 = Channel 0 positive input is AN0

REGISTER 17-6: AD1CSSL: ADC1 INPUT SCAN SELECT REGISTER LOW⁽¹⁾

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	CSS12	CSS11	CSS10	CSS9	CSS8
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| CSS7 | CSS6 | CSS5 | CSS4 | CSS3 | CSS2 | CSS1 | CSS0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-0 CSS<12:0>: ADC Input Scan Selection bits

1 = Select ANx for input scan0 = Skip ANx for input scan

Note 1: On PIC24HJ32GP202 devices, all AD1CSSL bits can be selected. However, inputs selected for scan without a corresponding input on device will convert ADREF-.

REGISTER 17-7: AD1PCFGL: ADC1 PORT CONFIGURATION REGISTER LOW(1)

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	_	_	PCFG12	PCFG11	PCFG10	PCFG9	PCFG8
bit 15							bit 8

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| PCFG7 | PCFG6 | PCFG5 | PCFG4 | PCFG3 | PCFG2 | PCFG1 | PCFG0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit 12-0 PCFG<12:0>: ADC Port Configuration Control bits

1 = Port pin in Digital mode, port read input enabled. ADC input multiplexer connected to AVss

0 = Port pin in Analog mode, port read input disabled, ADC samples pin voltage

Note 1: On PIC24HJ32GP202 devices, all PCFG bits are R/W. However, PCFG bits are ignored on ports without a corresponding input on device.

PICZ4F							
NOTES:							

18.0 SPECIAL FEATURES

Note:

This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "PIC24H Family Reference Manual".

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices include several features that are intended to maximize application flexibility and reliability, and minimize cost through elimination of external components. These are:

- · Flexible configuration
- Watchdog Timer (WDT)
- Code Protection and CodeGuard™ Security
- · JTAG Boundary Scan Interface
- In-Circuit Serial Programming™ (ICSP™)
- · In-Circuit emulation

18.1 Configuration Bits

The Configuration bits can be programmed (read as '0'), or left unprogrammed (read as '1'), to select various device configurations. These bits are mapped starting at program memory location 0xF80000.

The Device Configuration register map is shown in Table 18-1.

The individual Configuration bit descriptions for the FBS, FGS, FOSCSEL, FOSC, FWDT, FPOR and FICD Configuration registers are shown in Table 18-2.

Note that address 0xF80000 is beyond the user program memory space. It belongs to the configuration memory space (0x800000-0xFFFFFF), which can only be accessed using table reads and table writes.

The upper byte of all device Configuration registers should always be '1111 1111.' This makes them appear to be NOP instructions in the remote event that their locations are ever executed by accident. Since Configuration bits are not implemented in the corresponding locations, writing '1' to these locations has no effect on device operation.

To prevent the inadvertent configuration changes during code execution, all programmable Configuration bits are write-once. After a bit is initially programmed during a power cycle, it cannot be written to again. Changing a device configuration requires that power to the device be cycled.

TABLE 18-1: DEVICE CONFIGURATION REGISTER MAP

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0xF80000	FBS	_	_		_		BSS<2:0>		BWRP
0xF80002	Reserved				Reserved	_d (1)			
0xF80004	FGS	_	_	_	_	_	GSS<1	:0>	GWRP
0xF80006	FOSCSEL	IESO		I		- FNOSC<2:0>		•	
0xF80008	FOSC	FCKSM ⁻	<1:0>	IOL1WAY		-	OSCIOFNC	POSCM	ID<1:0>
0xF8000A	FWDT	FWDTEN	WINDIS		WDTPRE		WDTPOST	<3:0>	
0xF8000C	FPOR			I	ALTI2C	1	FPW	/RT<2:0>	•
0xF8000E	FICD	BKBUG	COE	JTAGEN	1	ı	_	ICS<	:1:0>
0xF80010	FUID0				User Unit ID	Byte 0			
0xF80012	FUID1		User Unit ID Byte 1						
0xF80014	FUID2		User Unit ID Byte 2						
0xF80016	FUID3				User Unit ID	Byte 3			

Note 1: These reserved bits read as '1' and must be programmed as '1'.

TABLE 18-2: PIC24HJ32GP202/204 AND PIC24HJ16GP304 CONFIGURATION BITS DESCRIPTION

DES	DESCRIPTION							
Bit Field	Register	Description						
BWRP	FBS	Boot Segment Program Flash Write Protection 1 = Boot segment may be written 0 = Boot segment is write-protected						
BSS<2:0>	FBS	PIC24HJ32GP202 and PIC24HJ32GP204 Devices Only Boot Segment Program Flash Code Protection Size x11 = No Boot program Flash segment Boot space is 768 Instruction Words (except interrupt vectors)						
		110 = Standard security; boot program Flash segment ends at 0x0007FE 010 = High security; boot program Flash segment ends at 0x0007FE Boot space is 3840 Instruction Words (except interrupt vectors)						
		101 = Standard security; boot program Flash segment, ends at 0x001FFE 001 = High security; boot program Flash segment ends at 0x001FFE						
		Boot space is 7936 Instruction Words (except interrupt vectors) 100 = Standard security; boot program Flash segment ends at 0x003FFE 000 = High security; boot program Flash segment ends at 0x003FFE						
BSS<2:0>	FBS	PIC24HJ16GP304 Devices Only Boot Segment Program Flash Code Protection Size x11 = No Boot program Flash segment						
		Boot space is 768 Instruction Words (except interrupt vectors) 110 = Standard security; boot program Flash segment ends at 0x0007FE 010 = High security; boot program Flash segment ends at 0x0007FE						
		Boot space is 3840 Instruction Words (except interrupt vectors) 101 = Standard security; boot program Flash segment, ends at 0x001FFE 001 = High security; boot program Flash segment ends at 0x001FFE						
		Boot space is 5376 Instruction Words (except interrupt vectors) 100 = Standard security; boot program Flash segment ends at 0x002BFE 000 = High security; boot program Flash segment ends at 0x002BFE						
GSS<1:0>	FGS	General Segment Code-Protect bit 11 = User program memory is not code-protected 10 = Standard security 0x = High security						
GWRP	FGS	General Segment Write-Protect bit 1 = User program memory is not write-protected 0 = User program memory is write-protected						
IESO	FOSCSEL	Two-speed Oscillator Start-up Enable bit 1 = Start-up device with FRC, then automatically switch to the user-selected oscillator source when ready 0 = Start-up device with user-selected oscillator source						
FNOSC<2:0>	FOSCSEL	Initial Oscillator Source Selection bits 111 = Internal Fast RC (FRC) oscillator with postscaler 110 = Internal Fast RC (FRC) oscillator with divide-by-16 101 = LPRC oscillator 100 = Secondary (LP) oscillator 011 = Primary (XT, HS, EC) oscillator with PLL 010 = Primary (XT, HS, EC) oscillator 001 = Internal Fast RC (FRC) oscillator with PLL 000 = FRC oscillator						

TABLE 18-2: PIC24HJ32GP202/204 AND PIC24HJ16GP304 CONFIGURATION BITS DESCRIPTION (CONTINUED)

(CONTINUED)					
Bit Field	Register	Description			
FCKSM<1:0>	FOSC	Clock Switching Mode bits 1x = Clock switching is disabled, Fail-Safe Clock Monitor is disabled 01 = Clock switching is enabled, Fail-Safe Clock Monitor is disabled 00 = Clock switching is enabled, Fail-Safe Clock Monitor is enabled			
IOL1WAY	FOSC	Peripheral Pin Select Configuration 1 = Allow only one re-configuration 0 = Allow multiple re-configurations			
OSCIOFNC	FOSC	OSC2 Pin Function bit (except in XT and HS modes) 1 = OSC2 is clock output 0 = OSC2 is general purpose digital I/O pin			
POSCMD<1:0>	FOSC	Primary Oscillator Mode Select bits 11 = Primary oscillator disabled 10 = HS Crystal Oscillator mode 01 = XT Crystal Oscillator mode 00 = EC (External Clock) mode			
FWDTEN	FWDT	Watchdog Timer Enable bit 1 = Watchdog Timer always enabled (LPRC oscillator cannot be disabled. Clearing the SWDTEN bit in the RCON register will have no effect.) 0 = Watchdog Timer enabled/disabled by user software (LPRC can be disabled by clearing the SWDTEN bit in the RCON register)			
WINDIS	FWDT	Watchdog Timer Window Enable bit 1 = Watchdog Timer in Non-Window mode 0 = Watchdog Timer in Window mode			
WDTPRE	FWDT	Watchdog Timer Prescaler bit 1 = 1:128 0 = 1:32			
WDTPOST<3:0>	FWDT	Watchdog Timer Postscaler bits 1111 = 1:32,768 1110 = 1:16,384			
ALTI2C	FPOR	Alternate I^2 C pins 1 = I^2 C mapped to SDA1/SCL1 pins 0 = I^2 C mapped to ASDA1/ASCL1 pins			
FPWRT<2:0>	FPOR	Power-on Reset Timer Value Select bits 111 = PWRT = 128 ms 110 = PWRT = 64 ms 101 = PWRT = 32 ms 100 = PWRT = 16 ms 011 = PWRT = 8 ms 010 = PWRT = 4 ms 001 = PWRT = 2 ms 000 = PWRT = Disabled			
BKBUG	FICD	Background Debug Enable bit 1 = Device will reset in User mode 0 = Device will reset in Debug mode			
COE	FICD	Debugger/Emulator Enable bit 1 = Device will reset in Operational mode 0 = Device will reset in Clip-On Emulation mode			

TABLE 18-2: PIC24HJ32GP202/204 AND PIC24HJ16GP304 CONFIGURATION BITS DESCRIPTION (CONTINUED)

(0011111022)			
Bit Field	Register	Description	
JTAGEN	FICD	JTAG Enable bit 1 = JTAG enabled	
ICS<1:0>	FICD	0 = JTAG disabled ICD Communication Channel Select bits	
100 110	1.00	11 = Communicate on PGC1/EMUC1 and PGD1/EMUD1 10 = Communicate on PGC2/EMUC2 and PGD2/EMUD2 01 = Communicate on PGC3/EMUC3 and PGD3/EMUD3 00 = Reserved, do not use	

18.2 On-Chip Voltage Regulator

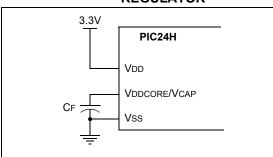
All of the PIC24HJ32GP202/204 and PIC24HJ16GP304 devices power their core digital logic at a nominal 2.5V. This can create a conflict for designs that are required to operate at a higher typical voltage, such as 3.3V. To simplify system design, all devices in the PIC24HJ32GP202/204 and PIC24HJ16GP304 family incorporate an on-chip regulator that allows the device to run its core logic from VDD

The regulator provides power to the core from the other VDD pins. When the regulator is enabled, a low-ESR (less than 5 ohms) capacitor (such as tantalum or ceramic) must be connected to the VDDCORE/VCAP pin (Figure 18-1). This helps to maintain the stability of the regulator. The recommended value for the filter capacitor is provided in Table 21-13 located in **Section 21.1** "DC Characteristics".

Note: It is important for the low-ESR capacitor to be placed as close as possible to the VDDCORE pin.

On a POR, it takes approximately 20 μ s for the on-chip voltage regulator to generate an output voltage. During this time, designated as TSTARTUP, code execution is disabled. TSTARTUP is applied every time the device resumes operation after any power-down.

FIGURE 18-1: CONNECTIONS FOR THE ON-CHIP VOLTAGE REGULATOR⁽¹⁾



- Note 1: These are typical operating voltages. Refer to Table 21-13 located in Section 21.1 "DC Characteristics" for the full operating ranges of VDD and VDDCORE.
 - 2: It is important for the low-ESR capacitor to be placed as close as possible to the VDDCORE pin.

18.3 BOR: Brown-Out Reset

The Brown-out Reset (BOR) module is based on an internal voltage reference circuit that monitors the regulated voltage VDDCORE. The main purpose of the BOR module is to generate a device Reset when a brown-out condition occurs. Brown-out conditions are generally caused by glitches on the AC mains (for example, missing portions of the AC cycle waveform due to bad power transmission lines, or voltage sags due to excessive current draw when a large inductive load is turned on).

A BOR generates a Reset pulse, which resets the device. The BOR selects the clock source, based on the device Configuration bit values (FNOSC<2:0> and POSCMD<1:0>).

If an oscillator mode is selected, the BOR activates the Oscillator Start-up Timer (OST). The system clock is held until OST expires. If the PLL is used, the clock is held until the LOCK bit (OSCCON<5>) is '1'.

Concurrently, the PWRT time-out (TPWRT) will be applied before the internal Reset is released. If TPWRT = 0 and a crystal oscillator is being used, a nominal delay of TFSCM = 100 is applied. The total delay in this case is TFSCM.

The BOR Status bit (RCON<1>) is set to indicate that a BOR has occurred. The BOR circuit continues to operate while in Sleep or Idle mode and resets the device in case VDD falls below the BOR threshold voltage.

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18.4 Watchdog Timer (WDT)

For PIC24HJ32GP202/204 and PIC24HJ16GP304 devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

18.4.1 PRESCALER/POSTSCALER

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler than can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT time-out period (TWDT) of 1 ms in 5-bit mode, or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDT<3:0>), which allows the selection of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods ranging from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- · On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSC bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

18.4.2 SLEEP AND IDLE MODES

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3,2>) will need to be cleared in software after the device wakes up.

18.4.3 ENABLING WDT

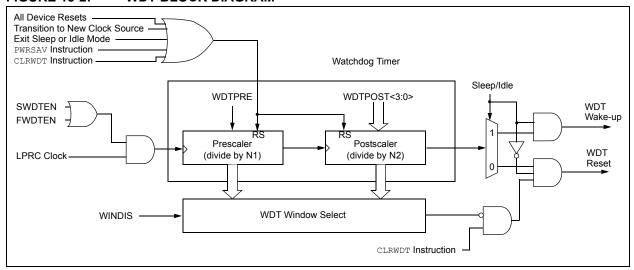
The WDT is enabled or disabled by the FWDTEN Configuration bit in the FWDT Configuration register. When the FWDTEN Configuration bit is set, the WDT is always enabled.

The WDT flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

The WDT can be optionally controlled in software when the FWDTEN Configuration bit has been programmed to '0'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user application to enable the WDT for critical code segments and disable the WDT during non-critical segments for maximum power savings.

Note: If the WINDIS bit (FWDT<6>) is cleared, the CLRWDT instruction should be executed by the application software only during the last 1/4 of the WDT period. This CLRWDT window can be determined by using a timer. If a CLRWDT instruction is executed before this window, a WDT Reset occurs.

FIGURE 18-2: WDT BLOCK DIAGRAM



18.5 JTAG Interface

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices implement a JTAG interface, which supports boundary scan device testing, as well as in-circuit programming. Detailed information on this interface will be provided in future revisions of the document.

18.6 Code Protection and CodeGuard™ Security

The PIC24HJ32GP202/204 and PIC24HJ16GP304 product families offer the intermediate implementation of CodeGuard Security. CodeGuard Security allows multiple parties to securely share resources (memory,

TABLE 18-3: CODE FLASH SECURITY SEGMENT SIZES FOR 32 KBYTE DEVICES

CONFIG BITS		
D00 40:05 ===44	VS = 256 IW	000000h 0001FEh 000200h 0007FEh
BSS<2:0>=x11 0K	GS = 11008 IW	000800h 001FFEh 002000h 003FFEh 004000h
		_0057FEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x10	BS = 768 IW	000200h 0007FEh
256		000800h 001FFEh 002000h 003FFEh 004000h
	GS = 10240 IW	004000H 0057FEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x01	BS = 3840 IW	000200h 0007FEh 000800h 001FFEh
768		002000h 003FFEh 004000h
	GS = 7168 IW	0057FEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x00	BS = 7936 IW	000200h 0007FEh 000800h 001FFEh
1792		002000h 003FFEh 004000h
	GS = 3072 IW	0057FEh

interrupts and peripherals) on a single chip. This feature helps to protect individual Intellectual Property in collaborative system designs.

When coupled with software encryption libraries, CodeGuard Security can be used to securely update Flash even when multiple IPs reside on the single chip.

The code protection features are controlled by the Configuration registers: FBS and FGS. The Secure segment and RAM is not implemented.

Note: Refer to "CodeGuard Security Reference Manual" (DS70180) for further information on usage, configuration and operation of CodeGuard Security.

TABLE 18-4: CODE FLASH SECURITY SEGMENT SIZES FOR 16 KBYTE DEVICES

	O KBI IL DEVIC	
CONFIG BITS		
	VS = 256 IW	000000h 0001FEh 000200h
BSS<2:0>=x11 0K	GS = 5376 IW	000200h 0007FEh 000800h 001FFEh 002000h
		002BFEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x10	BS = 768 IW	000200h 0007FEh
256		000800h 001FFEh 002000h
	GS = 4608 IW	002BFEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x01	BS = 3840 IW	000200h 0007FEh 000800h 001FFEh
768		002000h
	GS = 1536 IW	002BFEh
	VS = 256 IW	000000h 0001FEh
BSS<2:0>=x00	BS = 5376 IW	000200h 0007FEh 000800h 001FFEh 002000h
1792		002BFEh

18.7 In-Circuit Serial Programming

PIC24HJ32GP202/204 and PIC24HJ16GP304 family microcontrollers can be serially programmed while in the end application circuit. This is done with two lines for clock and data, and three other lines for power, ground and the programming sequence. Serial programming allows customers to manufacture boards with unprogrammed devices and then program the microcontroller just before shipping the product. Serial programming also allows the most recent firmware or a custom firmware to be programmed. Refer to the "dsPIC30F/33F Flash Programming Specification" (DS70152) document for details about In-Circuit Serial Programming (ICSP).

Any of the following three pairs of programming clock/data pins can be used:

- PGC1/EMUC1 and PGD1/EMUD1
- PGC2/EMUC2 and PGD2/EMUD2
- PGC3/EMUC3 and PGD3/EMUD3

18.8 In-Circuit Debugger

When MPLAB® ICD 2 is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the Emulation/Debug Clock (EMUCx) and Emulation/Debug Data (EMUDx) pin functions.

Any of the following three pairs of debugging clock/data pins can be used:

- PGC1/EMUC1 and PGD1/EMUD1
- PGC2/EMUC2 and PGD2/EMUD2
- PGC3/EMUC3 and PGD3/EMUD3

To make use of the in-circuit debugger function of the device, the design must implement ICSP connections to $\overline{\text{MCLR}}$, VDD, Vss, PGC, PGD and the EMUDx/EMUCx pin pair. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.

19.0 INSTRUCTION SET SUMMARY

Note:

This data sheet summarizes the features of this group of PIC24HJ32GP202/204 and PIC24HJ16GP304 devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the "PIC24H Family Reference Manual".

The PIC24H instruction set is identical to that of the PIC24F, and is a subset of the dsPIC30F/33F instruction set.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word, divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- · Word or byte-oriented operations
- · Bit-oriented operations
- · Literal operations
- Control operations

Table 19-1 shows the general symbols used in describing the instructions.

The PIC24H instruction set summary in Table 19-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand which is typically a register 'Wb' without any address modifier
- The second source operand which is typically a register 'Ws' with or without an address modifier
- The destination of the result which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- · The file register specified by the value 'f'
- The destination, which could either be the file register 'f' or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand which is a register 'Wb' without any address modifier
- The second source operand which is a literal value
- The destination of the result (only if not the same as the first source operand) which is typically a register 'Wd' with or without an address modifier

The control instructions may use some of the following operands:

- · A program memory address
- The mode of the table read and table write instructions

All instructions are single word. Certain double-word instructions are designed to provide all of the required information in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all table reads and writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or double word instruction. Moreover, double word moves require two cycles. The double word instructions execute in two instruction cycles.

Note: For more details on the instruction set, refer to the "dsPIC30F/33F Programmer's Reference Manual" (DS70157).

TABLE 19-1: SYMBOLS USED IN OPCODE DESCRIPTIONS

Field	Description		
#text	Means literal defined by "text"		
(text)	Means "content of text"		
[text]	Means "the location addressed by text"		
{ }	Optional field or operation		
<n:m></n:m>	Register bit field		
.b	Byte mode selection		
.d	Double Word mode selection		
.S	Shadow register select		
.w	Word mode selection (default)		
bit4	4-bit bit selection field (used in word addressed instructions) ∈ {015}		
C, DC, N, OV, Z	MCU Status bits: Carry, Digit Carry, Negative, Overflow, Sticky Zero		
Expr	Absolute address, label or expression (resolved by the linker)		
f	File register address ∈ {0x00000x1FFF}		
lit1	1-bit unsigned literal ∈ {0,1}		
lit4	4-bit unsigned literal ∈ {015}		
lit5	5-bit unsigned literal ∈ {031}		
lit8	8-bit unsigned literal ∈ {0255}		
lit10	10-bit unsigned literal ∈ {0255} for Byte mode, {0:1023} for Word mode		
lit14	14-bit unsigned literal ∈ {016384}		
lit16	16-bit unsigned literal ∈ {065535}		
lit23	23-bit unsigned literal ∈ {08388608}; LSB must be '0'		
None	Field does not require an entry, may be blank		
PC	Program Counter		
Slit10	10-bit signed literal ∈ {-512511}		
Slit16	16-bit signed literal ∈ {-3276832767}		
Slit6	6-bit signed literal ∈ {-1616}		
Wb	Base W register ∈ {W0W15}		
Wd	Destination W register ∈ { Wd, [Wd], [Wd++], [Wd], [++Wd], [Wd] }		
Wdo	Destination W register ∈ { Wnd, [Wnd], [Wnd++], [Wnd], [++Wnd], [Wnd], [Wnd+Wb] }		
Wm,Wn	Dividend, Divisor working register pair (direct addressing)		
Wm*Wm	Multiplicand and Multiplier working register pair for Square instructions ∈ {W4 * W4,W5 * W5,W6 * W6,W7 * W7}		
Wn	One of 16 working registers ∈ {W0W15}		
Wnd	One of 16 destination working registers ∈ {W0W15}		
Wns	One of 16 source working registers ∈ {W0W15}		
WREG	W0 (working register used in file register instructions)		
Ws	Source W register ∈ { Ws, [Ws], [Ws++], [Ws], [++Ws], [Ws] }		
Wso	Source W register ∈ { Wns, [Wns++], [Wns], [++Wns], [Wns], [Wns+Wb] }		

TABLE 19-2: INSTRUCTION SET OVERVIEW

Base Instr #	E 19-2: Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
1	ADD	ADD	f	f = f + WREG	1	1	C,DC,N,OV,Z
'	ADD	ADD	f,WREG	WREG = f + WREG	1	1	C,DC,N,OV,Z
		ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C,DC,N,OV,Z
		ADD	Wb, Ws, Wd	Wd = Wb + Ws	1	1	C,DC,N,OV,Z
		ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C,DC,N,OV,Z
2	ADDC	ADDC	f	f = f + WREG + (C)	1	1	C,DC,N,OV,Z
		ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C,DC,N,OV,Z
		ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C,DC,N,OV,Z
		ADDC	Wb, Ws, Wd	Wd = Wb + Ws + (C)	1	1	C,DC,N,OV,Z
		ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C,DC,N,OV,Z
3	AND	AND	f	f = f .AND. WREG	1	1	N,Z
		AND	f,WREG	WREG = f .AND. WREG	1	1	N,Z
		AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N,Z
		AND	Wb, Ws, Wd	Wd = Wb .AND. Ws	1	1	N,Z
		AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N,Z
4	ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C,N,OV,Z
		ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C,N,OV,Z
		ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C,N,OV,Z
		ASR	Wb, Wns, Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N,Z
		ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N,Z
5	BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
		BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
6	BRA	BRA	C, Expr	Branch if Carry	1	1 (2)	None
		BRA	GE, Expr	Branch if greater than or equal	1	1 (2)	None
		BRA	GEU, Expr	Branch if unsigned greater than or equal	1	1 (2)	None
		BRA	GT, Expr	Branch if greater than	1	1 (2)	None
		BRA	GTU, Expr	Branch if unsigned greater than	1	1 (2)	None
		BRA	LE, Expr	Branch if less than or equal	1	1 (2)	None
		BRA	LEU, Expr	Branch if unsigned less than or equal	1	1 (2)	None
		BRA	LT,Expr	Branch if less than	1	1 (2)	None
		BRA	LTU, Expr	Branch if unsigned less than	1	1 (2)	None
		BRA	N, Expr	Branch if Negative	1	1 (2)	None
		BRA	NC,Expr	Branch if Not Carry	1	1 (2)	None
		BRA	NN,Expr	Branch if Not Negative	1	1 (2)	None
		BRA	NZ,Expr	Branch if Not Zero	1	1 (2)	None
		BRA	Expr	Branch Unconditionally	1	2	None
		BRA	Z,Expr	Branch if Zero	1	1 (2)	None
		BRA	Wn	Computed Branch	1	2	None
7	BSET	BSET	f,#bit4	Bit Set f	1	1	None
		BSET	Ws,#bit4	Bit Set Ws	1	1	None
8	BSW	BSW.C	Ws,Wb	Write C bit to Ws <wb></wb>	1	1	None
		BSW.Z	Ws,Wb	Write Z bit to Ws <wb></wb>	1	1	None
9	BTG	BTG	f,#bit4	Bit Toggle f	1	1	None
		BTG	Ws,#bit4	Bit Toggle Ws	1	1	None
10	BTSC	BTSC	f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
		BTSC	Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None
11	BTSS	BTSS	f,#bit4	Bit Test f, Skip if Set	1	1 (2 or 3)	None
		BTSS	Ws,#bit4	Bit Test Ws, Skip if Set	1	1 (2 or 3)	None

TABLE 19-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
12	BTST	BTST	f,#bit4	Bit Test f	1	1	Z
		BTST.C	Ws,#bit4	Bit Test Ws to C	1	1	С
		BTST.Z	Ws,#bit4	Bit Test Ws to Z	1	1	Z
		BTST.C	Ws,Wb	Bit Test Ws <wb> to C</wb>	1	1	С
		BTST.Z	Ws,Wb	Bit Test Ws <wb> to Z</wb>	1	1	Z
13	BTSTS	BTSTS	f,#bit4	Bit Test then Set f	1	1	Z
		BTSTS.C	Ws,#bit4	Bit Test Ws to C, then Set	1	1	С
		BTSTS.Z	Ws,#bit4	Bit Test Ws to Z, then Set	1	1	Z
14	CALL	CALL	lit23	Call subroutine	2	2	None
		CALL	Wn	Call indirect subroutine	1	2	None
15	CLR	CLR	f	f = 0x0000	1	1	None
		CLR	WREG	WREG = 0x0000	1	1	None
		CLR	Ws	Ws = 0x0000	1	1	None
16	CLRWDT	CLRWDT		Clear Watchdog Timer	1	1	WDTO,Sleep
17	СОМ	COM	f	$f = \overline{f}$	1	1	N,Z
		COM	f,WREG	WREG = f	1	1	N,Z
		COM	Ws,Wd	Wd = Ws	1	1	N,Z
18	СР	CP	f	Compare f with WREG	1	1	C,DC,N,OV,Z
		CP	Wb,#lit5	Compare Wb with lit5	1	1	C,DC,N,OV,Z
		CP	Wb,Ws	Compare Wb with Ws (Wb – Ws)	1	1	C,DC,N,OV,Z
19	CP0	CP0	f	Compare f with 0x0000	1	1	C,DC,N,OV,Z
		CP0	Ws	Compare Ws with 0x0000	1	1	C,DC,N,OV,Z
20	СРВ	CPB	f	Compare f with WREG, with Borrow	1	1	C,DC,N,OV,Z
		CPB	Wb,#lit5	Compare Wb with lit5, with Borrow	1	1	C,DC,N,OV,Z
		CPB	Wb,Ws	Compare Wb with Ws, with Borrow (Wb - Ws - C)	1	1	C,DC,N,OV,Z
21	CPSEQ	CPSEQ	Wb, Wn	Compare Wb with Wn, skip if =	1	1 (2 or 3)	None
22	CPSGT	CPSGT	Wb, Wn	Compare Wb with Wn, skip if >	1	1 (2 or 3)	None
23	CPSLT	CPSLT	Wb, Wn	Compare Wb with Wn, skip if <	1	1 (2 or 3)	None
24	CPSNE	CPSNE	Wb, Wn	Compare Wb with Wn, skip if 1/4	1	1 (2 or 3)	None
25	DAW	DAW	Wn	Wn = decimal adjust Wn	1	1	С
26	DEC	DEC	f	f = f - 1	1	1	C,DC,N,OV,Z
		DEC	f,WREG	WREG = f - 1	1	1	C,DC,N,OV,Z
		DEC	Ws,Wd	Wd = Ws - 1	1	1	C,DC,N,OV,Z
27	DEC2	DEC2	f	f = f - 2	1	1	C,DC,N,OV,Z
		DEC2	f,WREG	WREG = f - 2	1	1	C,DC,N,OV,Z
		DEC2	Ws,Wd	Wd = Ws - 2	1	1	C,DC,N,OV,Z
28	DISI	DISI	#lit14	Disable Interrupts for k instruction cycles	1	1	None
29	DIV	DIV.S	Wm,Wn	Signed 16/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.SD	Wm,Wn	Signed 32/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.U	Wm,Wn	Unsigned 16/16-bit Integer Divide	1	18	N,Z,C,OV
		DIV.UD	Wm,Wn	Unsigned 32/16-bit Integer Divide	1	18	N,Z,C,OV
30	EXCH	EXCH	Wns, Wnd	Swap Wns with Wnd	1	1	None
31	FBCL	FBCL	Ws,Wnd	Find Bit Change from Left (MSb) Side	1	1	С
32	FF1L	FF1L	Ws,Wnd	Find First One from Left (MSb) Side	1	1	С
33	FF1R	FF1R	Ws,Wnd	Find First One from Right (LSb) Side	1	1	С
34	GOTO	GOTO	Expr	Go to address	2	2	None
		GOTO	Wn	Go to indirect	1	2	None

TABLE 19-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr	E 19-2: Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
# 35	INC	INC	f	f = f + 1	1	1	C,DC,N,OV,Z
33	INC	INC	f,WREG	WREG = f + 1	1	1	C,DC,N,OV,Z
		INC	Ws,Wd	Wd = Ws + 1	1	1	C,DC,N,OV,Z
36	INC2	INC2	f	f = f + 2	1	1	C,DC,N,OV,Z
30	IIVOZ	INC2	f,WREG	WREG = f + 2	1	1	C,DC,N,OV,Z
		INC2	Ws,Wd	Wd = Ws + 2	1	1	C,DC,N,OV,Z
37	IOR	IOR	f	f = f .IOR. WREG	1	1	N,Z
37 IOR		IOR	f,WREG	WREG = f.IOR. WREG	1	1	N,Z
		IOR	#lit10,Wn	Wd = lit10 .IOR. Wd	1	1	N,Z
		IOR	Wb, Ws, Wd	Wd = Wb .IOR. Ws	1	1	N,Z
		IOR	Wb,#lit5,Wd	Wd = Wb .IOR. lit5	1	1	N,Z
38	LNK	LNK	#lit14	Link Frame Pointer	1	1	None
39	LSR	LSR	f	f = Logical Right Shift f	1	1	C,N,OV,Z
00	LOIX	LSR	f,WREG	WREG = Logical Right Shift f	1	1	C,N,OV,Z
		LSR	Ws, Wd	Wd = Logical Right Shift Ws	1	1	C,N,OV,Z
		LSR	Wb, Wns, Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N,Z
		LSR	Wb,#lit5,Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N,Z
40	MOV	MOV	f,Wn	Move f to Wn	1	1	None
		MOV	f	Move f to f	1	1	N,Z
		MOV	f,WREG	Move f to WREG	1	1	N,Z
		MOV	#lit16,Wn	Move 16-bit literal to Wn	1	1	None
		MOV.b	#lit8,Wn	Move 8-bit literal to Wn	1	1	None
		MOV	Wn,f	Move Wn to f	1	1	None
		MOV	Wso, Wdo	Move Ws to Wd	1	1	None
		MOV	WREG, f	Move WREG to f	1	1	N,Z
		MOV.D	Wns, Wd	Move Double from W(ns):W(ns + 1) to Wd	1	2	None
		MOV.D	Ws, Wnd	Move Double from Ws to W(nd + 1):W(nd)	1	2	None
41	MUL	MUL.SS	Wb, Ws, Wnd	{Wnd + 1, Wnd} = signed(Wb) * signed(Ws)	1	1	None
		MUL.SU	Wb, Ws, Wnd	{Wnd + 1, Wnd} = signed(Wb) * unsigned(Ws)	1	1	None
		MUL.US	Wb, Ws, Wnd	{Wnd + 1, Wnd} = unsigned(Wb) * signed(Ws)	1	1	None
		MUL.UU	Wb, Ws, Wnd	{Wnd + 1, Wnd} = unsigned(Wb) * unsigned(Ws)	1	1	None
		MUL.SU	Wb,#lit5,Wnd	{Wnd + 1, Wnd} = signed(Wb) * unsigned(lit5)	1	1	None
		MUL.UU	Wb,#lit5,Wnd	{Wnd + 1, Wnd} = unsigned(Wb) * unsigned(lit5)	1	1	None
		MUL	f	W3:W2 = f * WREG	1	1	None
42	NEG	NEG	f	$f = \overline{f} + 1$	1	1	C,DC,N,OV,Z
		NEG	f,WREG	WREG = f + 1	1	1	C,DC,N,OV,Z
		NEG	Ws,Wd	$Wd = \overline{Ws} + 1$	1	1	C,DC,N,OV,Z
43	NOP	NOP		No Operation	1	1	None
		NOPR		No Operation	1	1	None
44	POP	POP	f	Pop f from Top-of-Stack (TOS)	1	1	None
		POP	Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
		POP.D	Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd + 1)	1	2	None
		POP.S		Pop Shadow Registers	1	1	All
45	PUSH	PUSH	f	Push f to Top-of-Stack (TOS)	1	1	None
		PUSH	Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
		PUSH.D	Wns	Push W(ns):W(ns + 1) to Top-of-Stack (TOS)	1	2	None
		PUSH.S		Push Shadow Registers	1	1	None
				- J			·

TABLE 19-2: INSTRUCTION SET OVERVIEW (CONTINUED)

IABLE 19-2:		INSTIN	CHON SET OVER	VIEW (CONTINUED)		1	T
Base Instr #	Assembly Mnemonic		Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
47	RCALL	RCALL	Expr	Relative Call	1	2	None
		RCALL	Wn	Computed Call	1	2	None
48	REPEAT	REPEAT	#lit14	Repeat Next Instruction lit14 + 1 times	1	1	None
		REPEAT	Wn	Repeat Next Instruction (Wn) + 1 times	1	1	None
49	RESET	RESET		Software device Reset	1	1	None
50	RETFIE	RETFIE		Return from interrupt	1	3 (2)	None
51	RETLW	RETLW	#lit10,Wn	Return with literal in Wn	1	3 (2)	None
52	RETURN	RETURN		Return from Subroutine	1	3 (2)	None
53	RLC	RLC	f	f = Rotate Left through Carry f	1	1	C,N,Z
		RLC	f,WREG	WREG = Rotate Left through Carry f	1	1	C,N,Z
		RLC	Ws,Wd	Wd = Rotate Left through Carry Ws	1	1	C,N,Z
54	RLNC	RLNC	f	f = Rotate Left (No Carry) f	1	1	N,Z
		RLNC	f,WREG	WREG = Rotate Left (No Carry) f	1	1	N,Z
		RLNC	Ws,Wd	Wd = Rotate Left (No Carry) Ws	1	1	N,Z
55	RRC	RRC	f	f = Rotate Right through Carry f	1	1	C,N,Z
		RRC	f,WREG	WREG = Rotate Right through Carry f	1	1	C,N,Z
		RRC	Ws,Wd	Wd = Rotate Right through Carry Ws	1	1	C,N,Z
56	RRNC	RRNC	f	f = Rotate Right (No Carry) f	1	1	N,Z
		RRNC	f,WREG	WREG = Rotate Right (No Carry) f	1	1	N,Z
		RRNC	Ws,Wd	Wd = Rotate Right (No Carry) Ws	1	1	N,Z
57	SE	SE	Ws,Wnd	Wnd = sign-extended Ws	1	1	C,N,Z
58	SETM	SETM	f	f = 0xFFFF	1	1	None
		SETM	WREG	WREG = 0xFFFF	1	1	None
		SETM	Ws	Ws = 0xFFFF	1	1	None
59	SL	SL	f	f = Left Shift f	1	1	C,N,OV,Z
		SL	f,WREG	WREG = Left Shift f	1	1	C,N,OV,Z
		SL	Ws,Wd	Wd = Left Shift Ws	1	1	C,N,OV,Z
		SL	Wb, Wns, Wnd	Wnd = Left Shift Wb by Wns	1	1	N,Z
		SL	Wb,#lit5,Wnd	Wnd = Left Shift Wb by lit5	1	1	N,Z
60	SUB	SUB	f	f = f - WREG	1	1	C,DC,N,OV,Z
		SUB	f,WREG	WREG = f - WREG	1	1	C,DC,N,OV,Z
		SUB	#lit10,Wn	Wn = Wn - lit10	1	1	C,DC,N,OV,Z
		SUB	Wb, Ws, Wd	Wd = Wb - Ws	1	1	C,DC,N,OV,Z
		SUB	Wb,#lit5,Wd	Wd = Wb - lit5	1	1	C,DC,N,OV,Z
61	SUBB	SUBB	f	$f = f - WREG - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBB	f,WREG	WREG = $f - WREG - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBB	#lit10,Wn	$Wn = Wn - lit10 - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBB	Wb, Ws, Wd	$Wd = Wb - Ws - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBB	Wb,#lit5,Wd	$Wd = Wb - lit5 - (\overline{C})$	1	1	C,DC,N,OV,Z
62	SUBR	SUBR	f	f = WREG - f	1	1	C,DC,N,OV,Z
		SUBR	f,WREG	WREG = WREG - f	1	1	C,DC,N,OV,Z
		SUBR	Wb, Ws, Wd	Wd = Ws - Wb	1	1	C,DC,N,OV,Z
		SUBR	Wb,#lit5,Wd	Wd = lit5 - Wb	1	1	C,DC,N,OV,Z
63	SUBBR	SUBBR	f	$f = WREG - f - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBBR	f,WREG	WREG = WREG - f - (\overline{C})	1	1	C,DC,N,OV,Z
		SUBBR	Wb, Ws, Wd	$Wd = Ws - Wb - (\overline{C})$	1	1	C,DC,N,OV,Z
		SUBBR	Wb,#lit5,Wd	Wd = lit5 - Wb - (C)	1	1	C,DC,N,OV,Z
64	SWAP	SWAP.b	Wn Wn	Wn = nibble swap Wn	1	1	None
J 1	3,,,,,,	SWAP.D	Wn	Wn = byte swap Wn	1	1	None

TABLE 19-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles	Status Flags Affected
66	TBLRDL	TBLRDL	Ws,Wd	Read Prog<15:0> to Wd	1	2	None
67	TBLWTH	TBLWTH	Ws,Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
68	TBLWTL	TBLWTL	Ws,Wd	Write Ws to Prog<15:0>	1	2	None
69	ULNK	ULNK		Unlink Frame Pointer	1	1	None
70	XOR	XOR	f	f = f .XOR. WREG	1	1	N,Z
		XOR	f,WREG	WREG = f .XOR. WREG	1	1	N,Z
		XOR	#lit10,Wn	Wd = lit10 .XOR. Wd	1	1	N,Z
		XOR	Wb, Ws, Wd	Wd = Wb .XOR. Ws	1	1	N,Z
		XOR	Wb,#lit5,Wd	Wd = Wb .XOR. lit5	1	1	N,Z
71	ZE	ZE	Ws,Wnd	Wnd = Zero-extend Ws	1	1	C,Z,N

NOTES:	

20.0 DEVELOPMENT SUPPORT

The PIC[®] microcontrollers are supported with a full range of hardware and software development tools:

- · Integrated Development Environment
 - MPLAB® IDE Software
- · Assemblers/Compilers/Linkers
 - MPASM™ Assembler
 - MPLAB C18 and MPLAB C30 C Compilers
 - MPLINK[™] Object Linker/ MPLIB[™] Object Librarian
 - MPLAB ASM30 Assembler/Linker/Library
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB ICE 2000 In-Circuit Emulator
 - MPLAB REAL ICE™ In-Circuit Emulator
- · In-Circuit Debugger
 - MPLAB ICD 2
- · Device Programmers
 - PICSTART® Plus Development Programmer
 - MPLAB PM3 Device Programmer
 - PICkit™ 2 Development Programmer
- Low-Cost Demonstration and Development Boards and Evaluation Kits

20.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- · A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- · A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- · High-level source code debugging
- Visual device initializer for easy register initialization
- · Mouse over variable inspection
- Drag and drop variables from source to watch windows
- · Extensive on-line help
- Integration of select third party tools, such as HI-TECH Software C Compilers and IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either assembly or C)
- One touch assemble (or compile) and download to PIC MCU emulator and simulator tools (automatically updates all project information)
- · Debug using:
 - Source files (assembly or C)
 - Mixed assembly and C
 - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

20.2 MPASM Assembler

The MPASM Assembler is a full-featured, universal macro assembler for all PIC MCUs.

The MPASM Assembler generates relocatable object files for the MPLINK Object Linker, Intel® standard HEX files, MAP files to detail memory usage and symbol reference, absolute LST files that contain source lines and generated machine code and COFF files for debugging.

The MPASM Assembler features include:

- · Integration into MPLAB IDE projects
- User-defined macros to streamline assembly code
- Conditional assembly for multi-purpose source files
- Directives that allow complete control over the assembly process

20.3 MPLAB C18 and MPLAB C30 C Compilers

The MPLAB C18 and MPLAB C30 Code Development Systems are complete ANSI C compilers for Microchip's PIC18 and PIC24 families of microcontrollers and the dsPIC30 and dsPIC33 family of digital signal controllers. These compilers provide powerful integration capabilities, superior code optimization and ease of use not found with other compilers.

For easy source level debugging, the compilers provide symbol information that is optimized to the MPLAB IDE debugger.

20.4 MPLINK Object Linker/ MPLIB Object Librarian

The MPLINK Object Linker combines relocatable objects created by the MPASM Assembler and the MPLAB C18 C Compiler. It can link relocatable objects from precompiled libraries, using directives from a linker script.

The MPLIB Object Librarian manages the creation and modification of library files of precompiled code. When a routine from a library is called from a source file, only the modules that contain that routine will be linked in with the application. This allows large libraries to be used efficiently in many different applications.

The object linker/library features include:

- Efficient linking of single libraries instead of many smaller files
- Enhanced code maintainability by grouping related modules together
- Flexible creation of libraries with easy module listing, replacement, deletion and extraction

20.5 MPLAB ASM30 Assembler, Linker and Librarian

MPLAB ASM30 Assembler produces relocatable machine code from symbolic assembly language for dsPIC30F devices. MPLAB C30 C Compiler uses the assembler to produce its object file. The assembler generates relocatable object files that can then be archived or linked with other relocatable object files and archives to create an executable file. Notable features of the assembler include:

- · Support for the entire dsPIC30F instruction set
- Support for fixed-point and floating-point data
- · Command line interface
- · Rich directive set
- · Flexible macro language
- · MPLAB IDE compatibility

20.6 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C18 and MPLAB C30 C Compilers, and the MPASM and MPLAB ASM30 Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

20.7 MPLAB ICE 2000 High-Performance In-Circuit Emulator

The MPLAB ICE 2000 In-Circuit Emulator is intended to provide the product development engineer with a complete microcontroller design tool set for PIC microcontrollers. Software control of the MPLAB ICE 2000 In-Circuit Emulator is advanced by the MPLAB Integrated Development Environment, which allows editing, building, downloading and source debugging from a single environment.

The MPLAB ICE 2000 is a full-featured emulator system with enhanced trace, trigger and data monitoring features. Interchangeable processor modules allow the system to be easily reconfigured for emulation of different processors. The architecture of the MPLAB ICE 2000 In-Circuit Emulator allows expansion to support new PIC microcontrollers.

The MPLAB ICE 2000 In-Circuit Emulator system has been designed as a real-time emulation system with advanced features that are typically found on more expensive development tools. The PC platform and Microsoft® Windows® 32-bit operating system were chosen to best make these features available in a simple, unified application.

20.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC[®] Flash MCUs and dsPIC[®] Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The MPLAB REAL ICE probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with the popular MPLAB ICD 2 system (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

MPLAB REAL ICE is field upgradeable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added, such as software breakpoints and assembly code trace. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, real-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

20.9 MPLAB ICD 2 In-Circuit Debugger

Microchip's In-Circuit Debugger, MPLAB ICD 2, is a powerful, low-cost, run-time development tool, connecting to the host PC via an RS-232 or high-speed USB interface. This tool is based on the Flash PIC MCUs and can be used to develop for these and other PIC MCUs and dsPIC DSCs. The MPLAB ICD 2 utilizes the in-circuit debugging capability built into the Flash devices. This feature, along with Microchip's In-Circuit Serial Programming™ (ICSP™) protocol, offers cost-effective, in-circuit Flash debugging from the graphical user interface of the MPLAB Integrated Development Environment. This enables a designer to develop and debug source code by setting breakpoints, single stepping and watching variables, and CPU status and peripheral registers. Running at full speed enables testing hardware and applications in real time. MPLAB ICD 2 also serves as a development programmer for selected PIC devices.

20.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages and a modular, detachable socket assembly to support various package types. The ICSP™ cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices and incorporates an SD/MMC card for file storage and secure data applications.

20.11 PICSTART Plus Development Programmer

The PICSTART Plus Development Programmer is an easy-to-use, low-cost, prototype programmer. It connects to the PC via a COM (RS-232) port. MPLAB Integrated Development Environment software makes using the programmer simple and efficient. The PICSTART Plus Development Programmer supports most PIC devices in DIP packages up to 40 pins. Larger pin count devices, such as the PIC16C92X and PIC17C76X, may be supported with an adapter socket. The PICSTART Plus Development Programmer is CE compliant.

20.12 PICkit 2 Development Programmer

The PICkit™ 2 Development Programmer is a low-cost programmer and selected Flash device debugger with an easy-to-use interface for programming many of Microchip's baseline, mid-range and PIC18F families of Flash memory microcontrollers. The PICkit 2 Starter Kit includes a prototyping development board, twelve sequential lessons, software and HI-TECH's PICC™ Lite C compiler, and is designed to help get up to speed quickly using PIC® microcontrollers. The kit provides everything needed to program, evaluate and develop applications using Microchip's powerful, mid-range Flash memory family of microcontrollers.

20.13 Demonstration, Development and Evaluation Boards

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, Keelog® security ICs, CAN, IrDA®, PowerSmart battery management, Seeval® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

21.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of PIC24HJ32GP202/204 and PIC24HJ16GP304 electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24HJ32GP202/204 and PIC24HJ16GP304 family are listed below. Exposure to these maximum rating conditions for extended periods can affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

Absolute Maximum Ratings⁽¹⁾

Ambient temperature under bias	40°C to +125°C
Storage temperature	
Voltage on VDD with respect to Vss	-0.3V to +4.0V
Voltage on any combined analog and digital pin and MCLR, with respect to Vss	0.3V to (VDD + 0.3V)
Voltage on any digital-only pin with respect to Vss	-0.3V to +5.6V
Voltage on VDDCORE with respect to Vss	2.25V to 2.75V
Maximum current out of Vss pin	300 mA
Maximum current into VDD pin ⁽²⁾	250 mA
Maximum output current sunk by any I/O pin ⁽³⁾	4 mA
Maximum output current sourced by any I/O pin ⁽³⁾	4 mA
Maximum current sunk by all ports	200 mA
Maximum current sourced by all ports ⁽²⁾	200 mA

- **Note 1:** Stresses above those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods can affect device reliability.
 - 2: Maximum allowable current is a function of device maximum power dissipation (see Table 21-2).
 - **3:** Exceptions are CLKOUT, which is able to sink/source 25 mA, and the VREF+, VREF-, SCLx, SDAx, PGCx and PGDx pins, which are able to sink/source 12 mA.

21.1 DC Characteristics

TABLE 21-1: OPERATING MIPS VS. VOLTAGE

Characteristic	VDD Range (in Volts)	Temp Range (in °C)	Max MIPS PIC24HJ32GP202/204 and PIC24HJ16GP304
	3.0-3.6V	-40°C to +85°C	40
	3.0-3.6V	-40°C to +125°C	40

TABLE 21-2: THERMAL OPERATING CONDITIONS

Rating	Symbol	Min	Тур	Max	Unit
Industrial Temperature Devices					
Operating Junction Temperature Range	TJ	-40	_	+125	°C
Operating Ambient Temperature Range	TA	-40	_	+85	°C
Extended Temperature Devices					
Operating Junction Temperature Range	TJ	-40	_	+140	°C
Operating Ambient Temperature Range	TA	-40	_	+125	°C
Power Dissipation: Internal chip power dissipation: $PINT = VDD \ x \ (IDD - \Sigma \ IOH)$	PD	!	PINT + PI/O)	W
I/O Pin Power Dissipation: I/O = Σ ({VDD - VOH} x IOH) + Σ (VOL x IOL)					
Maximum Allowed Power Dissipation	PDMAX	(ΤJ - ΤΑ)/θJΑ			W

TABLE 21-3: THERMAL PACKAGING CHARACTERISTICS

Characteristic	Symbol	Тур	Max	Unit	Notes
Package Thermal Resistance, 44-pin QFN	θ JA	32	_	°C/W	1
Package Thermal Resistance, 44-pin TFQP	θ JA	45	_	°C/W	1
Package Thermal Resistance, 28-pin SPDIP	θ JA	45	_	°C/W	1
Package Thermal Resistance, 28-pin SOIC	θја	50	_	°C/W	1
Package Thermal Resistance, 28-pin QFN-S	θ JA	35	_	°C/W	1

Note 1: Junction to ambient thermal resistance, Theta-JA (θ JA) numbers are achieved by package simulations.

TABLE 21-4: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CHA	ARACTER	ISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteristic	Min Typ ⁽¹⁾ Max Units Conditions						
Operati	ng Voltage	9							
DC10	Supply V	/oltage							
	VDD	_	3.0	_	3.6	V	Industrial and Extended		
DC12	VDR	RAM Data Retention Voltage ⁽²⁾	1.1	_	1.8	V	_		
DC16	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	_	_	Vss	V	_		
DC17	SVDD	VDD Rise Rate to ensure internal Power-on Reset signal	0.03	_	_	V/ms	0-3.0V in 0.1s		
DC18	VCORE	VDD Core ⁽³⁾ Internal regulator voltage	2.25	_	2.75	V	Voltage is dependent on load, temperature and VDD		

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

^{2:} This is the limit to which VDD can be lowered without losing RAM data.

^{3:} These parameters are characterized but not tested in manufacturing.

TABLE 21-5: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACT	ERISTICS		(unless other	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended						
Parameter No.	Typical ⁽¹⁾	Max	Units	Units Conditions						
Operating Cur	rent (IDD) ⁽²⁾									
DC20d	24	30	mA	-40°C						
DC20a	27	30	mA	+25°C	3.3V	10 MIPS				
DC20b	27	30	mA	+85°C	3.3V	10 WIFS				
DC20c	27	35	mA	+125°C						
DC21d	30	40	mA	-40°C						
DC21a	37	40	mA	+25°C	3.3V	16 MIPS				
DC21b	32	45	mA	+85°C	3.3V	10 WIFS				
DC21c	33	45	mA	+125°C						
DC22d	35	50	mA	-40°C						
DC22a	38	50	mA	+25°C	3.3V	20 MIPS				
DC22b	38	55	mA	+85°C	3.3V	20 WIFS				
DC22c	39	55	mA	+125°C						
DC23d	47	70	mA	-40°C						
DC23a	48	70	mA	+25°C	3.3V	30 MIPS				
DC23b	48	70	mA	+85°C	3.3V	30 WIFS				
DC23c	48	70	mA	+125°C						
DC24d	56	90	mA	-40°C						
DC24a	56	90	mA	+25°C	3.3V	40 MIPS				
DC24b	54	90	mA	+85°C	3.31	40 WIFS				
DC24c	54	90	mA	+125°C						

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

^{2:} The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows: OSC1 driven with external square wave from rail to rail. All I/O pins are configured as inputs and pulled to Vss. MCLR = VDD, WDT and FSCM are disabled. CPU, SRAM, program memory and data memory are operational. No peripheral modules are operating; however, every peripheral is being clocked (PMD bits are all zeroed).

TABLE 21-6: DC CHARACTERISTICS: IDLE CURRENT (IIDLE)

DC CHARACTI	ERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended							
Parameter No.	Typical ⁽¹⁾	Max	Units	Conditions						
Idle Current (III	DLE): Core OF	F Clock ON	Base Curren	t ⁽²⁾						
DC40d	3	25	mA	-40°C						
DC40a	3	25	mA	+25°C		10 MIPS				
DC40b	3	25	mA	+85°C	3.3V	10 MIFS				
DC40c	3	25	mA	+125°C						
DC41d	4	25	mA	-40°C						
DC41a	4	25	mA	+25°C	3.3V	16 MIPS				
DC41b	5	25	mA	+85°C	3.3V	16 IVIIPS				
DC41c	5	25	mA	+125°C						
DC42d	6	25	mA	-40°C						
DC42a	6	25	mA	+25°C	3.3V	20 MIPS				
DC42b	7	25	mA	+85°C	3.3V	20 MIPS				
DC42c	7	25	mA	+125°C						
DC43d	9	25	mA	-40°C						
DC43a	9	25	mA	+25°C	3.3V	30 MIPS				
DC43b	9	25	mA	+85°C	3.3V	30 IVIIPS				
DC43c	9	25	mA	+125°C						
DC44d	10	25	mA	-40°C						
DC44a	10	25	mA	+25°C	3.3V	40 MIDS				
DC44b	16	25	mA	+85°C	J 3.3V	40 MIPS				
DC44c	10	25	mA	+125°C						

Note 1: Data in "Typical" column is at 3.3V, 25°C unless otherwise stated.

^{2:} Base IIDLE current is measured with core off, clock on and all modules turned off. Peripheral Module Disable SFR registers are zeroed. All I/O pins are configured as inputs and pulled to Vss.

TABLE 21-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACT	ERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended							
Parameter No.	Typical ⁽¹⁾	Max	Units	Conditions						
Power-Down Current (IPD) ⁽²⁾										
DC60d	55	500	μΑ	-40°C						
DC60a	63	500	μΑ	+25°C	3.3V	Base Power-Down Current ^(3,4)				
DC60b	85	500	μΑ	+85°C	3.34	Base Fower-Down Current				
DC60c	146	1	mA	+125°C						
DC61d	8	12	μΑ	-40°C						
DC61a	10	15	μΑ	+25°C	2 2)/	Watchdog Timer Current: ∆IwDT ⁽³⁾				
DC61b	12	20	μΑ	+85°C	3.3V	watchdog Timer Current: Alworks,				
DC61c	13	25	μΑ	+125°C						

- Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated.
 - 2: Base IPD is measured with all peripherals and clocks shut down. All I/Os are configured as inputs and pulled to Vss. WDT, etc., are all switched off, and VREGS (RCON<8>)=1.
 - **3:** The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
 - **4:** These currents are measured on the device containing the most memory in this family.

TABLE 21-8: DC CHARACTERISTICS: DOZE CURRENT (IDOZE)

DC CHARACTER	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended							
Parameter No.	Doze Ratio	Units		Conditions				
DC73a	25	32	1:2	mA				
DC73f	23	27	1:64	mA	-40°C	3.3V	40 MIPS	
DC73g	23	26	1:128	mA				
DC70a	42	47	1:2	mA		3.3V	40 MIPS	
DC70f	26	27	1:64	mA	+25°C			
DC70g	25	27	1:128	mA				
DC71a	41	48	1:2	mA				
DC71f	25	28	1:64	mA	+85°C	3.3V	40 MIPS	
DC71g	24	28	1:128	mA				
DC72a	42	49	1:2	mA		·		
DC72f	26	29	1:64	mA	+125°C	3.3V	40 MIPS	
DC72g	25	28	1:128	mA				

Note 1: Data in the Typical column is at 3.3V, 25°C unless otherwise stated.

TABLE 21-9: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS

DC CHA	RACTER	ISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteristic	Min	Typ ⁽¹⁾	Max	Units	Conditions		
	VIL	Input Low Voltage							
DI10		I/O pins	Vss	_	0.2 VDD	V			
DI15		MCLR	Vss	_	0.2 VDD	V			
DI16		OSC1 (XT mode)	Vss	_	0.2 VDD	V			
DI17		OSC1 (HS mode)	Vss	_	0.2 VDD	V			
DI18		SDAx, SCLx	Vss	_	0.3 VDD	V	SMBus disabled		
DI19		SDAx, SCLx	Vss	_	0.2 VDD	V	SMBus enabled		
	VIH	Input High Voltage							
DI20		I/O pins: with analog functions ⁽⁴⁾ digital-only ⁽⁴⁾	0.8 VDD 0.8 VDD	_ _	V _{DD} 5.5	V V			
DI25		MCLR	0.8 VDD	_	VDD	V			
DI26		OSC1 (XT mode)	0.7 VDD	_	VDD	V			
DI27		OSC1 (HS mode)	0.7 VDD	_	VDD	V			
DI28		SDAx, SCLx	0.7 VDD	_	VDD	V	SMBus disabled		
DI29		SDAx, SCLx	0.8 VDD	_	VDD	V	SMBus enabled		
	ICNPU	CNx Pull-up Current							
DI30			50	250	400	μΑ	VDD = 3.3V, VPIN = VSS		
	II∟	Input Leakage Current ⁽²⁾⁽³⁾							
DI50		I/O ports	_	_	±2	μΑ	Vss ≤ Vpin ≤ Vdd, Pin at high-impedance		
DI51		Analog Input Pins	_	_	±1	μΑ	$\begin{tabular}{ll} VSS \le VPIN \le VDD, Pin at \\ high-impedance, \\ 40^{\circ}C \le TA \le +85^{\circ}C \end{tabular}$		
DI51a		Analog Input Pins	_	_	±2	μΑ	Analog pins shared with external reference pins, $40^{\circ}C \le TA \le +85^{\circ}C$		
DI51b		Analog Input Pins	_	_	±3.5	μΑ	Vss ≤ VpiN ≤ Vdd, Pin at high-impedance, -40°C ≤ Ta ≤ +125°C		
DI51c		Analog Input Pins	_	_	±8	μΑ	Analog pins shared with external reference pins, -40°C ≤ Ta ≤ +125°C		
DI55		MCLR	_	_	±2	μΑ	$Vss \leq Vpin \leq Vdd$		
DI56		OSC1	_		±2	μΑ	VSS ≤ VPIN ≤ VDD, XT and HS modes		

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

- 2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3: Negative current is defined as current sourced by the pin.
- 4: See Table 9-1 for a list of digital-only and analog pins.

TABLE 21-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteristic	Min Typ Max Units Conditions						
	Vol	Output Low Voltage							
DO10		I/O ports	_	_	0.4	V	IOL = 2mA, VDD = 3.3V		
DO16		OSC2/CLKO	_		0.4	V	IOL = 2mA, VDD = 3.3V		
	Vон	Output High Voltage							
DO20		I/O ports	2.40	_	_	V	IOH = -2.3 mA, VDD = 3.3V		
DO26		OSC2/CLKO	2.41		_	V	IOH = -1.3 mA, VDD = 3.3V		

TABLE 21-11: ELECTRICAL CHARACTERISTICS: BOR

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic		Min ⁽¹⁾	Тур	Max	Units	Conditions
BO10	VBOR	BOR Event on VDD transition high-to-low BOR event is tied to VDD core voltage decrease		2.40	_	2.55	V	_

Note 1: Parameters are for design guidance only and are not tested in manufacturing.

TABLE 21-12: DC CHARACTERISTICS: PROGRAM MEMORY

DC CHARACTERISTICS				Standard Operating Co (unless otherwise state Operating temperature			s: 3.0V to 3.6V ≤ TA ≤ +85°C for Industrial ≤ TA ≤ +125°C for Extended
Param No.	Symbol	Characteristic	Min	Min Typ ⁽¹⁾ Max U		Units	Conditions
		Program Flash Memory					
D130	EP	Cell Endurance	10,000	_	_	E/W	-40°C to +125°C
D131	VPR	VDD for Read	VMIN	-	3.6	V	Vмін = Minimum operating voltage
D132B	VPEW	VDD for Self-Timed Write	VMIN	_	3.6	V	VміN = Minimum operating voltage
D134	TRETD	Characteristic Retention	20	_	_	Year	Provided no other specifications are violated, -40°C to +125°C
D135	IDDP	Supply Current during Programming	_	10	_	mA	
D136a	Trw	Row Write Time	1.32	-	1.74	ms	TRW = 11064 FRC cycles, TA = +85°C, See Note 2
D136b	Trw	Row Write Time	1.28	-	1.79	ms	TRW = 11064 FRC cycles, TA = +125°C, See Note 2
D137a	TPE	Page Erase Time	20.1	-	26.5	ms	TPE = 168517 FRC cycles, TA = +85°C, See Note 2
D137b	TPE	Page Erase Time	19.5	_	27.3	ms	TPE = 168517 FRC cycles, TA = +125°C, See Note 2
D138a	Tww	Word Write Cycle Time	42.3	_	55.9	μS	Tww = 355 FRC cycles, TA = +85°C, See Note 2
D138b	Tww	Word Write Cycle Time	41.1	_	57.6	μS	Tww = 355 FRC cycles, TA = +125°C, See Note 2

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

2: Other conditions: FRC = 7.37 MHz, TUN<5:0> = b'011111 (for Min), TUN<5:0> = b'100000 (for Max). This parameter depends on the FRC accuracy (see Table 21-18) and the value of the FRC Oscillator Tuning register (see Register 7-4). For complete details on calculating the Minimum and Maximum time see Section 4.3 "Programming Operations".

TABLE 21-13: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)

Operating temperature ~ -40°C $\leq~$ Ta $\leq~$ +85°C for Industrial

 $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended

Param No.	Symbol	Characteristics	Min	Тур	Max	Units	Comments
	CEFC	External Filter Capacitor Value	1	10	_		Capacitor must be low series resistance (< 5 ohms)

21.2 AC Characteristics and Timing Parameters

The information contained in this section defines PIC24HJ32GP202/204 and PIC24HJ16GP304 AC characteristics and timing parameters.

TABLE 21-14: TEMPERATURE AND VOLTAGE SPECIFICATIONS - AC

	Standard Operating Conditions: 3.0V to 3.6V
	(unless otherwise stated)
AC CHARACTERISTICS	Operating temperature -40°C ≤ TA ≤ +85°C for Industrial
AC CHARACTERISTICS	-40°C ≤ TA ≤ +125°C for Extended
	Operating voltage VDD range as described in Section 21.0 "Electrical
	Characteristics".

FIGURE 21-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

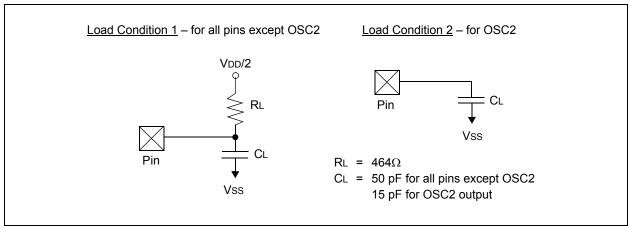


TABLE 21-15: CAPACITIVE LOADING REQUIREMENTS ON OUTPUT PINS

Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
DO50	Cosc2	OSC2/SOSC2 pin	_	_	15	pF	In XT and HS modes when external clock is used to drive OSC1
DO56	Сю	All I/O pins and OSC2	_	_	50	pF	EC mode
DO58	Св	SCLx, SDAx	_	_	400	pF	In I ² C™ mode

FIGURE 21-2: EXTERNAL CLOCK TIMING

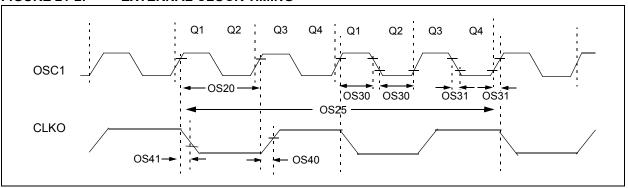


TABLE 21-16: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symb	Characteristic	Min Typ ⁽¹⁾ Max Units Condi						
OS10	Fin	External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC	_	40	MHz	EC		
		Oscillator Crystal Frequency	3.5 10	_ _ _	10 40 33	MHz MHz kHz	XT HS SOSC		
OS20	Tosc	Tosc = 1/Fosc	12.5	_	DC	ns	_		
OS25	TCY	Instruction Cycle Time ⁽²⁾	25	_	DC	ns	_		
OS30	TosL, TosH	External Clock in (OSC1) High or Low Time	0.375 x Tosc	_	0.625 x Tosc	ns	EC		
OS31	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	_	_	20	ns	EC		
OS40	TckR	CLKO Rise Time ⁽³⁾	_	5.2	_	ns	_		
OS41	TckF	CLKO Fall Time ⁽³⁾	_	5.2	_	ns			

- **Note 1:** Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.
 - 2: Instruction cycle period (TcY) equals two times the input oscillator time-base period. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits can result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "min." values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the "max." cycle time limit is "DC" (no clock) for all devices.
 - 3: Measurements are taken in EC mode. The CLKO signal is measured on the OSC2 pin.

TABLE 21-17: PLL CLOCK TIMING SPECIFICATIONS (VDD = 3.0V TO 3.6V)

AC CHA	RACTERIS	STICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteris	tic	Min	Typ ⁽¹⁾	Max	Units	Conditions		
OS50	FPLLI	PLL Voltage Controll Oscillator (VCO) Inpu Frequency Range		0.8		8	MHz	ECPLL, XTPLL modes		
OS51	Fsys	On-Chip VCO Syster Frequency	n	100		200	MHz	_		
OS52	TLOCK	PLL Start-up Time (L	ock Time)	0.9	1.5	3.1	ms	_		
OS53	DCLK	CLKO Stability (Jitter	·)	-3	0.5	3	%	Measured over 100 ms period		

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

TABLE 21-18: AC CHARACTERISTICS: INTERNAL RC ACCURACY

AC CHA	RACTERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended									
Param No.	Characteristic	Min	Тур	Max	Units	s Conditions					
	Internal FRC Accuracy @	FRC Fr	equency	= 7.37 N	IHz ^(1,2)						
F20	FRC	-2	_	+2	%	-40°C ≤ TA ≤ +85°C	VDD = 3.0-3.6V				
	FRC	-5	_	+5	%	-40°C ≤ TA ≤ +125°C					

Note 1: Frequency calibrated at 25°C and 3.3V. TUN bits can be used to compensate for temperature drift.

2: FRC is set to initial frequency of 7.37 MHz (±2%) at 25°C.

TABLE 21-19: INTERNAL RC ACCURACY

AC CH	ARACTERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Characteristic	Min	Тур	Max	Units	nits Conditions		
	LPRC @ 32.768 kHz ^(1,2)							
F21	LPRC	-20	±6	+20	%	-40°C ≤ TA ≤ +85°C		
	LPRC	-70		+70	%	$-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$	VDD = 3.0-3.6V	

Note 1: Change of LPRC frequency as VDD changes.

2: LPRC accuracy impacts the Watchdog Timer Time-out Period (TWDT1). See Section 18.4 "Watchdog Timer (WDT)" for more information.

FIGURE 21-3: I/O TIMING CHARACTERISTICS

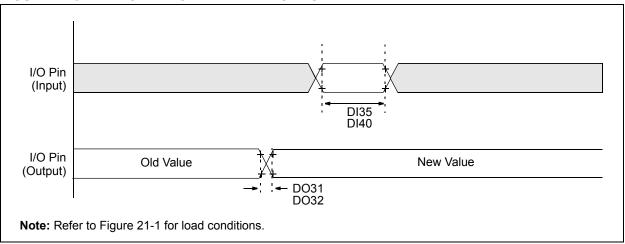


TABLE 21-20: I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)							
Param No.	Symbol	Characte	Min	Typ ⁽¹⁾	Max	Units	Conditions			
DO31	TioR	Port Output Rise Tim	е	_	10	25	ns	_		
DO32	TioF	Port Output Fall Time	;	_	10	25	ns			
DI35	TINP	INTx Pin High or Low	20	_		ns				
DI40	TRBP	CNx High or Low Tim	ne (input)	2	_	_	Tcy	_		

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

FIGURE 21-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING CHARACTERISTICS

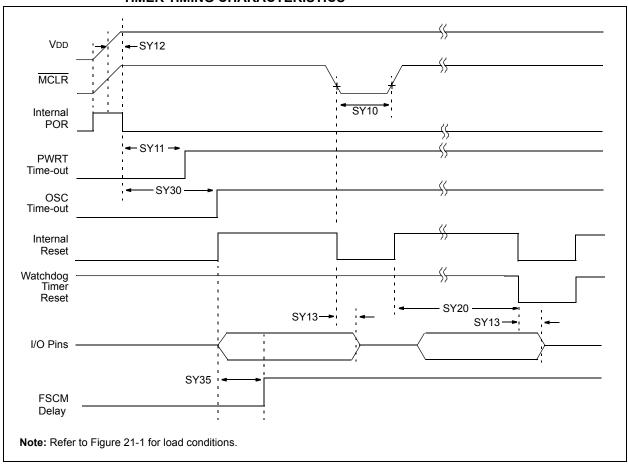


TABLE 21-21: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER, POWER-UP TIMER TIMING REQUIREMENTS

AC CHA	AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteristic ⁽¹⁾	Min Typ ⁽²⁾ Max Units Conditions							
SY10	TMCL	MCLR Pulse-Width (low)	2	_	_	μS	-40°C to +85°C			
SY11	TPWRT	Power-up Timer Period	_	2 4 8 16 32 64 128	_	ms	-40°C to +85°C User programmable			
SY12	TPOR	Power-on Reset Delay	3	10	30	μS	-40°C to +85°C			
SY13	Tioz	I/O High-Impedance from MCLR Low or Watchdog Timer Reset	0.68	0.72	1.2	μS	_			
SY20	TWDT1	Watchdog Timer Time-out Period (No Prescaler)	_		_	ms	See Section 18.4 "Watchdog Timer (WDT)" and LPRC specification F21 (Table 21-19).			
SY30	Tost	Oscillator Start-up Time	_	1024 Tosc	_	_	Tosc = OSC1 period			
SY35	TFSCM	Fail-Safe Clock Monitor Delay	_	500	900	μS	-40°C to +85°C			

Note 1: These parameters are characterized but not tested in manufacturing.

^{2:} Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

FIGURE 21-5: TIMER1, 2 AND 3 EXTERNAL CLOCK TIMING CHARACTERISTICS

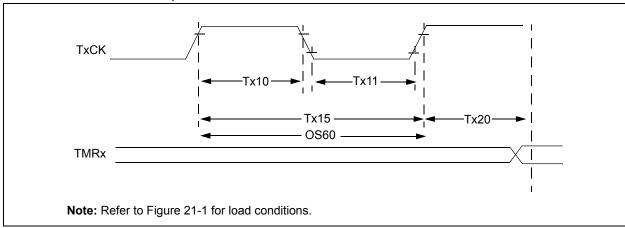


TABLE 21-22: TIMER1 EXTERNAL CLOCK TIMING REQUIREMENTS⁽¹⁾

AC CHARACTERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)
AC CHARACTERISTICS	Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial
	-40°C ≤ TA ≤ +125°C for Extended

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Param No.	Symbol	Characte	eristic	Min	Тур	Max	Units	Conditions
TA10	ТтхН	TxCK High Time	Synchronous, no prescaler	0.5 Tcy + 20	_	_	ns	Must also meet parameter TA15
			Synchronous, with prescaler	10	1	_	ns	
			Asynchronous	10		_	ns	
TA11	TTXL	TxCK Low Time	Synchronous, no prescaler	0.5 Tcy + 20	_	_	ns	Must also meet parameter TA15
			Synchronous, with prescaler	10	_	_	ns	
			Asynchronous	10		_	ns	
TA15	ТтхР	TxCK Input Period	Synchronous, no prescaler	Tcy + 40	_	_	ns	_
			Synchronous, with prescaler	Greater of: 20 ns or (Tcy + 40)/N	_	_	_	N = prescale value (1, 8, 64, 256)
			Asynchronous	20	_	_	ns	_
OS60	Ft1	SOSC1/T1CK Osci frequency Range (o by setting bit TCS (scillator enabled	DC	_	50	kHz	_
TA20	TCKEXTMRL	Delay from Externa Edge to Timer Incre		0.5 Tcy		1.5 TCY	_	_

Note 1: Timer1 is a Type A.

TABLE 21-23: TIMER2 EXTERNAL CLOCK TIMING REQUIREMENTS

Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated)
Operating temperature -40°C ≤ TA ≤ +85°C for Industrial

 $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended **Param** Symbol Characteristic Min Max **Units Conditions** Typ No. TB10 TtxH TxCK High Time Synchronous, 0.5 Tcy + 20Must also meet ns no prescaler parameter TB15 Synchronous, 10 ns with prescaler **TB11** TtxL **TxCK Low Time** Synchronous, 0.5 Tcy + 20Must also meet ns no prescaler parameter TB15 Synchronous, 10 ns with prescaler TxCK Input **TB15 TtxP** Synchronous, Tcy + 40 ns N = prescale Period no prescaler value (1, 8, 64, 256) Synchronous, Greater of: with prescaler 20 ns or (Tcy + 40)/N**TB20** TCKEXT-Delay from External TxCK Clock 0.5 Tcy 1.5 Tcy Edge to Timer Increment MRL

TABLE 21-24: TIMER3 EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq \text{TA} \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq \text{TA} \leq +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characte	eristic		Min	Тур	Max	Units	Conditions	
TC10	TtxH	TxCK High Time	Synchro	nous	0.5 Tcy + 20			ns	Must also meet parameter TC15	
TC11	TtxL	TxCK Low Time	Synchro	nous	0.5 Tcy + 20	_	_	ns	Must also meet parameter TC15	
TC15	TtxP	TxCK Input Period	Synchron no preso		Tcy + 40	_	_	ns	N = prescale value	
			Synchro with pres		Greater of: 20 ns or (Tcy + 40)/N				(1, 8, 64, 256)	
TC20	TCKEXTMRL	Delay from Externa Edge to Timer Incre		ock	0.5 TcY	-	1.5 Tcy	_	_	

FIGURE 21-6: INPUT CAPTURE (CAPx) TIMING CHARACTERISTICS

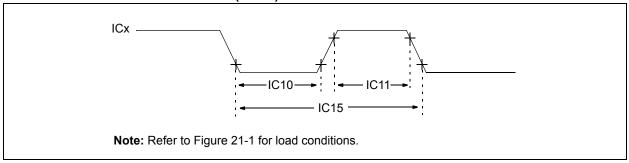


TABLE 21-25: INPUT CAPTURE TIMING REQUIREMENTS

AC CHA	RACTERI	STICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +125^{\circ}C$ for Extended						
Param No.	Symbol	Characte	ristic ⁽¹⁾	Max	Units	Conditions			
IC10	TccL	ICx Input Low Time	No Prescaler	0.5 Tcy + 20	_	ns	_		
			With Prescaler	10	_	ns			
IC11	TccH	ICx Input High Time	No Prescaler	0.5 Tcy + 20	_	ns	_		
			With Prescaler	10	_	ns			
IC15	TccP	ICx Input Period	(TcY + 40)/N — ns N = presc value (1, 4						

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 21-7: OUTPUT COMPARE MODULE (OCx) TIMING CHARACTERISTICS

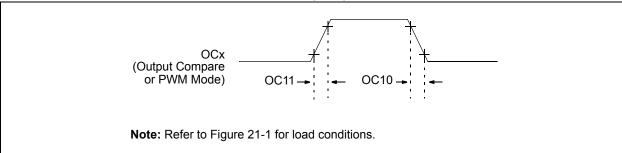


TABLE 21-26: OUTPUT COMPARE MODULE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended						
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Тур	Max	Units	Conditions		
OC10	TccF	OCx Output Fall Time	_	_	_	ns	See parameter D032		
OC11	TccR	OCx Output Rise Time	_	_	_	ns	See parameter D031		

Note 1: These parameters are characterized but not tested in manufacturing.

FIGURE 21-8: OC/PWM MODULE TIMING CHARACTERISTICS

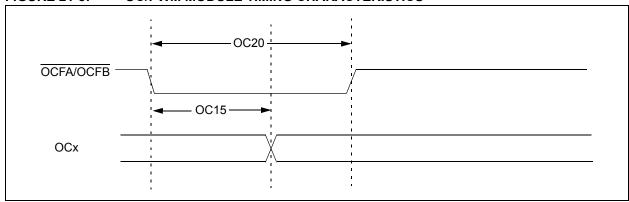


TABLE 21-27: SIMPLE OC/PWM MODE TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic ⁽¹⁾	Min Typ Max Units Conditions					
OC15	TFD	Fault Input to PWM I/O Change	_	_	50	ns	_	
OC20	TFLT	Fault Input Pulse-Width	50	_	_	ns	_	

Note 1: These parameters are characterized but not tested in manufacturing.

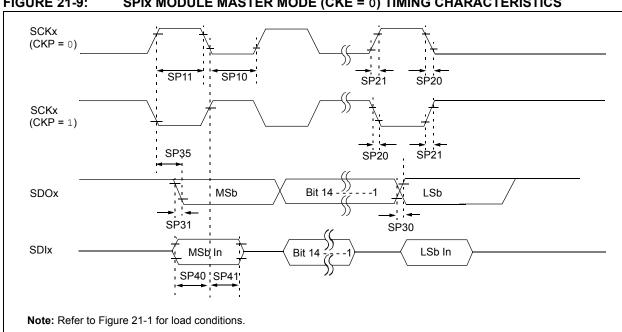


FIGURE 21-9: SPIX MODULE MASTER MODE (CKE = 0) TIMING CHARACTERISTICS

TABLE 21-28: SPIX MASTER MODE (CKE = 0) TIMING REQUIREMENTS

AC CHA	ARACTERIST	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended							
Param No.	Symbol	Characteristic ⁽¹⁾	Min Typ ⁽²⁾ Max Units Conditions						
SP10	TscL	SCKx Output Low Time	Tcy/2	_	_	ns	See Note 3		
SP11	TscH	SCKx Output High Time	Tcy/2	_	_	ns	See Note 3		
SP20	TscF	SCKx Output Fall Time	_	_	_	ns	See parameter D032 and Note 4		
SP21	TscR	SCKx Output Rise Time	_	_	_	ns	See parameter D031 and Note 4		
SP30	TdoF	SDOx Data Output Fall Time	_	_	_	ns	See parameter D032 and Note 4		
SP31	TdoR	SDOx Data Output Rise Time	_	_	_	ns	See parameter D031 and Note 4		
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	6	20	ns	_		
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	23	_	_	ns	_		
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30	_	_	ns	_		

- **Note 1:** These parameters are characterized but not tested in manufacturing.
 - 2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.
 - 3: The minimum clock period for SCKx is 100 ns. Therefore, the clock generated in Master mode must not violate this specification.
 - 4: Assumes 50 pF load on all SPIx pins.

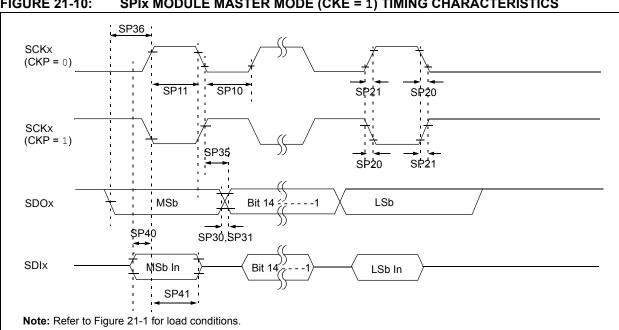
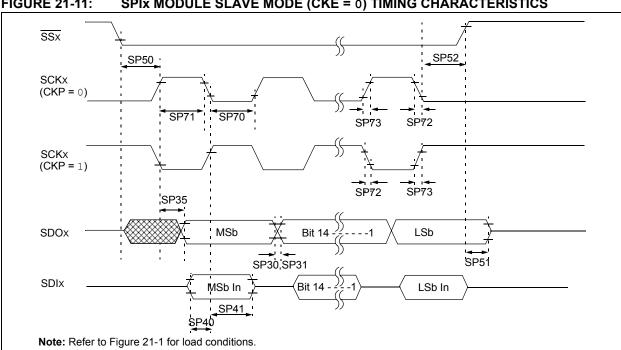


FIGURE 21-10: SPIX MODULE MASTER MODE (CKE = 1) TIMING CHARACTERISTICS

TABLE 21-29: SPIX MODULE MASTER MODE (CKE = 1) TIMING REQUIREMENTS

AC CHA	RACTERIST	rics	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions	
SP10	TscL	SCKx Output Low Time	Tcy/2	_	_	ns	See Note 3	
SP11	TscH	SCKx Output High Time	Tcy/2	_	_	ns	See Note 3	
SP20	TscF	SCKx Output Fall Time	_	_	_	ns	See parameter D032 and Note 4	
SP21	TscR	SCKx Output Rise Time	_	_	_	ns	See parameter D031 and Note 4	
SP30	TdoF	SDOx Data Output Fall Time	_	_	_	ns	See parameter D032 and Note 4	
SP31	TdoR	SDOx Data Output Rise Time	_	_	_	ns	See parameter D031 and Note 4	
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	6	20	ns	_	
SP36	TdoV2sc, TdoV2scL	SDOx Data Output Setup to First SCKx Edge	30	_	_	ns	_	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	23	_	_	ns	_	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	30		_	ns	_	

- Note 1: These parameters are characterized but not tested in manufacturing.
 - 2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.
 - The minimum clock period for SCKx is 100 ns. The clock generated in Master mode must not violate this specification.
 - 4: Assumes 50 pF load on all SPIx pins.



SPIX MODULE SLAVE MODE (CKE = 0) TIMING CHARACTERISTICS **FIGURE 21-11:**

TABLE 21-30: SPIx MODULE SLAVE MODE (CKE = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions
SP70	TscL	SCKx Input Low Time	30	_		ns	_
SP71	TscH	SCKx Input High Time	30	_	_	ns	_
SP72	TscF	SCKx Input Fall Time	_	10	25	ns	See Note 3
SP73	TscR	SCKx Input Rise Time	_	10	25	ns	See Note 3
SP30	TdoF	SDOx Data Output Fall Time	_		_	ns	See parameter D032 and Note 3
SP31	TdoR	SDOx Data Output Rise Time	_		_	ns	See parameter D031 and Note 3
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	_	30	ns	_
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	20		_	ns	_
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	20		I	ns	_
SP50	TssL2scH, TssL2scL	$\overline{\text{SSx}} \downarrow \text{to SCKx} \uparrow \text{ or SCKx Input}$	120		1	ns	_
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance	10	_	50	ns	See Note 3
SP52	TscH2ssH TscL2ssH	SSx after SCKx Edge	1.5 Tcy +40	_	_	ns	_

These parameters are characterized but not tested in manufacturing. Note 1:

- Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.
- Assumes 50 pF load on all SPIx pins.

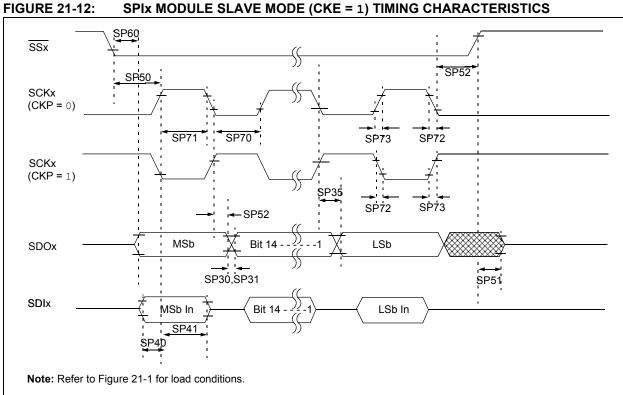


TABLE 21-31: SPIX MODULE SLAVE MODE (CKE = 1) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions	
SP70	TscL	SCKx Input Low Time	30			ns	_	
SP71	TscH	SCKx Input High Time	30	_	_	ns	_	
SP72	TscF	SCKx Input Fall Time	_	10	25	ns	See Note 3	
SP73	TscR	SCKx Input Rise Time	_	10	25	ns	See Note 3	
SP30	TdoF	SDOx Data Output Fall Time	_	_	_	ns	See parameter D032 and Note 3	
SP31	TdoR	SDOx Data Output Rise Time	_	_	_	ns	See parameter D031 and Note 3	
SP35	TscH2doV, TscL2doV	SDOx Data Output Valid after SCKx Edge	_	_	30	ns	_	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDIx Data Input to SCKx Edge	20	_	_	ns	_	
SP41	TscH2diL, TscL2diL	Hold Time of SDIx Data Input to SCKx Edge	20	_	_	ns	_	
SP50	TssL2scH, TssL2scL	SSx ↓ to SCKx ↓ or SCKx ↑ Input	120	_	_	ns	_	
SP51	TssH2doZ	SSx ↑ to SDOx Output High-Impedance	10	_	50	ns	See Note 4	
SP52	TscH2ssH TscL2ssH	SSx ↑ after SCKx Edge	1.5 Tcy + 40	_	_	ns	_	
SP60	TssL2doV	SDOx Data Output Valid after SSx Edge	_	_	50	ns	_	

Note 1: These parameters are characterized but not tested in manufacturing.

^{2:} Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

^{3:} The minimum clock period for SCKx is 100 ns. The clock generated in Master mode must not violate this specification.

^{4:} Assumes 50 pF load on all SPIx pins.

FIGURE 21-13: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)

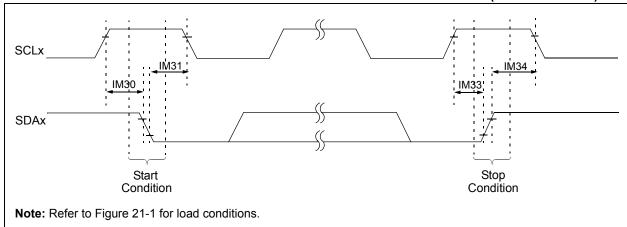


FIGURE 21-14: I2Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)

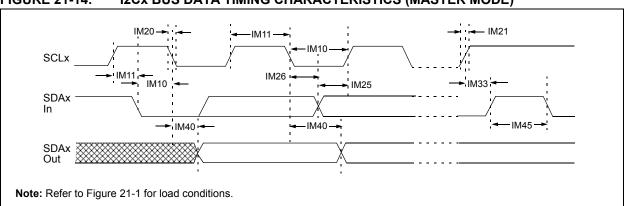


TABLE 21-32: I2Cx BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic		Min ⁽¹⁾	Max	Units	Conditions	
IM10	TLO:SCL	Clock Low Time	100 kHz mode	Tcy/2 (BRG + 1)	_	μS	_	
			400 kHz mode	Tcy/2 (BRG + 1)	_	μS	_	
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	μS	_	
IM11	THI:SCL	Clock High Time	100 kHz mode	Tcy/2 (BRG + 1)	_	μS	_	
			400 kHz mode	Tcy/2 (BRG + 1)	_	μS	_	
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	μS	_	
IM20	TF:SCL	SDAx and SCLx Fall Time	100 kHz mode	_	300	ns	CB is specified to be	
			400 kHz mode	20 + 0.1 CB	300	ns	from 10 to 400 pF	
			1 MHz mode ⁽²⁾	_	100	ns		
IM21	TR:SCL	SDAx and SCLx Rise Time	100 kHz mode	_	1000	ns	CB is specified to be	
			400 kHz mode	20 + 0.1 CB	300	ns	from 10 to 400 pF	
			1 MHz mode ⁽²⁾	_	300	ns		
IM25	TSU:DAT	Data Input Setup Time	100 kHz mode	250	_	ns	_	
			400 kHz mode	100	_	ns		
			1 MHz mode ⁽²⁾	40	_	ns		
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	_	μS	_	
			400 kHz mode	0	0.9	μS		
			1 MHz mode ⁽²⁾	0.2	_	μS		
IM30	Tsu:sta	Start Condition Setup Time	100 kHz mode	Tcy/2 (BRG + 1)	_	μS	Only relevant for	
			400 kHz mode	Tcy/2 (BRG + 1)	_	μS	Repeated Start	
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	μS	condition	
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	Tcy/2 (BRG + 1)	_	μS	After this period the	
			400 kHz mode	Tcy/2 (BRG + 1)	_	μS	first clock pulse is	
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	μS	generated	
IM33	Tsu:sto	Stop Condition Setup Time	100 kHz mode	Tcy/2 (BRG + 1)	_	μS	_	
			400 kHz mode	Tcy/2 (BRG + 1)	_	μS		
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	μS		
IM34	THD:STO	Stop Condition	100 kHz mode	Tcy/2 (BRG + 1)	_	ns	_	
		Hold Time	400 kHz mode	Tcy/2 (BRG + 1)	_	ns		
			1 MHz mode ⁽²⁾	Tcy/2 (BRG + 1)	_	ns		
IM40	TAA:SCL	Coutput Valid From Clock	100 kHz mode	_	3500	ns	_	
			400 kHz mode	_	1000	ns	_	
			1 MHz mode ⁽²⁾	_	400	ns	_	
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be	
			400 kHz mode	1.3	_	μS	free before a new	
			1 MHz mode ⁽²⁾	0.5	_	μS	transmission can start	
IM50	Св	Bus Capacitive L	oading	_	400	pF	_	

Note 1: BRG is the value of the I²C Baud Rate Generator. Refer to Section 19. "Inter-Integrated Circuit (I2C™)" in the "PIC24H Family Reference Manual".

^{2:} Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

FIGURE 21-15: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (SLAVE MODE)

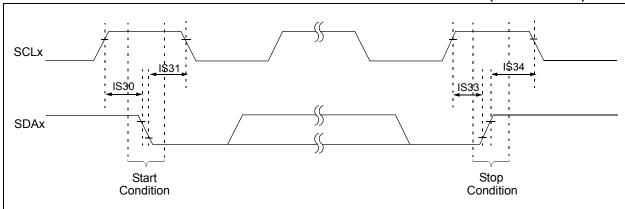
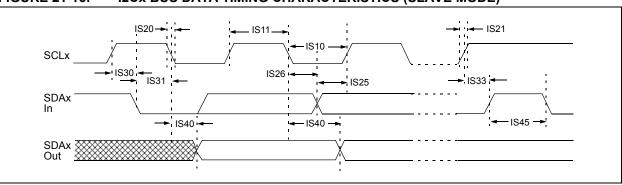


FIGURE 21-16: I2Cx BUS DATA TIMING CHARACTERISTICS (SLAVE MODE)



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TABLE 21-33: I2Cx BUS DATA TIMING REQUIREMENTS (SLAVE MODE)

AC CHARACTERISTICS				(unless other	erating (Conditionated) -40°C	ns: 3.0V to 3.6V ≤ TA ≤ +85°C for Industrial ≤ TA ≤ +125°C for Extended
Param	Symbol	Charac	teristic	Min	Max	Units	Conditions
IS10	TLO:SCL	Clock Low Time	100 kHz mode	4.7	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	_	μS	Device must operate at a minimum of 10 MHz
			1 MHz mode ⁽¹⁾	0.5	_	μS	_
IS11	THI:SCL	Clock High Time	100 kHz mode	4.0	_	μS	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	_	μS	Device must operate at a minimum of 10 MHz
			1 MHz mode ⁽¹⁾	0.5	_	μS	_
IS20	TF:SCL	SDAx and SCLx	100 kHz mode	_	300	ns	CB is specified to be from
		Fall Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_	100	ns	
IS21	TR:SCL	SDAx and SCLx	100 kHz mode	_	1000	ns	CB is specified to be from
		Rise Time	400 kHz mode	20 + 0.1 CB	300	ns	10 to 400 pF
			1 MHz mode ⁽¹⁾	_	300	ns	
IS25	TSU:DAT	Data Input	100 kHz mode	250	_	ns	_
		Setup Time	400 kHz mode	100	_	ns	
			1 MHz mode ⁽¹⁾	100	_	ns	
IS26	THD:DAT		100 kHz mode	0	0	μS	_
		Hold Time	400 kHz mode	0	0.9	μS	
			1 MHz mode ⁽¹⁾	0	0.3	μS	
IS30	Tsu:sta	Start Condition	100 kHz mode	4.7	_	μS	Only relevant for Repeated
		Setup Time	400 kHz mode	0.6	_	μS	Start condition
			1 MHz mode ⁽¹⁾	0.25	_	μS	
IS31	THD:STA	Start Condition	100 kHz mode	4.0	_	μS	After this period, the first
		Hold Time	400 kHz mode	0.6	_	μS	clock pulse is generated
			1 MHz mode ⁽¹⁾	0.25	_	μS	
IS33	Tsu:sto	Stop Condition	100 kHz mode	4.7		μS	_
		Setup Time	400 kHz mode	0.6	_	μS	
			1 MHz mode ⁽¹⁾	0.6		μS	
IS34	THD:ST	Stop Condition	100 kHz mode	4000		ns	_
	0	Hold Time	400 kHz mode	600	_	ns	
			1 MHz mode ⁽¹⁾	250		ns	
IS40	TAA:SCL	Output Valid	100 kHz mode	0	3500	ns	_
		From Clock	400 kHz mode	0	1000	ns	
			1 MHz mode ⁽¹⁾	0	350	ns	
IS45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	_	μS	Time the bus must be free
			400 kHz mode	1.3	_	μS	before a new transmission can start
			1 MHz mode ⁽¹⁾	0.5		μS	our our
IS50	Св	Bus Capacitive Lo	ading	_	400	pF	_

Note 1: Maximum pin capacitance = 10 pF for all I2Cx pins (for 1 MHz mode only).

TABLE 21-34: ADC MODULE SPECIFICATIONS

AC CHARACTERISTICS			Standard C (unless oth Operating te	erwise	ure -40°C≤	Ta ≤ +	to 3.6V -85°C for Industrial 125°C for Extended
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions
			Device S	upply			
AD01	AVDD	Module VDD Supply	Greater of VDD – 0.3 or 3.0	_	Lesser of VDD + 0.3 or 3.6	V	_
AD02	AVss	Module Vss Supply	Vss - 0.3	-	Vss + 0.3	V	_
			Reference	Inputs			
AD05	VREFH	Reference Voltage High	AVss + 2.7	_	AVDD	V	See Note 1
AD05a			3.0		3.6	V	VREFH = AVDD VREFL = AVSS = 0
AD06	VREFL	Reference Voltage Low	AVss	_	AVDD - 2.7	V	See Note 1
AD06a			0	_	0	V	VREFH = AVDD VREFL = AVSS = 0
AD07	VREF	Absolute Reference Voltage	2.7	_	3.6	V	VREF = VREFH - VREFL
AD08	IREF	Current Drain	_	400 —	550 10	μ Α μ Α	ADC operating ADC off
			Analog I	nput			
AD12	VINH	Input Voltage Range VINH	VINL	_	VREFH	V	This voltage reflects Sample and Hold Channels 0, 1, 2, and 3 (CH0-CH3), positive input
AD13	VINL	Input Voltage Range VINL	VREFL	_	AVss + 1V	V	This voltage reflects Sample and Hold Channels 0, 1, 2, and 3 (CH0-CH3), negative input
AD17	Rin	Recommended Impedance of Analog Voltage Source			200 200	Ω Ω	10-bit ADC 12-bit ADC

Note 1: These parameters are not characterized or tested in manufacturing.

TABLE 21-35: ADC MODULE SPECIFICATIONS (12-BIT MODE)

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions
		ADC Accuracy (12-bit Mode	e) – Meas	urement	s with e	xternal	VREF+/VREF-
AD20a	Nr	Resolution	12	2 data bi	ts	bits	_
AD21a	INL	Integral Nonlinearity	-2	_	+2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD22a	DNL	Differential Nonlinearity	>-1	_	<1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD23a	GERR	Gain Error	1.25	1.5	3	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD24a	Eoff	Offset Error	1.25	1.52	2	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD25a	_	Monotonicity	_	_	_	_	Guaranteed ⁽¹⁾
	į	ADC Accuracy (12-bit Mode	e) – Meas	uremen	ts with i	nternal '	VREF+/VREF-
AD20a	Nr	Resolution	12	2 data bi	ts	bits	_
AD21a	INL	Integral Nonlinearity	-2		+2	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD22a	DNL	Differential Nonlinearity	>-1	_	<1	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD23a	GERR	Gain Error	2	3	7	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD24a	Eoff	Offset Error	2	3	5	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD25a	_	Monotonicity	_	_	_	_	Guaranteed ⁽¹⁾
		Dynamic	Performa	nce (12	bit Mod	e)	
AD30a	THD	Total Harmonic Distortion	-77	-69	-61	dB	_
AD31a	SINAD	Signal to Noise and Distortion	59	63	64	dB	_
AD32a	SFDR	Spurious Free Dynamic Range	63	72	74	dB	_
AD33a	FNYQ	Input Signal Bandwidth			250	kHz	_
AD34a	ENOB	Effective Number of Bits	10.95	11.1	_	bits	_

Note 1: The A/D conversion result never decreases with an increase in the input voltage, and has no missing codes.

TABLE 21-36: ADC MODULE SPECIFICATIONS (10-BIT MODE)

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended				
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions
		ADC Accuracy (10-bit Mode) – Meas	uremen	ts with e	xternal	VREF+/VREF-
AD20b	Nr	Resolution	10	0 data bi	ts	bits	_
AD21b	INL	Integral Nonlinearity	-1.5	_	+1.5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD22b	DNL	Differential Nonlinearity	>-1	_	<1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD23b	GERR	Gain Error	1	3	6	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD24b	EOFF	Offset Error	1	2	5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V
AD25b	_	Monotonicity	_	_		_	Guaranteed ⁽¹⁾
	,	ADC Accuracy (10-bit Mode	e) – Meas	uremen	ts with i	nternal \	VREF+/VREF-
AD20b	Nr	Resolution	10	0 data bi	ts	bits	_
AD21b	INL	Integral Nonlinearity	-1	_	+1	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD22b	DNL	Differential Nonlinearity	>-1	_	<1	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD23b	GERR	Gain Error	1	5	6	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD24b	Eoff	Offset Error	1	2	3	LSb	VINL = AVSS = 0V, AVDD = 3.6V
AD25b	_	Monotonicity	_	_	_		Guaranteed ⁽¹⁾
		Dynamic I	Performa	nce (10	-bit Mod	e)	
AD30b	THD	Total Harmonic Distortion	_	-64	-67	dB	_
AD31b	SINAD	Signal to Noise and Distortion		57	58	dB	_
AD32b	SFDR	Spurious Free Dynamic Range		60	62	dB	
AD33b	FNYQ	Input Signal Bandwidth	_	_	550	kHz	_
AD34b	ENOB	Effective Number of Bits	9.1	9.7	9.8	bits	_

Note 1: The A/D conversion result never decreases with an increase in the input voltage, and has no missing codes.

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FIGURE 21-17: ADC CONVERSION (12-BIT MODE) TIMING CHARACTERISTICS (ASAM = 0, SSRC<2:0> = 000)

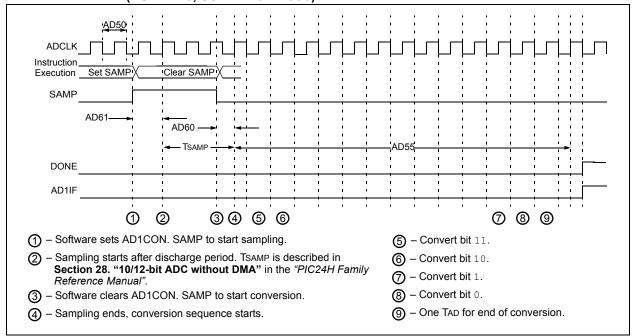


TABLE 21-37: ADC CONVERSION (12-BIT MODE) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic	Min.	Тур	Max.	Units	Conditions	
		Cloc	k Paramet	ters				
AD50	TAD	ADC Clock Period	117.6	_	_	ns	_	
AD51	trc	ADC Internal RC Oscillator Period	_	250		ns	_	
	Conversion Rate							
AD55	tconv	Conversion Time	_	14 TAD	_	ns	_	
AD56	FCNV	Throughput Rate	_	_	500	Ksps	_	
AD57	TSAMP	Sample Time	3.0 TAD	_	_	_	_	
		Timin	g Parame	ters				
AD60	tPCS	Conversion Start from Sample Trigger ⁽²⁾	2.0 TAD	_	3.0 TAD	_	Auto Convert Trigger not selected	
AD61	tpss	Sample Start from Setting Sample (SAMP) bit ⁽²⁾	2.0 TAD	_	3.0 TAD	_	_	
AD62	tcss	Conversion Completion to Sample Start (ASAM = 1) ⁽²⁾	_	0.5 TAD	_		_	
AD63	tDPU	Time to Stabilize Analog Stage from ADC Off to ADC On ⁽²⁾		_	20	μS	_	

Note 1: Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

2: These parameters are characterized but not tested in manufacturing.

FIGURE 21-18: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 0, SSRC<2:0> = 000)

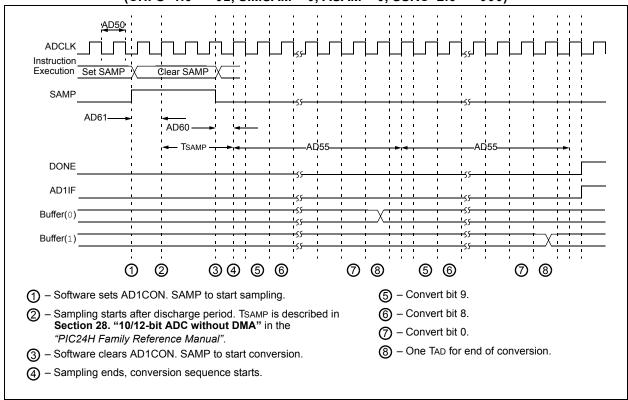


FIGURE 21-19: ADC CONVERSION (10-BIT MODE) TIMING CHARACTERISTICS (CHPS<1:0> = 01, SIMSAM = 0, ASAM = 1, SSRC<2:0> = 111, SAMC<4:0> = 00001)

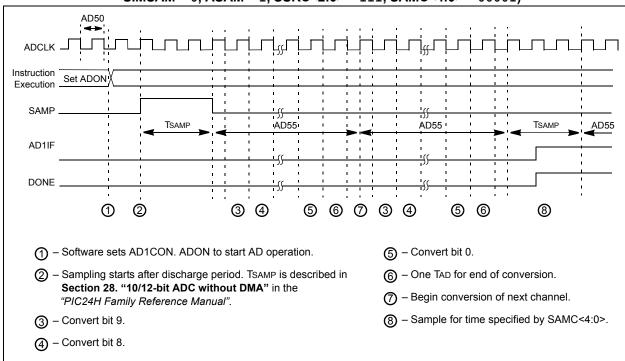


TABLE 21-38: ADC CONVERSION (10-BIT MODE) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{Ta} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{Ta} \le +125^{\circ}\text{C}$ for Extended					
Param No.	Symbol	Characteristic	Min.	Min. Typ ⁽¹⁾ Max. Units Conditions				
	Clock Parameters							
AD50	TAD	ADC Clock Period	76	_	_	ns	_	
AD51	trc	ADC Internal RC Oscillator Period	_	250	_	ns	_	
	Conversion Rate							
AD55	tconv	Conversion Time	_	12 TAD			_	
AD56	FCNV	Throughput Rate	_	_	1.1	Msps	_	
AD57	TSAMP	Sample Time	2.0 TAD	_	_	_	_	
		Timin	g Parame	eters				
AD60	tPCS	Conversion Start from Sample Trigger ⁽¹⁾	2.0 TAD		3.0 TAD		Auto-Convert Trigger not selected	
AD61	tpss	Sample Start from Setting Sample (SAMP) bit ⁽¹⁾	2.0 TAD	_	3.0 TAD	_	_	
AD62	tcss	Conversion Completion to Sample Start (ASAM = 1) ⁽¹⁾	_	0.5 TAD		1	_	
AD63	tDPU	Time to Stabilize Analog Stage from ADC Off to ADC On ⁽¹⁾	_	_	20	μS	_	

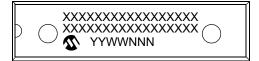
Note 1: These parameters are characterized but not tested in manufacturing.

^{2:} Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

22.0 PACKAGING INFORMATION

22.1 Package Marking Information

28-Lead SPDIP



Example



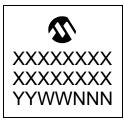
28-Lead SOIC (.300")



Example



28-Lead QFN-S



Example



Legend: XX...X Customer-specific information
Year code (last digit of calendar year)

YY Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

(e3) Pb-free JEDEC designator for Matte Tin (Sn)

This package is Pb-free. The Pb-free JEDEC designator (@3)

can be found on the outer packaging for this package.

Note: If the full Microchip part number cannot be marked on one line, it is carried over to the next line, thus limiting the number of available characters for customer-specific information.

22.1 Package Marking Information (Continued)

44-Lead QFN



Example



44-Lead TQFP



Example

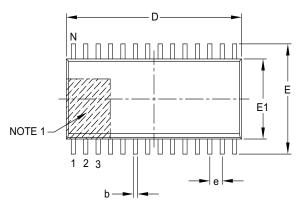


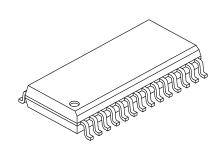
Legend: XX...X Customer-specific information
Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
Pb-free JEDEC designator for Matte Tin (Sn)
This package is Pb-free. The Pb-free JEDEC designator (©3)
can be found on the outer packaging for this package.

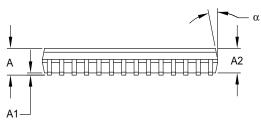
Note: If the full Microchip part number cannot be marked on one line, it is carried over to the next line, thus limiting the number of available characters for customer-specific information.

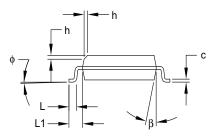
28-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging









	Units		MILLMETERS		
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		1.27 BSC		
Overall Height	А	-	-	2.65	
Molded Package Thickness	A2	2.05	-	_	
Standoff §	A1	0.10	-	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width	E1	7.50 BSC			
Overall Length	D		17.90 BSC		
Chamfer (optional)	h	0.25	-	0.75	
Foot Length	L	0.40	-	1.27	
Footprint	L1		1.40 REF		
Foot Angle Top	ф	0°	-	8°	
Lead Thickness	С	0.18	-	0.33	
Lead Width	b	0.31	-	0.51	
Mold Draft Angle Top	α	5°	_	15°	
Mold Draft Angle Bottom	β	5°	_	15°	

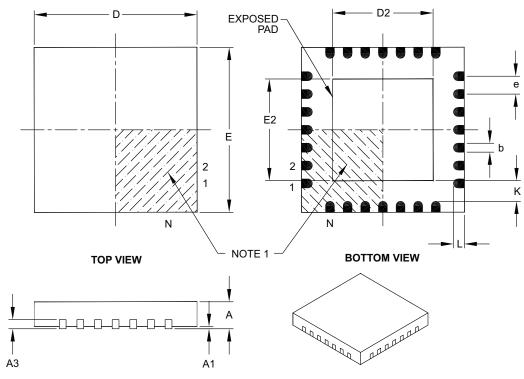
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B

28-Lead Plastic Quad Flat, No Lead Package (MM) – 6x6x0.9 mm Body [QFN-S] with 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	3
Dimension	n Limits	MIN	NOM	MAX
Number of Pins	N		28	
Pitch	е		0.65 BSC	
Overall Height	Α	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	А3	0.20 REF		
Overall Width	Е	6.00 BSC		
Exposed Pad Width	E2	3.65	3.70	4.70
Overall Length	D		6.00 BSC	
Exposed Pad Length	D2	3.65	3.70	4.70
Contact Width	b	0.23	0.38	0.43
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

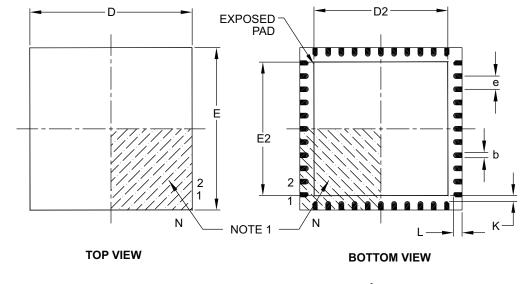
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

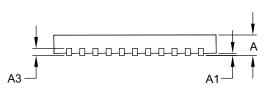
REF: Reference Dimension, usually without tolerance, for information purposes only.

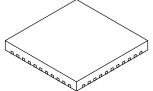
Microchip Technology Drawing C04-124B

44-Lead Plastic Quad Flat, No Lead Package (ML) - 8x8 mm Body [QFN]

For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging







·	Units		MILLIMETERS		
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		44		
Pitch	е		0.65 BSC		
Overall Height	A	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	E	8.00 BSC			
Exposed Pad Width	E2	6.30	6.45	6.80	
Overall Length	D		8.00 BSC		
Exposed Pad Length	D2	6.30	6.45	6.80	
Contact Width	b	0.25	0.30	0.38	
Contact Length	L	0.30	0.40	0.50	
Contact-to-Exposed Pad	K	0.20	_	_	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

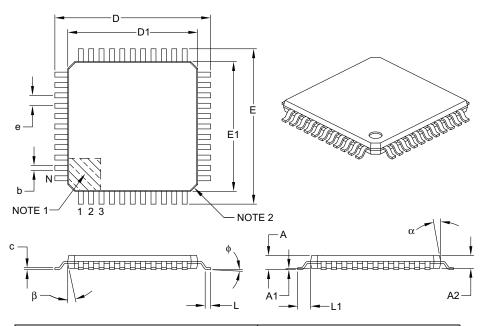
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-103B

44-Lead Plastic Thin Quad Flatpack (PT) - 10x10x1 mm Body, 2.00 mm Footprint [TQFP]

te: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimen:	sion Limits	MIN	NOM	MAX
Number of Leads	N		44	
Lead Pitch	е		0.80 BSC	
Overall Height	Α	_	_	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	_	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1	1.00 REF		
Foot Angle	ф	0°	3.5°	7°
Overall Width	E		12.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Thickness	С	0.09	_	0.20
Lead Width	b	0.30	0.37	0.45
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Chamfers at corners are optional; size may vary.
- 3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-076B

APPENDIX A: REVISION HISTORY

Revision A (July 2007)

Initial release of this document.

Revision B (June 2008)

This revision includes minor typographical and formatting changes throughout the data sheet text.

The major changes are referenced by their respective section in the following table.

TABLE 22-1: MAJOR SECTION UPDATES

Section Name	Update Description
"High-Performance, 16-bit Microcontrollers"	Added Extended Interrupts column to Remappable Peripherals in the Controller Families table and Note 2 (see Table 1).
	Added Note 1 to all pin diagrams, which references RPn pin usage by remappable peripherals (see "Pin Diagrams").
Section 1.0 "Device Overview"	Changed PORTA pin name from RA15 to RA10 (see Table 1-1).
Section 3.0 "Memory Organization"	Updated Reset values for the following SFRs: IPC1, IPC3-IPC5, IPC7, IPC16, and INTTREG (see Table 3-4).
	Added the System Control Register Map (see Table 3-20).
Section 5.0 "Resets"	Entire section was replaced to maintain consistency with other PIC24H data sheets.
Section 7.0 "Oscillator Configuration"	Removed the first sentence of the third clock source item (External Clock) in Section 7.1.1.2 "Primary".
	Updated the default bit values for DOZE and FRCDIV in the Clock Divisor Register (see Register 7-2).
	Added the center frequency in the OSCTUN register for the FRC Tuning bits (TUN<5:0>) value 011111 and updated the center frequency for bits value 011110 (see Register 7-4).
Section 8.0 "Power-Saving	Added the following two registers:
Features"	PMD1: Peripheral Module Disable Control Register 1
	PMD2: Peripheral Module Disable Control Register 2
Section 9.0 "I/O Ports"	Added paragraph and Table 9-1 to Section 9.1.1 "Open-Drain Configuration", which provides details on I/O pins and their functionality.
	Removed the following sections, which are now available in the related section of the PIC24H Family Reference Manual:
	9.4.2 "Available Peripherals"
	• 9.4.3.3 "Mapping"
	9.4.5 "Considerations for Peripheral Pin Selection"
Section 13.0 "Output Compare"	Replaced sections 13.1, 13.2 and 13.3 and related figures and tables with entirely new content.
Section 14.0 "Serial Peripheral Interface (SPI)"	Removed the following sections, which are now available in the related section of the PIC24H Family Reference Manual:
	• 14.1 "Interrupts"
	14.2 "Receive Operations"
	• 14.3 "Transmit Operations"
	• 14.4 "SPI Setup" (retained Figure 14-1: SPI Module Block Diagram)

TABLE 22-1: MAJOR SECTION UPDATES (CONTINUED)

Section Name	Update Description
Section 15.0 "Inter-Integrated Circuit (I2C™)"	Removed the following sections, which are now available in the related section of the PIC24H Family Reference Manual:
,	• 15.3 "I ² C Interrupts"
	15.4 "Baud Rate Generator" (retained Figure 15-1: I ² C Block Diagram)
	• 15.5 "I ² C Module Addresses"
	15.6 "Slave Address Masking"
	• 15.7 "IPMI Support"
	15.8 "General Call Address Support"
	15.9 "Automatic Clock Stretch"
	15.10 "Software Controlled Clock Stretching (STREN = 1)"
	15.11 "Slope Control"
	15.12 "Clock Arbitration"
	• 15.13 "Multi-Master Communication, Bus Collision, and Bus Arbitration"
	15.14 "Peripheral Pin Select Limitations"
Section 16.0 "Universal Asynchronous Receiver Transmitter	Removed the following sections, which are now available in the related section of the PIC24H Family Reference Manual:
(UART)"	16.1 "UART Baud Rate Generator"
	16.2 "Transmitting in 8-bit Data Mode"
	16.3 "Transmitting in 9-bit Data Mode"
	16.4 "Break and Sync Transmit Sequence"
	16.5 "Receiving in 8-bit or 9-bit Data Mode"
	16.6 "Flow Control Using UxCTS and UxRTS Pins"
	16.7 "Infrared Support"
	Removed IrDA references and Note 1, and updated the bit and bit value descriptions for UTXINV (UxSTA<14>) in the UARTx Status and Control Register (see Register 16-2).
Section 17.0 "10-bit/12-bit Analog- to-Digital Converter (ADC)"	Removed Equation 17-1: ADC Conversion Clock Period and Figure 17-2: ADC Transfer Function (10-Bit Example).
	Added ADC1 Module Block Diagram for PIC24HFJ16GP304 and PIC24HJ32GP204 Devices (Figure 17-1) and ADC1 Module Block Diagram FOR PIC24HJ32GP202 Devices (Figure 17-2).
	Added Note 2 to Figure 17-3: ADC Conversion Clock Period Block Diagram.
	Added device-specific information to Note 1 in the ADC1 Input Scan Select Register Low (see Register 17-6), and updated the default bit value for bits 12-10 (CSS12-CSS10) from U-0 to R/W-0.
	Added device-specific information to Note 1 in the ADC1 Port Configuration Register Low (see Register 17-7), and updated the default bit value for bits 12-10 (PCFG12-PCFG10) from U-0 to R/W-0.

TABLE 22-1: MAJOR SECTION UPDATES (CONTINUED)

Section Name	Update Description
Section 18.0 "Special Features"	Added FICD register information for address 0xF8000E in the Device Configuration Register Map (see Table 18-1).
	Added FICD register content (BKBUG, COE, JTAGEN, and ICS<1:0> to the PIC24HJ32GP202/204 and PIC24HJ16GP304 Configuration Bits Description (see Table 18-2).
	Added a note regarding the placement of low-ESR capacitors, after the second paragraph of Section 18.2 "On-Chip Voltage Regulator" and to Figure 18-1.
	Removed the words "if enabled" from the second sentence in the fifth paragraph of Section 18.3 "BOR: Brown-Out Reset".
Section 21.0 "Electrical	Removed Typ value for parameter DC12 (see Table 21-4).
Characteristics"	Updated MIPS conditions for parameters DC24c, DC44c, DC72a, DC72f and DC72g (see Table 21-5, Table 21-6 and Table 21-8).
	Added Note 4 (reference to new table containing digital-only and analog pin information to I/O Pin Input Specifications (see Table 21-9).
	Updated Min, Typ, and Max values and updated Min values for Program Memory parameters D136, D137 and D138 (see Table 21-12).
	Updated Max value for Internal RC Accuracy parameter F21 for -40°C \leq TA \leq +125°C condition and added Note 2 (see Table 21-19).
	Removed all values for Reset, Watchdog Timer, Oscillator Start-up Timer, and Power-up Timer parameter SY20 and updated conditions, which now refers to Section 18.4 "Watchdog Timer (WDT)" and LPRC parameter F21 (see Table 21-21).
	Updated Min and Typ values for parameters AD60, AD61, AD62 and AD63 and removed Note 3 (see Table 21-37).
	Updated Min and Typ values for parameters AD60, AD61, AD62 and AD63 and removed Note 3 (see Table 21-38).

PIC24FJ32GP202/204 and PIC24FJ16GP304				
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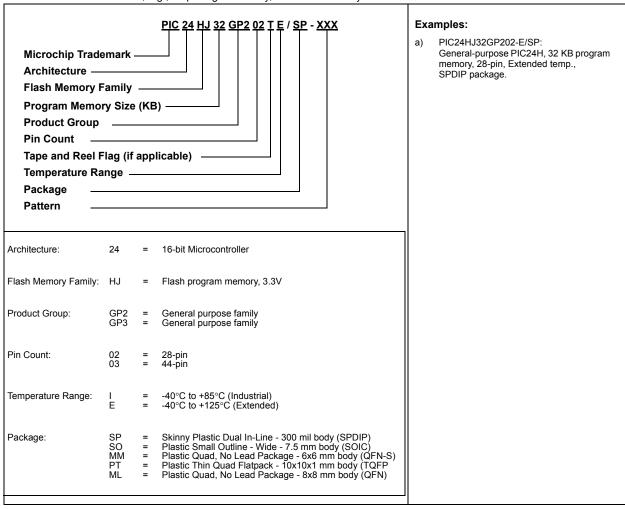
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